

10 kHz – 1.01 GHz AM/FM SIGNAL GENERATOR 2022E

Part No. 52022-950J

AMENDMENT RECORD

The following amendments are incorporated in this manual.

Amendment No.	Date	Issued at Serial number

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PREFACE

WARNINGS, CAUTIONS AND NOTES

These terms have specific meanings in this manual:-



WARNINGS contain information to prevent personal injury.

CAUTIONS contain information to prevent damage to the equipment.

Notes contain important general information.

HAZARD SYMBOLS

The meaning of hazard symbols appearing on the equipment is as follows:-

Symbol	Nature of hazard	Reference in manual
	Static sensitive device	Page (v)
	Component contains Beryllia	Page (v)

MANUAL AMENDMENT STATUS

Each page bears the date of the original issue or the code number and date of the latest amendment (Am. 1, Am. 2 etc.). New or amended material of technical importance introduced by the latest amendment is indicated by triangles positioned thus >.....< to show the extent of the change. When a chapter is reissued the triangles do not appear. Any changes subsequent to the latest amendment state of the manual are included on inserted sheets coded C1, C2 etc.

SECURITY NOTICE

Second functions are grouped into three levels of operation. Access to the first two groups, Normal and First level operation can be freely gained by carrying out the unlocking procedures described in both Operating Manual and Service Manual. Details for accessing the Second level operation however are only included in the Service Manual. Some user units may wish to further restrict the distribution of this information to selected calibration areas only. To enable this, Chapter 4 includes alternative pages 43a/44a which have the unlocking procedure deleted. Users may then withdraw either pages 43/44 or 43a/44a as required.

SERVICING PRECAUTIONS

This product has been designed and tested in accordance with IEC Publication 348 - 'Safety Requirements for Electronic Measuring Apparatus'. To keep it in a safe condition and avoid risk of injury, the precautions detailed in the WARNINGS below should be observed. To avoid damage to the equipment the precautions detailed in the CAUTIONS should also be observed.

WARNING - ELECTRICAL HAZARDS

AC supply voltage. This equipment conforms with IEC Safety Class 1, meaning that it is provided with a protective earthing lead. To maintain this protection the mains supply lead must always be connected to the source of supply via a socket with an earthing contact. Make sure that the earth protection is not interrupted if the supply is connected through an extension lead or an autotransformer.

Before fitting a non-soldered plug to the mains lead cut off the tinned end of the wires, otherwise cold flowing of the solder could cause intermittent contact.

Do not use the equipment if it is likely that its protection has been impaired as a result of damage.

Fuses. Note that there is a supply fuse in both the live and neutral wires of the supply lead. If only one of these fuses should rupture, certain parts of the equipment could remain at supply potential.

Make sure that only fuses of the correct rating and type are used for replacement. Do not use mended fuses or short-circuited fuse holders.

To provide protection against breakdown of the supply lead, its connectors (and filter if fitted), an external supply fuse with a continuous rating not exceeding 6 A should be used in the live conductor (e.g. fitted in the supply plug).

Removal of covers. Disconnect the supply before removing the covers so as to avoid the risk of exposing high voltage parts. If any internal adjustment or servicing has to be carried out with the supply on, it must only be performed by a skilled person who is aware of the hazard involved.

Remember that capacitors inside the equipment, including any supply filter capacitors, may still be charged after disconnection of the supply. Those connected to high voltage points should be discharged before carrying out work inside the equipment.

WARNING - OTHER HAZARDS

Parts of this equipment are made from metal pressings, therefore it should be handled with due care to avoid the risk of cuts or scratches.

Some of the components used in this equipment may include resins and other materials which give off toxic fumes if incinerated. Take appropriate precautions, therefore, in the disposal of these items.

This equipment has a lithium battery which if incorrectly handled could cause a danger to health or safety - refer to the Service Manual for safe handling precautions.

Beryllia (Beryllium Oxide) is used in the construction of the following components in this equipment.

UNIT AB1/2 : Transistor TR20

This material, when in form of fine dust or vapour and inhaled into the lungs, can cause a respiratory disease. In its solid form, as used here, it can be handled quite safely although it is prudent to avoid handling conditions which promote dust formation by surface abrasion.

Because of this hazard, you are advised to be very careful in removing and disposing of these components. Do not put them in the general industrial or domestic waste or despatch them by post. They must be separately and securely packed and clearly identified to show the nature of the hazard and then disposed of in a safe manner by an authorized toxic waste contractor.

CAUTION – LCD HANDLING

When operating or servicing this equipment take care not to depress the front or rear faces of the display module as this may damage the liquid crystal display elements.

CAUTION – STATIC SENSITIVE COMPONENTS

Components identified with the symbol on the circuit diagrams and/or parts lists are static sensitive devices. The presence of such devices is also indicated in the equipment by orange discs, flags or labels bearing the same symbol. Certain handling precautions must be observed to prevent these components being permanently damaged by static charges or fast surges.

- (1) If a printed board containing static sensitive components (as indicated by a warning disc or flag) is removed, it must be temporarily stored in a conductive plastic bag.
- (2) If a static sensitive component is to be removed or replaced the following anti-static equipment must be used.

A work bench with an earthed conductive surface.

Metallic tools earthed either permanently or by repeated discharges.

A low-voltage earthed soldering iron.

An earthed wrist strap and a conductive earthed seat cover for the operator, whose outer clothing must not be of man-made fibre.

- (3) As a general precaution, avoid touching the leads of a static sensitive component. When handling a new one, leave it in its conducting mount until it is required for use.
- (4) If using a freezer aerosol in fault finding, take care not to spray programmable ICs as this may affect their contents.



Chapter 4

TECHNICAL DESCRIPTION

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INTRODUCTION

1. The following summary is an outline description of the instrument which may be read in conjunction with two simplified block diagrams. The first is in the Operating Manual and provides a simple guide to the main method of signal frequency generation. Fig. 7-1 in this Service Manual is a more detailed diagram giving more specific information.

OVERALL TECHNICAL DESCRIPTION

Frequency synthesizer and signal processing

2. 2022E is a synthesized AM, FM or phase modulated signal generator covering a frequency range of 10 kHz – 1010 MHz. Frequencies in the range 250 – 500 MHz are generated from two voltage controlled oscillators. In the range 62.5 to 250 MHz signal frequencies are obtained by divider circuits and in the range 10 kHz to 62.5 MHz by a beat frequency oscillator (BFO) system. A frequency doubler is used to cover the band 500 – 1010 MHz.

3. The output frequency is phase locked to a frequency standard and frequencies up to 100 MHz can be set to a resolution of 10 Hz. Above 100 MHz the resolution is 100 Hz. A fractional division scheme allows this resolution to be obtained whilst still keeping the phase locked loop (PLL) bandwidth reasonably high. Provision is also made for the use of an external frequency standard when this is preferred. Frequencies of 10, 5 or 1 MHz can be used depending on the position of an internal link fitted within the instrument.

Output

4. Calibrated output levels from -127 dBm to +10 dBm are provided. A combination of ten output level calibration units can be selected on the front panel. The RF output level can be set to a resolution of 0.1 dB over the entire output voltage range and features a total cumulative accuracy of ± 2 dB. A precision attenuator provides 120 dB in 10 dB steps and is a self contained module. Three 30 dB, one 20 dB and one 10 dB pad are used whose frequency response is factory set. Each pad is operated by TO5 relays. 20 dB of fine level control is achieved using PIN diode attenuators.

Modulation

5. Amplitude, frequency and phase modulation can be provided internally from a free running switchable modulation source.

6. **Amplitude modulation.** For carrier frequencies greater than 62.5 MHz, modulation is obtained using PIN diode attenuators and envelope feedback. At carrier frequencies less than 62.5 MHz modulation is provided by a fixed frequency modulator operating at a frequency of 160 MHz. AM is DC coupled when the modulation ALC is off.

7. **Frequency modulation.** FM is created by applying the modulation signal to varactor(s) in the 250 – 500 MHz oscillator. Simultaneous modulation of the reference frequency prevents fall off in response below the loop bandwidth. FM off (CW mode) gives the lowest residual FM noise. The low frequency response is tailored to optimize the modulation accuracy of low frequency square waves.

8. **Phase modulation.** This is achieved using a differentiator in the modulation signal path and then applying the differentiated signal in the same manner as the FM.

9. **Modulation signal ALC.** This is always in circuit when internal modulation is in use and may be selected when switched to external modulation. The circuit uses a JFET and automatically levels signals in the 0.9 to 1.1 V range to maintain accurate modulation. Outside of this voltage range HI or LO messages appear in the modulation display area to warn the operator of an error.

10. **Auxiliary modulation.** A rear panel socket allows an external modulation signal to be combined with the internal modulation signal. A signal level of 1 V RMS at this socket will produce 20% of the indicated modulation setting.

Control

11. Front panel operation is carried out by direct entry of required settings via the keyboard. Microprocessor control ensures flexibility, simplicity of use and allows programming by the General Purpose Interface Bus (GPIB). This facility is offered as an optional accessory enabling the instrument to be used both as a manually operated bench mounted instrument or as part of a fully automated test system.

12. Both analogue and digital circuits are incorporated to control the instrument. Three methods of data transfer from the microprocessor to the remainder of the instrument are used:-

- (1) The VCO frequency is set by direct parallel loading from the microprocessor to the synthesizer board.
- (2) Analogue control of functions such as a.m. depth and RF level is maintained by first converting data into a serial format then transmitting it from the microprocessor/synthesizer box. The data is then converted back to an 8-bit parallel format which is loaded into Digital-to-Analogue Converters (DACs). This causes gain changes which vary voltage levels as appropriate.
- (3) The third method is to convert the parallel data on the control board into a special serial format that is fed to the liquid crystal display drivers.

13. The microprocessor used is an 8085A and incorporates an 8-bit multiplexed data/low order address structure to allow a 16-bit address bus. 2 K bytes of RAM are used for temporary storage. 32 K bytes of EPROM are used for the instrument's operating program and 2 K bytes of non-volatile EAROM are available for user control settings and calibration information.

SYNTHESIZER (AA1/1)

Circuit diagram : Fig. 7-6

250-500 MHz synthesis

14. This is accomplished by fractional N synthesis and is made up of a system into three areas as follows:-

- (1) 40 kHz synthesizer. A conventional type operating in 40 kHz increments consisting of a fully programmable divider, a 40 kHz reference divider, frequency comparator and a loop filter.
- (2) Fractional N accumulator. Whose purpose is to make periodic adjustments to the division ratio of the synthesizer so that the average division ratio is a rational value (i.e. interpolating between the 40 kHz increments).
- (3) A jitter correction circuit. Whose function is to correct for the unevenness of the divider output pulses caused by the operation of the accumulator.

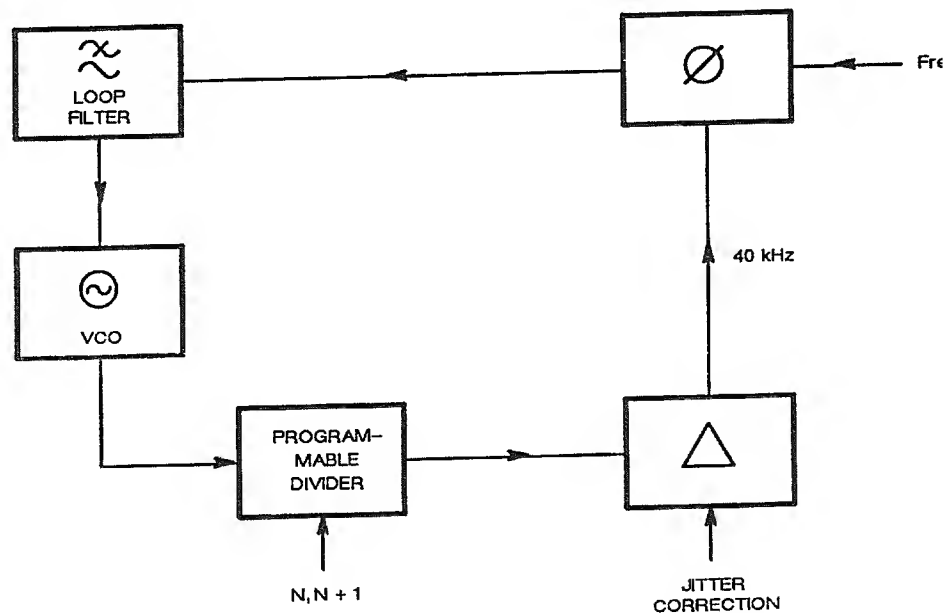


Fig. 4-1 Fractional N synthesis simplified block diagram

15. Fractional N synthesis. In single-loop synthesis the minimum frequency increment attainable is equal to the reference frequency. Thus fine frequency increments can only be attained at the expense of a very low reference frequency. To overcome this, extensive filtering at the loop filter, resulting in a low loop bandwidth and poor performance. Fractional N synthesis overcomes this restriction.

16. Increments smaller than the reference frequency are generated by making periodic adjustments to the division ratio so that the average value of division ratio is a fractional number. The output pulses from the programmable divider do not have uniform spacing and this must be corrected before the signal reaches the frequency comparator otherwise spurious modulation or 'jitter' will occur. The circuit that makes these adjustments to the division ratio also generates a correction voltage used to delay the output pulses to return them to uniform spacing, eliminating jitter.

VCO system (250–505 MHz)

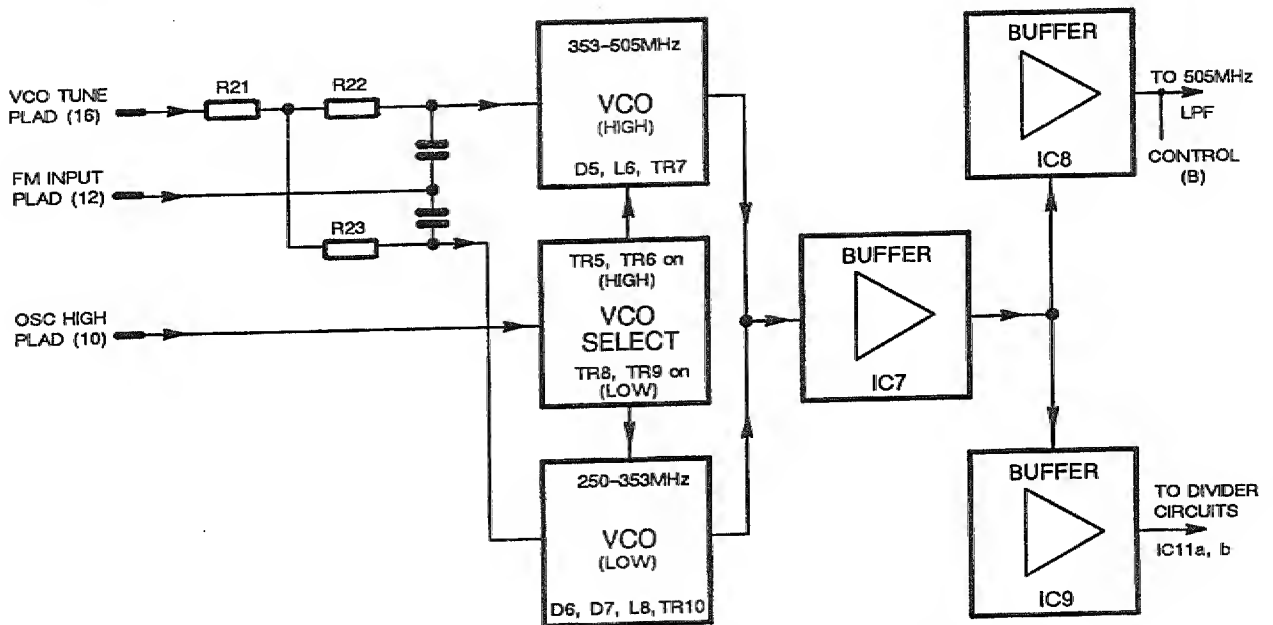


Fig. 4–7 250–500 MHz VCO system simplified block diagram (AB1/2)

69. Two oscillators are used to cover the basic frequency range each one generating one half octave. Changeover occurs at 353 MHz. The upper half octave 353 – 500 MHz is generated from a tuned circuit formed by C31, D5, and L6, the latter is only evident as a thicker length of track on the PCB. The base of TR7 oscillator is driven from the centre tap of L6 and the collector via C37 and R34, these components are positioned so as to be mutually coupled to the oscillator tuned circuit.

70. R32, R33, C33 and C34 control the impedance of oscillator TR7 and compensate for unwanted internal phase shift within the transistor. Having resistors in both emitter and collector circuits also prevents the formation of parasitic resonance which would otherwise occur via the transistor's junction capacitances.

71. Tuning of the oscillator is carried out by the varactor D5 with bias applied via L5. The LF end of the oscillator range may be adjusted by C31 for 2 V at 353 MHz. The HF end of the range should be approximately 15 V at 500 MHz. Output is taken from a low tapping point on L6, via R27.

72. The lower half octave oscillator 250 – 352 MHz operates in a similar manner with the capacitor values doubled in the tuned circuit to give the half-octave reduction in frequency.

73. Selection 353 – 505 MHz (HIGH) and 250 – 352 MHz (LOW) is carried out by the OSC HIGH control line (PLAD pin 10) from A2/2 Control circuit. When this is asserted 'high' TR5 and TR6 conduct and complete the –12 V supply line to allow TR7 to conduct. When the OSC HIGH control line is at logic 'low' TR8 and TR9 conduct and TR10 is powered. Because only one oscillator is powered at a time from the single control line, outputs are resistively summed at the input of IC7 amplifier. Both oscillators and amplifier are mounted within the on-board screening so as to achieve a very low level of load reaction.

Frequency dividers (62.5 – 250 MHz)

74. The VCO output range (250 – 500 MHz) is divided into three paths via IC8, IC9 and IC10 buffer amplifiers. IC8 provides the signal path for the 250 – 500 MHz range, IC9 the 62.5 – 250 MHz range and IC10 provides a synchronizing output to AA1/1 programmable dividers.

75. Selecting of the required signal path is controlled by IC4–IC6 signal gating circuit. The control data is input via PLAD pins 6,7 and 11 and is shown on the circuit diagram as range control logic and uses the letters (A) to (G) to indicate where assertion of data (negative true logic) is made.

76. The output from IC9 drives two binary frequency dividers IC11a and IC11b. These D type flip-flops are wired as two binary dividers by connecting the Q outputs to their respective D inputs. The first divider is clocked via pin 11. Both Q and QL outputs are utilized, driving opposite ends of T1 balancing transformer. The output is taken from a third winding via D15 when control logic line (B) is asserted. This arrangement gives a symmetrical output waveform containing little second harmonic therefore simplifying filtering.

77. When (F) is asserted 'low' R59 and R61 provide bias to allow IC11a divider to operate. R58 and R60 provide bias to the clock inputs via L16 and L35 to maintain these at the mean logic level. The second divider operates when the bias provided via R78 and R79 is applied, this occurs when both (A) and (F) are asserted 'low'.

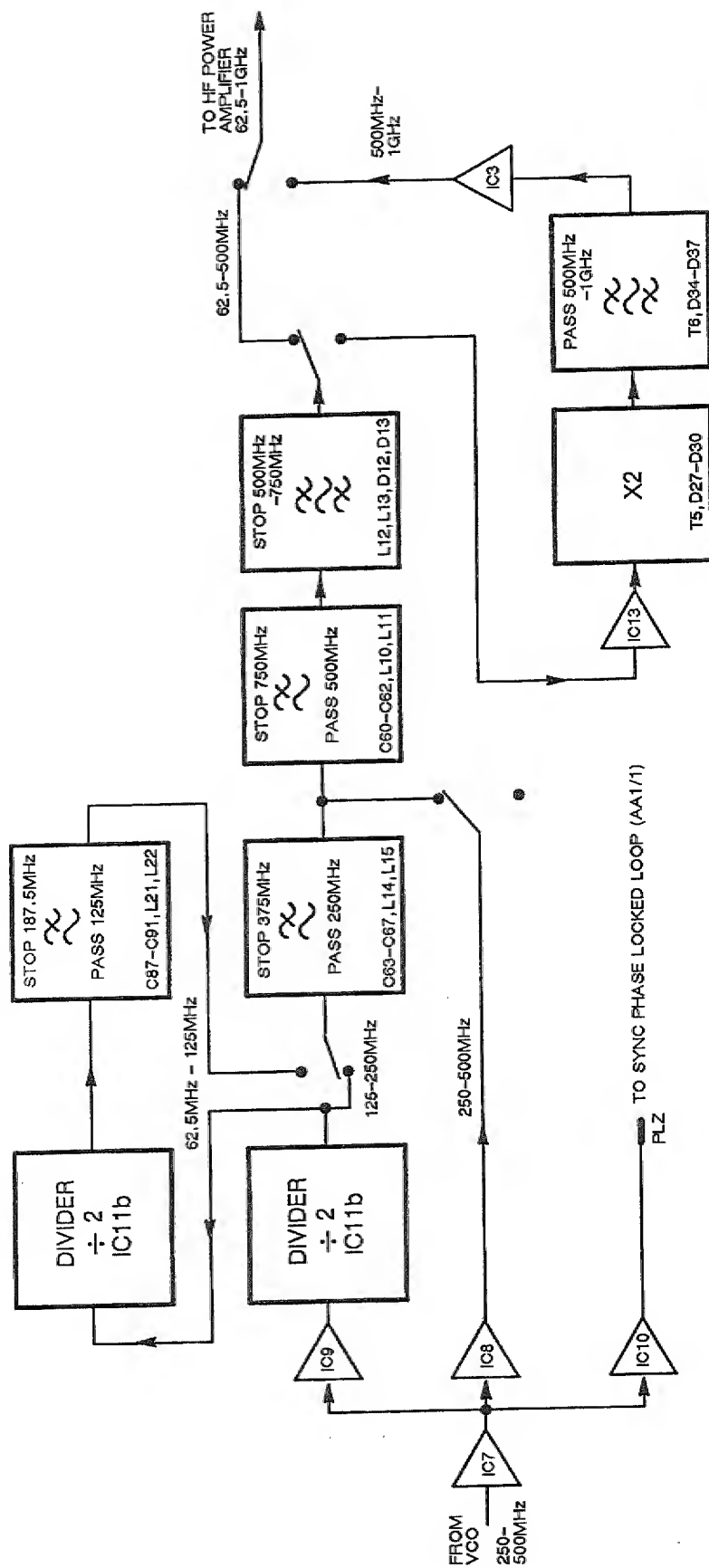


Fig. 4-8 Frequency dividers, simplified block diagram (AB1/2)

78. **250 – 500 MHz.** When frequencies in this range are selected, point (E) is taken 'low' turning D8 and D9 on and D10 off. (F), (A) and (B) are taken 'high', disabling IC11a,b dividers; D11 is also turned off. The signal path is then routed from IC8 and through a 500 MHz low-pass filter comprising L10,L11,C60–C62. Cut off frequency of this filter is 750 MHz enabling signals of up to 500 MHz to pass but none of the third or higher harmonics. A further tunable notch filter L12,L13,D12 and D13 eliminates the second harmonics in the range 500–750 MHz.

79. **125 – 250 MHz.** When frequencies in this range are required, point (E) is taken 'high', D8 and D9 are turned off and D10 is turned on. Points (F) and (B) are taken 'low' activating IC11a first divider. D11,D14 and D15 are also turned on and D17,D18 are turned off. The first divider's output is routed via D15 and D14 to a 250 MHz low-pass elliptic filter comprising L14,L15, C63–C67. Cut off frequency of this filter is 375 MHz so the required range is passed but the third harmonic in the band 375 – 750 MHz (and higher harmonics) are eliminated. The signal is then routed from the low-pass filter via D11 to the input of the 500 MHz low-pass filter to be combined with the 250 – 500 MHz signal frequency range.

80. **62.5 – 125 MHz.** When frequencies in this range are required, points (A) and (F) are taken 'low' and (B) is taken 'high'. D15 is turned off, D16 and D18 are turned on, both IC11a and IC11b dividers operate and the output (62.5–125 MHz) is taken from T4 transformer secondary. The signal is passed through a 125 MHz low-pass filter L21, L22,C87–C91. Cut off frequency of the filter is 187.5 MHz to eliminate the third and higher harmonics. This allows the required 62.5–125 MHz band to be routed via D16 to the 250 MHz low-pass filter L14,L15. The signal is then combined with the 125–250 MHz and the 250–500 MHz signal paths as far as the junction C71,D20,D21.

81. At C71 the signal paths divide. When signals in the range 62.5–500 MHz are selected, point (C) is taken low and point (D) is taken 'high', D20, D23 and D31 are turned on and D32 is turned off. Signals are routed to the input of the HF output amplifier stage via D20,D23,D31 and C102.

Frequency doubler (500–1010 MHz)

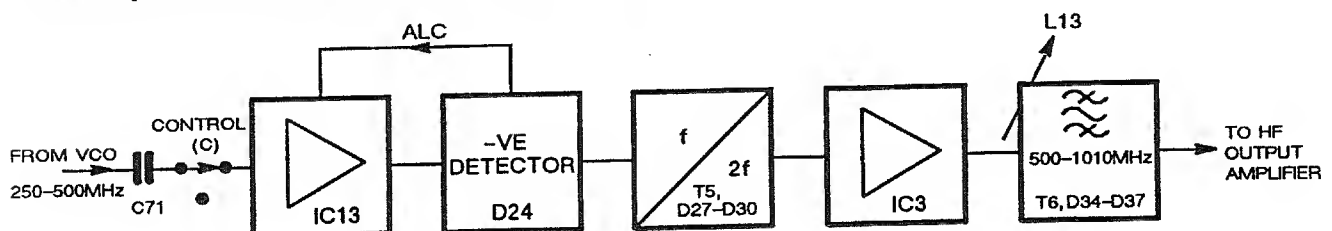


Fig. 4-9 Frequency multipliers, simplified block diagram (AB1/2)

82. The frequency range of 500–1010 MHz is obtained by taking the VCO output range (250–500 MHz) from the output of the 500–1010 MHz notch filter and following this with a frequency doubler circuit. Selection is effected by the assertion of the range control logic, point (C) is taken 'high' and point (D) is taken 'low'. D20 is turned off and the signal path is then taken via the amplifier IC13. Output from IC13 is detected by D24 which drives an automatic level correction circuit. This controls the RF resistance of D21,D22 and thus the drive to the doubler circuit.

83. The frequency doubler circuit comprises T5, balancing transformer and D27-D30 diode bridge. Insertion loss of the doubler is compensated for by IC3 which provides 12 dB of amplification. This output is filtered by a 500-1010 MHz voltage tuned band-pass filter comprising D34-D37 and T6.

84. The filter together with the 500-1010 MHz voltage tuned notch filter previously described share a common control line. This originates from a digital-to-analogue converter on A2/2 board via PLAD pin 15. Tracking data is set by the requirements of the band-pass filter which has no other means of adjustment. The notch filter is then aligned to this data by adjustment of L13. Output from the 500-1010 MHz band-pass filter is connected via D32 and C102 to the HF output amplifier.

HF output stage (62.5-1010 MHz)

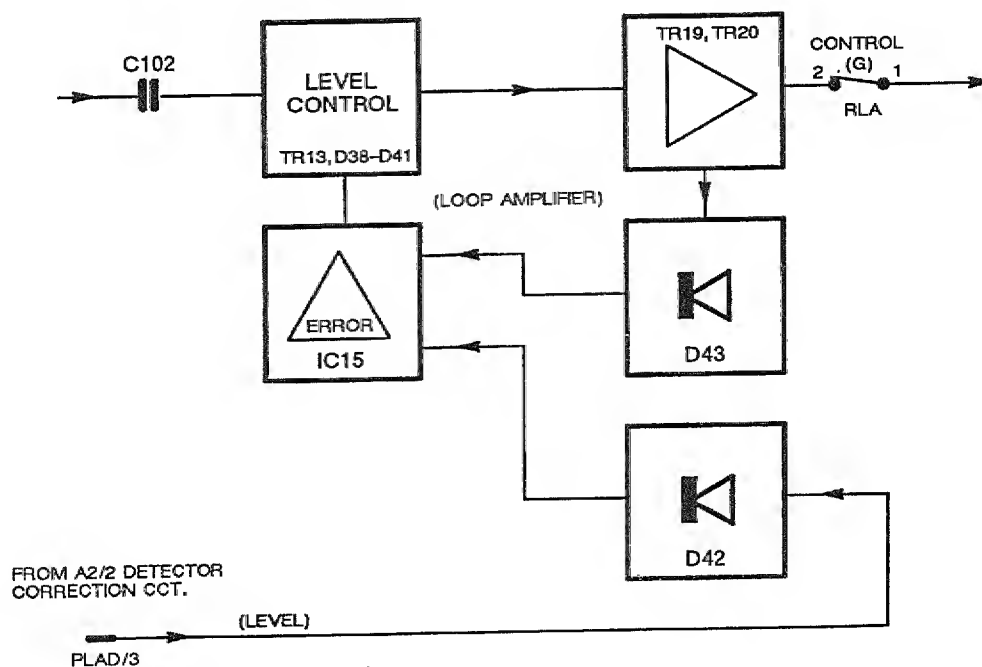


Fig. 4-10 HF output stage (62.5-1010 MHz) simplified block diagram (AB1/2)

85. The HF output amplifier stage comprises TR19 and TR20 together with D43 output detector, loop amplifier IC15, TR13, and pin diodes D38-D41. The stage is required not only to provide levelled output over the range -7 to +10 dBm but also amplitude modulation of up to 80%. The total dynamic range of the ALC is thus +10 to -21 dBm. AM is specified using carrier frequencies up to 400 MHz although the circuit is usable to 1010 MHz.

86. The RF reference level is fed to IC15 pin 2 via D42. D42 and D43 are in close thermal contact and operate at similar bias currents so that the voltages dropped across the diodes are accurately matched. IC15 pin 6 goes negative turning on TR13 and D38-D41. The RF output of the amplifier IC14 pin 8 rises until the peak voltage detected by D43 equals the reference voltage. When AM is in use the modulating voltage is superimposed upon the reference. This is performed on A2/2 board and is described in that section.

87. The levelling achieves a defined RF voltage at the input of R123 which provides a 50 Ω source. The output is then fed to relay RLA where point (G) range control logic selects either this output or the output from the BFO system.

96. A mimic detector, D44 and C110 peak detects the combined level and AM signal arriving at PLAD pin 3. As the AM is added the RF level reference voltage at the junction of R105, R106 increases due to the action of D44. Since the reference and AF detected levels are summed at IC12 pin 6 the AM induced level error is cancelled out.

97. At low modulation frequencies the detector output will decay between envelope peaks at a rate depending on its time constant. In order to preserve the AM the reference voltage applied to the error amplifier must match the RF detector voltage exactly. If this is not accomplished IC12b error amplifier will produce a control signal that will tend to remove the AM from the RF signal. To make the reference behave in a similar manner as the AF detector voltage the mimic detector is set to have the same time constant as the RF detector.

98. The two detectors are of opposite polarity and C104 provides a long time constant to give a DC output from IC12b that is a measure of the error in carrier level irrespective of whether AM is in use or not. This is fed back to the current-controlled attenuator to set the level of signal at the mixer input such that the output level is correct. In common with the HF output amplifier, the signal is levelled as a voltage and R122 gives a source impedance of 50 Ω .

POWER SUPPLY/CONTROL (A0/1 and A2/2)

Circuit diagram : Figs. 7-2, 7-4 & 7-5

99. The primary purpose of this board is to interface and control the various areas of the instrument that require access to the microprocessor via the internal instrument bus. There are three main areas on the board, analogue control, digital control and power supplies. These are described as follows:-

Power supplies. Four stabilized voltage lines are derived. These are +24 V, +12 V, +5 V and -12 V d.c. The +5 V rail chiefly supplies digital ICs. This is generated using discrete circuitry. The +12 V and -12 V rails supply a number of amplifiers and use monolithic 3-terminal regulators. A +24 V rail is used for low current purposes and is generated using a voltage doubler.

Digital control section. Interrupts are controlled and routed to the microprocessor. A serial bus from the microprocessor is converted to an 8-bit parallel format which is then fed to latches on both A2/2 board and other boards. Address lines are also decoded on this board. The display drives on A1/2 board are supplied with a special format serial bus from A2/2 and data appearing on the 8-bit data bus can be converted back to serial data for transfer to the microprocessor.

Analogue control. This area has several functions as listed below. Control data for each of the operations is routed via the 8 way bus:-

- (1) Modulation signal ALC
- (2) Modulation depth or deviation control
- (3) RF level control
- (4) RF filter tuning
- (5) Reverse power protection
- (6) Attenuator drive
- (7) Jitter correction drive

Power supplies

100. The AC mains supply range is set by two selector switches, SB and SC whose position is locked by a reversible locking plate. Supply transformer T1 and fuses FS1, FS2 are mounted on the rear panel assembly which can easily be hinged to provide access.

101. **+5 V supply line.** A0/1 T1 secondary 2 is used to supply rectifiers D1 and D2 via PLF pins 1,3 and 4. A2/2 IC3 controls the +5 V rail providing both short circuit current limiting and stable voltage regulation. A voltage reference diode, D10 provides a stable reference point on the resistor chain R12-R15 against which the sense point (junction of R19/R20/R112) is compared. R15 is adjusted for $5.1 \text{ V} \pm 0.1 \text{ V}$.

102. If the sense voltage at R19/R20/R112 is *greater* than the reference voltage at the junction of R13/R14 IC3a output reduces and so does the drive to A2/2 TR1 base. R3 and R11 set the maximum permissible current limits for A2/2 TR1 collector and base respectively. A0/1 TR1 and A2/2 TR1 form a super beta pair with control of A2/2 TR1 base effectively setting the operating point of A0/1 TR1. The emitter of A0/1 TR1 is connected via R19 to the sense point so that reducing the current flowing into A2/2 TR1 base, current flowing through A0/1 TR1 also reduces. The voltage across the load will then fall to cancel the initial increase of sense voltage. This negative feedback system will equalize the voltage at the regulator output and at IC3a pin 3 to a nominal +5 V.

103. C49, C39 and R105 improve the transient response. Current limiting is achieved by monitoring the voltage drop across series resistor R19. Resistors R17 and R112 apply this voltage to IC3b. If due to excess current, the voltage at the junction of R16, R18 and R17 exceeds that on R112, then IC36 pin 7 will go negative, depriving A2/2, TR1 of base current by drawing it instead through R10 and D9. This will restrict the current flowing into the load.

104. In order to visualize the current limiting that occurs consider R16/R18 as a Thevenin equivalent ($9.09\text{ k}\Omega$ down to -1.09 V) and note that no current flows into IC3b pin 6. As the voltage at pin 5 falls, a lesser voltage at the top of R17 will be sufficient to bring the voltage of IC3b pin 6 up to equal that of IC3b pin 5. This implies a lower voltage *across* R19, i.e. the overall regulator current limit goes down as the output voltage goes down. This reduces short circuit dissipation in A0/1 TR1. However to provide assistance when fault finding, it is preferable to have some current flowing even under abnormal load conditions. The short circuit current is therefore deliberately not equal to zero.

105. **+12 V supply line.** A0/1 T1 secondary 1 winding is used to supply the bi-phase rectifier D3 which in turn charges C2. A0/1 IC1 and resistor chain A2/2 R4-R6 provide a +12 V regulated output with short circuit current limiting and over temperature protection. The voltage at PLH pin 5 is approximately 1.3 V below that at PLH pins 6 and 7 and the regulator A0/1 IC1 compares the voltage sensed at pins 5 and 7 with an internal bandgap reference. Current then flows out from the regulator via PLH pin 6 until the voltages equalize. PLH pin 7 receives a separate sensing signal from the regulator to improve the load regulation. D5 protects A0/1 IC1 from positive voltages on PLH pin 6 when PLH pin 4 voltage is low. C9 improves the ripple rejection.

106. **-12 V supply line.** Voltage in this circuit is generated in an identical manner to the +12 V supply except that the components are mounted on A2/2 board. One additional component, R108 is fitted to dissipate some of the heat generated and allow a smaller heatsink clip to be fitted to A2/2 IC1.

107. **+24 V supply line & voltage doubler circuit** is used to obtain this low current supply rail which is obtained via A0/1 T1 secondary 1 winding. All the components of the doubler circuit are mounted on A2/2 board. Consider the charge on C3; when the voltage at PLF pin 7 falls below zero C3 is charged through the lower left-hand diode of bridge D4.

108. When the positive phase of A0/1 T1 begins, the positive charge on C3 will start to charge C6 through the upper left hand diode of bridge D4. If little current is drawn the charge on C6 will remain and eventually the voltage across it will build up to the peak output from A0/1 T1 and in addition the peak voltage developed across C3 i.e. approximately twice the peak output of A0/1 T1. C4 charges C6 during the negative cycles of A0/1 T1.

109. C2 regulator is similar in its operation to A0/1 IC1 with resistor chain R7-R9, R8 providing the means of adjustment to $+24\text{ V} \pm 0.25\text{ V}$.

Digital control section

110. The circuit shown in Fig. 4-12 below illustrates how the microprocessor communicates with all the instrument latches, other than those on the synthesizer board. It does this over a serial bus which is converted to, and from, parallel data.

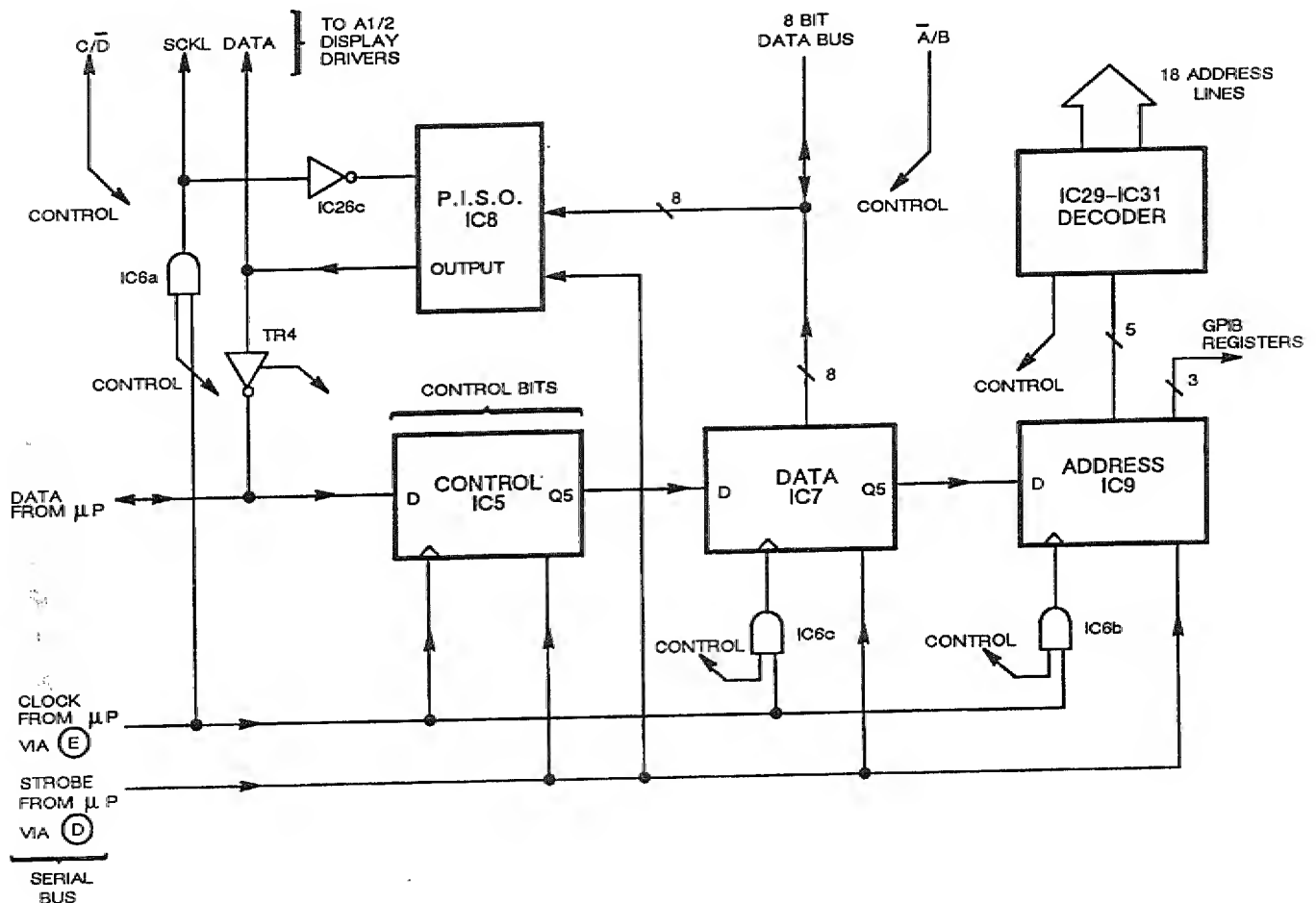


Fig. 4-12 Data conversion, simplified block diagram (A2/2)

111. **Serial to parallel conversion.** Serial data is initially fed to IC5, pin 2 DATA input, shift register and is clocked in on the positive edge of the CLOCK input at IC5 pin 3. After eight bits have been entered, IC5 output Qs begins to change state; IC5 at this point acts like a delay unit eight clock cycles long i.e. data entered on the D input via IC5 pin 2 appears eight cycles later at Qs. It is also possible to transfer data that is clocking through on to the outputs Q1 - Q8. This is done by taking the STROBE line to logic 'high'. IC7 and IC9 are identical to IC5 in operation.

112. Since the clock inputs of IC7 and IC9 are gated (using IC6b and c) to IC5 outputs Q1 and Q2 respectively, IC5 must be loaded with the appropriate control byte before the data and address lines can be set. Having sent the first byte (containing data which will be discussed later), three more bytes need to be clocked through to load IC7 and IC9. The first will go direct to IC9, the second to IC7 and the last to IC5.

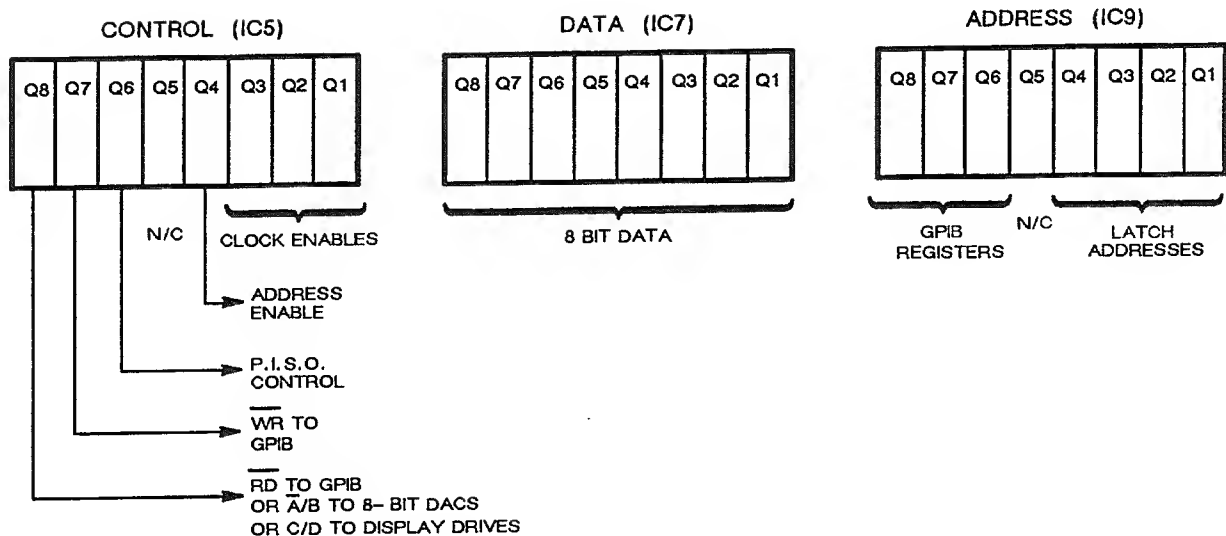


Fig. 4-13 Serial data string (A2/2)

113. The control latch, IC5, sends information to one of three possible destinations:
- Serial data for the display goes via the Display Data Converter (IC8).
 - 8-bit bytes for the keyboard and GPIB are sent via Data Converter IC7.
 - Outputs Q1 to Q5 of Address Converter IC9 drive a Register Address decoder consisting of IC29-31 which provides address and control signals for various d-a converters and other devices on the A2/2 board.

Note that pin 7 of IC5 provides a strobe line for the Register Address Decoder.

114. If *display* data is required it has to be converted back into serial form before being sent to A1/2 display drivers, IC1 and IC2. However a variety of *command* data is required when the display is initially set at switch on and the differentiation is made by taking IC5, Q8 'high' instead of 'low'. One of IC30's outputs will be taken 'low'. Data will be accepted on the returning positive edge.

115. **Parallel to serial conversion.** To change from parallel to serial format an 8-bit shift register, which may be pre-loaded, is used (IC8). Data present on inputs D0 - D7 is clocked out on Q8 and either sent to the display, in which case TR3 is switched on (Q6 of IC5 held 'low'), or sent back to the microprocessor. In the latter instance IC5, Q6 is held 'high' and TR4 acts as an inverter. C17, R24 and IC4 act as a monostable with an output duration of approximately 10 μ s. This is triggered on a negative-going edge of the STROBE line. When the STROBE line is asserted 'low', parallel data is forced into IC8. This may then be clocked out by taking IC5, Q3 'high'. The use of a single clock ensures that the clock edges and the data are synchronized.

116. **Interrupts.** The microprocessor will normally be executing a 'zero task' whilst the instrument provides the output signal requested. If a change is required it must first be interrupted and then be made to respond according to the new information presented. The interrupts may be from any of the following four sources:

- GPIB
- Keyboard
- Reverse power protection system
- Modulation signal automatic levelling loop, i.e. signal too high or too low.

117. **GPIB interrupt (High priority).** IC4e pin 3 will be asserted 'high' causing a negative-going edge to be sent to IC12d pin 12 and asserting IC13 pin 12 'low'. IC12d pin 13 will normally be at logic 'high' and IC12d NAND gate will function as an inverter causing a positive edge output to occur at the output on pin 11. This is then fed as the INTERRUPT line via PLL pin 13 to AA2/1 microprocessor. R25 prevents spurious interrupts if the GPIB is not connected. The microprocessor will react by addressing IC13 latch and reading D3 and D4 outputs to determine whether it is GPIB or keyboard requesting the interrupt. The microprocessor will then execute the necessary tasks to accept incoming data.

118. **Keyboard interrupt (High priority).** Action here is the same as described above, IC6d pin 12 goes 'low' IC6d pin 11 also goes 'low' creating a positive edge on IC12d pin 11.

119. **Reverse power protection system interrupt.** Relay AC1 RLF is normally energized when the instrument is switched on. Should there be an accidental application of reverse power AC1 RLF will trip. A2/2, TR16 is turned off and IC12c pin 8 will go 'low'. IC12c pin 9 will be 'high' therefore asserting IC12c pin 10 'high'. This will cause IC4f pin 4 to go 'low' causing a positive edge on IC12d pin 11. Pin 12 is held 'high' and a positive edge INTERRUPT pulse will again be created on IC12d pin 11 and routed to the micro-processor via PLL pin 13. To monitor keyboard interrupts (those required to reset the RPP) the outputs of IC13 are scanned. If a change is detected the normal keyboard reading sequence will occur but only RPP will have any effect. GPIB interrupts are also dealt with using the scanning process.

120. **Modulation signal automatic levelling loop (ALC) interrupt.** If the modulation signal applied is of a level that takes the control system outside preset limits (0 V and -6 V on IC15b pin 8) an interrupt will be caused. If the modulation level is insufficient, IC12a pin 1 will go 'low' and pin 3 'high'. IC12b pin 6 will normally be set 'high' thus pin 4 will go 'low'. IC12c pin 10 is then set 'high', IC4f pin 4 is sent 'low' and as before a positive edge on IC12d pin 11 INTERRUPT line is created. A similar action occurs if the modulation signal is excessive. This is the only interrupt that can be masked and this is carried out by setting IC11 Q3 'low'. If an interrupt from this system is read the microprocessor will periodically assert IC11 Q3 'high' and check to see if the modulation signal is within the specified limits.

Analogue control

121. **Modulation signal ALC.** This system is always in operation when the instrument is selected to INT MOD but can be selected in or out with the front panel MOD ALC key when in EXT MODulation mode. MOD ALC on is indicated by an LED adjacent to the key. The internal modulation signal is routed through RLA by taking IC11 Q0 'high'. R29 provides an approximate 600 Ω source impedance for the MOD IN/OUT front panel socket SKA.

122. IC15 is configured as a non-inverting amplifier with resistors R113 (adjust EXT MOD), R38, R35-R37 providing a feedback potential divider chain. TR6 is switched on via IC11 Q2 if MOD ALC is not required, this also switches TR7 off to give a fixed gain of nominally 3.54 from the circuit. If MOD ALC is selected TR7 then provides the mechanism for varying the gain of the stage by using it as an approximation to a voltage controlled resistor.

123. D14,C25 peak detect the output signal which is used as an offset against a negative voltage produced by R44,R45 and D15. Both voltages are summed at IC15 pin 9 and if the result is not zero then the output of IC15, pin 8 will integrate up or down charging C26. If IC15 pin 8 output were to increase (due to a low level signal at IC15 pin 7), then TR7 gate would also increase via R40 to turn on TR7 (R39,C24 improve the control/signal isolation).

124. When TR7 turns on its resistance between drain and source reduces and the gain of the stage increases. The output of the amplifier then goes up by a corresponding amount to give the required increase in output voltage. D16 improves speed by preventing C16 charging beyond +0.6 V. When the gate of TR7 is at 0 V, TR7 will be fully on – normal control is usually –3 or –4 V.

125. TR7's control voltage is monitored by IC18a and IC18b. If the level goes above 0 V IC18a's output switches low causing a 'LEVEL LO' interrupt. If the level goes below –6 V then IC18b output decreases and a 'LEVEL HI' interrupt is generated. It will simultaneously increase the signal level required for levelling at IC15a, pin 7. This hysteresis prevents multiple interrupts caused by a low frequency input signal whose level may be at the point of being just too high.

126. **Modulation depth/deviation control.** Three forms of modulation are possible AM, FM, or Φ M. These are controlled by three dual, digital-to-analogue converters (DACs). Both absolute level and calibration data are entered using these digital-to-analogue converters.

127. **Combining Auxiliary, External and Internal modulating signals.** The required combination of internal, external and auxiliary modulation is summed as shown in Fig. 4-14 and the resultant waveform is sent to the reference voltage pin (Pin 4) of multiplying DAC IC19.

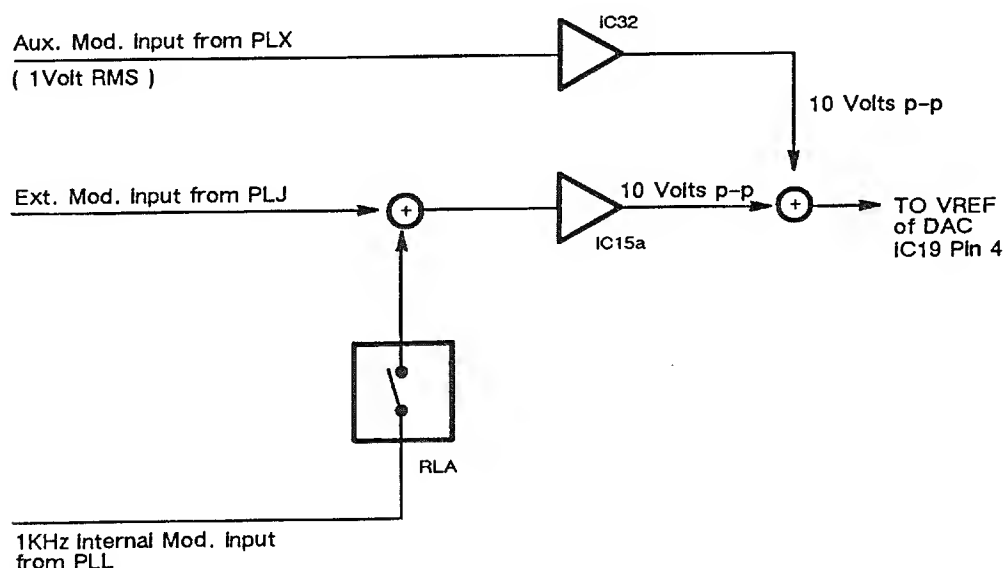


Fig. 4-14 Combining Aux., Ext. and Int. modulating signals (A2/2)

VCO system (250–505 MHz)

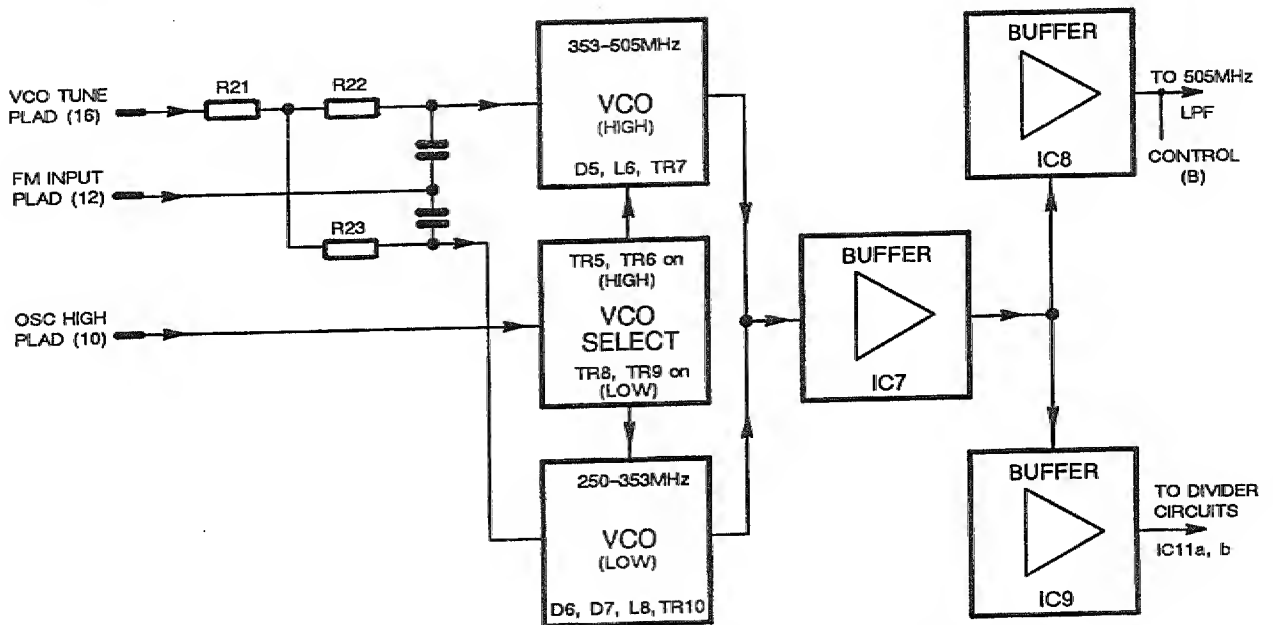


Fig. 4–7 250–500 MHz VCO system simplified block diagram (AB1/2)

69. Two oscillators are used to cover the basic frequency range each one generating one half octave. Changeover occurs at 353 MHz. The upper half octave 353 – 500 MHz is generated from a tuned circuit formed by C31, D5, and L6, the latter is only evident as a thicker length of track on the PCB. The base of TR7 oscillator is driven from the centre tap of L6 and the collector via C37 and R34, these components are positioned so as to be mutually coupled to the oscillator tuned circuit.

70. R32, R33, C33 and C34 control the impedance of oscillator TR7 and compensate for unwanted internal phase shift within the transistor. Having resistors in both emitter and collector circuits also prevents the formation of parasitic resonance which would otherwise occur via the transistor's junction capacitances.

71. Tuning of the oscillator is carried out by the varactor D5 with bias applied via L5. The LF end of the oscillator range may be adjusted by C31 for 2 V at 353 MHz. The HF end of the range should be approximately 15 V at 500 MHz. Output is taken from a low tapping point on L6, via R27.

72. The lower half octave oscillator 250 – 352 MHz operates in a similar manner with the capacitor values doubled in the tuned circuit to give the half-octave reduction in frequency.

73. Selection 353 – 505 MHz (HIGH) and 250 – 352 MHz (LOW) is carried out by the OSC HIGH control line (PLAD pin 10) from A2/2 Control circuit. When this is asserted 'high' TR5 and TR6 conduct and complete the –12 V supply line to allow TR7 to conduct. When the OSC HIGH control line is at logic 'low' TR8 and TR9 conduct and TR10 is powered. Because only one oscillator is powered at a time from the single control line, outputs are resistively summed at the input of IC7 amplifier. Both oscillators and amplifier are mounted within the on-board screening so as to achieve a very low level of load reaction.

Frequency dividers (62.5 – 250 MHz)

74. The VCO output range (250 – 500 MHz) is divided into three paths via IC8, IC9 and IC10 buffer amplifiers. IC8 provides the signal path for the 250 – 500 MHz range, IC9 the 62.5 – 250 MHz range and IC10 provides a synchronizing output to AA1/1 programmable dividers.

75. Selecting of the required signal path is controlled by IC4–IC6 signal gating circuit. The control data is input via PLAD pins 6,7 and 11 and is shown on the circuit diagram as range control logic and uses the letters (A) to (G) to indicate where assertion of data (negative true logic) is made.

76. The output from IC9 drives two binary frequency dividers IC11a and IC11b. These D type flip-flops are wired as two binary dividers by connecting the Q outputs to their respective D inputs. The first divider is clocked via pin 11. Both Q and QL outputs are utilized, driving opposite ends of T1 balancing transformer. The output is taken from a third winding via D15 when control logic line (B) is asserted. This arrangement gives a symmetrical output waveform containing little second harmonic therefore simplifying filtering.

77. When (F) is asserted 'low' R59 and R61 provide bias to allow IC11a divider to operate. R58 and R60 provide bias to the clock inputs via L16 and L35 to maintain these at the mean logic level. The second divider operates when the bias provided via R78 and R79 is applied, this occurs when both (A) and (F) are asserted 'low'.

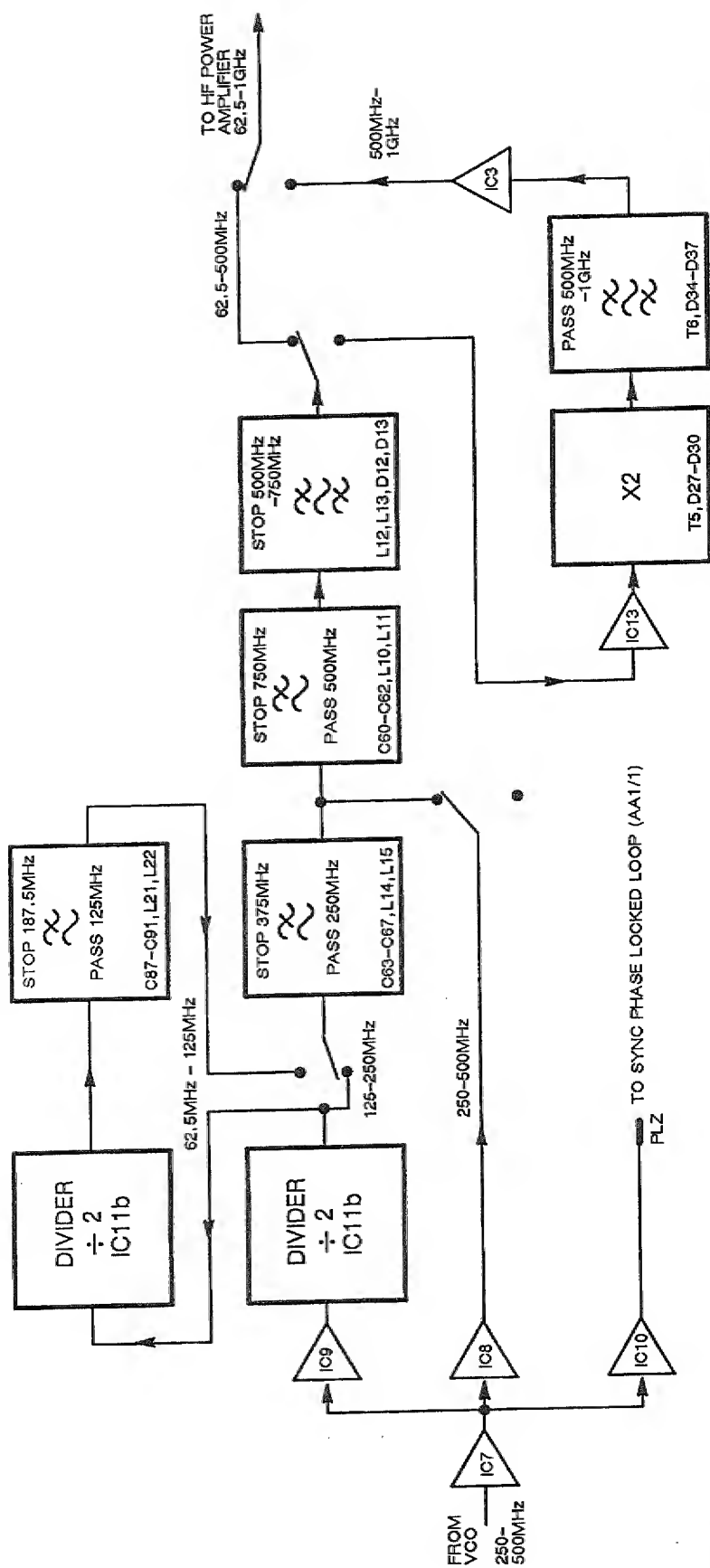


Fig. 4-8 Frequency dividers, simplified block diagram (AB1/2)

78. **250 – 500 MHz.** When frequencies in this range are selected, point (E) is taken 'low' turning D8 and D9 on and D10 off. (F), (A) and (B) are taken 'high', disabling IC11a,b dividers; D11 is also turned off. The signal path is then routed from IC8 and through a 500 MHz low-pass filter comprising L10,L11,C60–C62. Cut off frequency of this filter is 750 MHz enabling signals of up to 500 MHz to pass but none of the third or higher harmonics. A further tunable notch filter L12,L13,D12 and D13 eliminates the second harmonics in the range 500–750 MHz.

79. **125 – 250 MHz.** When frequencies in this range are required, point (E) is taken 'high', D8 and D9 are turned off and D10 is turned on. Points (F) and (B) are taken 'low' activating IC11a first divider. D11,D14 and D15 are also turned on and D17,D18 are turned off. The first divider's output is routed via D15 and D14 to a 250 MHz low-pass elliptic filter comprising L14,L15, C63–C67. Cut off frequency of this filter is 375 MHz so the required range is passed but the third harmonic in the band 375 – 750 MHz (and higher harmonics) are eliminated. The signal is then routed from the low-pass filter via D11 to the input of the 500 MHz low-pass filter to be combined with the 250 – 500 MHz signal frequency range.

80. **62.5 – 125 MHz.** When frequencies in this range are required, points (A) and (F) are taken 'low' and (B) is taken 'high'. D15 is turned off, D16 and D18 are turned on, both IC11a and IC11b dividers operate and the output (62.5–125 MHz) is taken from T4 transformer secondary. The signal is passed through a 125 MHz low-pass filter L21, L22,C87–C91. Cut off frequency of the filter is 187.5 MHz to eliminate the third and higher harmonics. This allows the required 62.5–125 MHz band to be routed via D16 to the 250 MHz low-pass filter L14,L15. The signal is then combined with the 125–250 MHz and the 250–500 MHz signal paths as far as the junction C71,D20,D21.

81. At C71 the signal paths divide. When signals in the range 62.5–500 MHz are selected, point (C) is taken low and point (D) is taken 'high', D20, D23 and D31 are turned on and D32 is turned off. Signals are routed to the input of the HF output amplifier stage via D20,D23,D31 and C102.

Frequency doubler (500–1010 MHz)

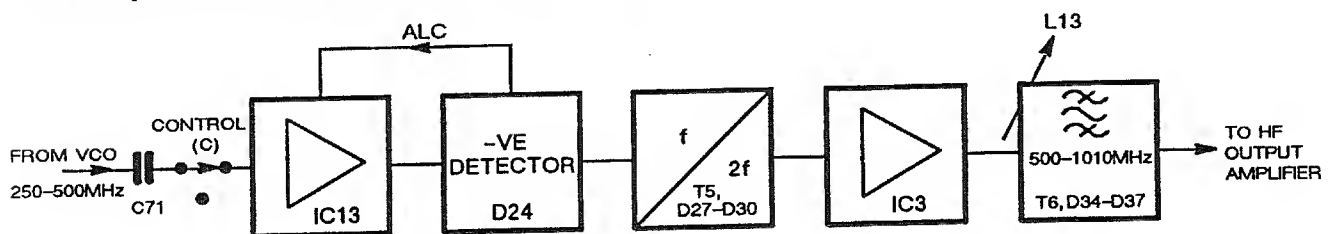


Fig. 4–9 Frequency multipliers, simplified block diagram (AB1/2)

82. The frequency range of 500–1010 MHz is obtained by taking the VCO output range (250–500 MHz) from the output of the 500–1010 MHz notch filter and following this with a frequency doubler circuit. Selection is effected by the assertion of the range control logic, point (C) is taken 'high' and point (D) is taken 'low'. D20 is turned off and the signal path is then taken via the amplifier IC13. Output from IC13 is detected by D24 which drives an automatic level correction circuit. This controls the RF resistance of D21,D22 and thus the drive to the doubler circuit.

83. The frequency doubler circuit comprises T5, balancing transformer and D27-D30 diode bridge. Insertion loss of the doubler is compensated for by IC3 which provides 12 dB of amplification. This output is filtered by a 500-1010 MHz voltage tuned band-pass filter comprising D34-D37 and T6.

84. The filter together with the 500-1010 MHz voltage tuned notch filter previously described share a common control line. This originates from a digital-to-analogue converter on A2/2 board via PLAD pin 15. Tracking data is set by the requirements of the band-pass filter which has no other means of adjustment. The notch filter is then aligned to this data by adjustment of L13. Output from the 500-1010 MHz band-pass filter is connected via D32 and C102 to the HF output amplifier.

HF output stage (62.5-1010 MHz)

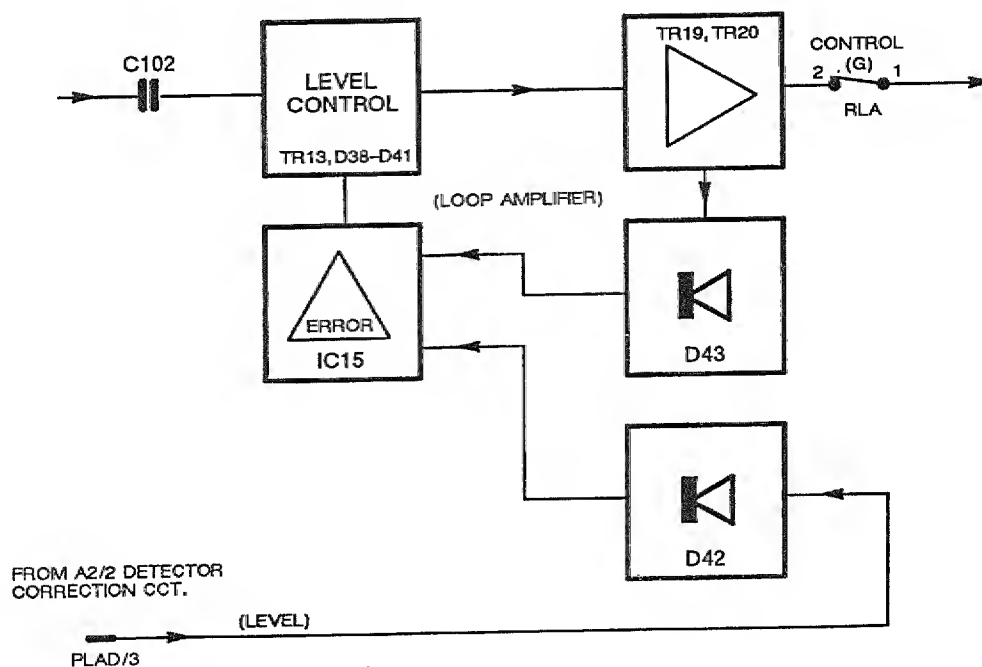


Fig. 4-10 HF output stage (62.5-1010 MHz) simplified block diagram (AB1/2)

85. The HF output amplifier stage comprises TR19 and TR20 together with D43 output detector, loop amplifier IC15, TR13, and pin diodes D38-D41. The stage is required not only to provide levelled output over the range -7 to +10 dBm but also amplitude modulation of up to 80%. The total dynamic range of the ALC is thus +10 to -21 dBm. AM is specified using carrier frequencies up to 400 MHz although the circuit is usable to 1010 MHz.

86. The RF reference level is fed to IC15 pin 2 via D42. D42 and D43 are in close thermal contact and operate at similar bias currents so that the voltages dropped across the diodes are accurately matched. IC15 pin 6 goes negative turning on TR13 and D38-D41. The RF output of the amplifier IC14 pin 8 rises until the peak voltage detected by D43 equals the reference voltage. When AM is in use the modulating voltage is superimposed upon the reference. This is performed on A2/2 board and is described in that section.

87. The levelling achieves a defined RF voltage at the input of R123 which provides a 50 Ω source. The output is then fed to relay RLA where point (G) range control logic selects either this output or the output from the BFO system.

96. A mimic detector, D44 and C110 peak detects the combined level and AM signal arriving at PLAD pin 3. As the AM is added the RF level reference voltage at the junction of R105, R106 increases due to the action of D44. Since the reference and AF detected levels are summed at IC12 pin 6 the AM induced level error is cancelled out.

97. At low modulation frequencies the detector output will decay between envelope peaks at a rate depending on its time constant. In order to preserve the AM the reference voltage applied to the error amplifier must match the RF detector voltage exactly. If this is not accomplished IC12b error amplifier will produce a control signal that will tend to remove the AM from the RF signal. To make the reference behave in a similar manner as the AF detector voltage the mimic detector is set to have the same time constant as the RF detector.

98. The two detectors are of opposite polarity and C104 provides a long time constant to give a DC output from IC12b that is a measure of the error in carrier level irrespective of whether AM is in use or not. This is fed back to the current-controlled attenuator to set the level of signal at the mixer input such that the output level is correct. In common with the HF output amplifier, the signal is levelled as a voltage and R122 gives a source impedance of 50 Ω .

POWER SUPPLY/CONTROL (A0/1 and A2/2)

Circuit diagram : Figs. 7-2, 7-4 & 7-5

99. The primary purpose of this board is to interface and control the various areas of the instrument that require access to the microprocessor via the internal instrument bus. There are three main areas on the board, analogue control, digital control and power supplies. These are described as follows:-

Power supplies. Four stabilized voltage lines are derived. These are +24 V, +12 V, +5 V and -12 V d.c. The +5 V rail chiefly supplies digital ICs. This is generated using discrete circuitry. The +12 V and -12 V rails supply a number of amplifiers and use monolithic 3-terminal regulators. A +24 V rail is used for low current purposes and is generated using a voltage doubler.

Digital control section. Interrupts are controlled and routed to the microprocessor. A serial bus from the microprocessor is converted to an 8-bit parallel format which is then fed to latches on both A2/2 board and other boards. Address lines are also decoded on this board. The display drives on A1/2 board are supplied with a special format serial bus from A2/2 and data appearing on the 8-bit data bus can be converted back to serial data for transfer to the microprocessor.

Analogue control. This area has several functions as listed below. Control data for each of the operations is routed via the 8 way bus:-

- (1) Modulation signal ALC
- (2) Modulation depth or deviation control
- (3) RF level control
- (4) RF filter tuning
- (5) Reverse power protection
- (6) Attenuator drive
- (7) Jitter correction drive

Power supplies

100. The AC mains supply range is set by two selector switches, SB and SC whose position is locked by a reversible locking plate. Supply transformer T1 and fuses FS1, FS2 are mounted on the rear panel assembly which can easily be hinged to provide access.

101. **+5 V supply line.** A0/1 T1 secondary 2 is used to supply rectifiers D1 and D2 via PLF pins 1,3 and 4. A2/2 IC3 controls the +5 V rail providing both short circuit current limiting and stable voltage regulation. A voltage reference diode, D10 provides a stable reference point on the resistor chain R12-R15 against which the sense point (junction of R19/R20/R112) is compared. R15 is adjusted for $5.1 \text{ V} \pm 0.1 \text{ V}$.

102. If the sense voltage at R19/R20/R112 is *greater* than the reference voltage at the junction of R13/R14 IC3a output reduces and so does the drive to A2/2 TR1 base. R3 and R11 set the maximum permissible current limits for A2/2 TR1 collector and base respectively. A0/1 TR1 and A2/2 TR1 form a super beta pair with control of A2/2 TR1 base effectively setting the operating point of A0/1 TR1. The emitter of A0/1 TR1 is connected via R19 to the sense point so that reducing the current flowing into A2/2 TR1 base, current flowing through A0/1 TR1 also reduces. The voltage across the load will then fall to cancel the initial increase of sense voltage. This negative feedback system will equalize the voltage at the regulator output and at IC3a pin 3 to a nominal +5 V.

103. C49, C39 and R105 improve the transient response. Current limiting is achieved by monitoring the voltage drop across series resistor R19. Resistors R17 and R112 apply this voltage to IC3b. If due to excess current, the voltage at the junction of R16, R18 and R17 exceeds that on R112, then IC36 pin 7 will go negative, depriving A2/2, TR1 of base current by drawing it instead through R10 and D9. This will restrict the current flowing into the load.

104. In order to visualize the current limiting that occurs consider R16/R18 as a Thevenin equivalent (9.09 k Ω down to -1.09 V) and note that no current flows into IC3b pin 6. As the voltage at pin 5 falls, a lesser voltage at the top of R17 will be sufficient to bring the voltage of IC3b pin 6 up to equal that of IC3b pin 5. This implies a lower voltage *across* R19, i.e. the overall regulator current limit goes down as the output voltage goes down. This reduces short circuit dissipation in A0/1 TR1. However to provide assistance when fault finding, it is preferable to have some current flowing even under abnormal load conditions. The short circuit current is therefore deliberately not equal to zero.

105. +12 V supply line. A0/1 T1 secondary 1 winding is used to supply the bi-phase rectifier D3 which in turn charges C2. A0/1 IC1 and resistor chain A2/2 R4-R6 provide a +12 V regulated output with short circuit current limiting and over temperature protection. The voltage at PLH pin 5 is approximately 1.3 V below that at PLH pins 6 and 7 and the regulator A0/1 IC1 compares the voltage sensed at pins 5 and 7 with an internal bandgap reference. Current then flows out from the regulator via PLH pin 6 until the voltages equalize. PLH pin 7 receives a separate sensing signal from the regulator to improve the load regulation. D5 protects A0/1 IC1 from positive voltages on PLH pin 6 when PLH pin 4 voltage is low. C9 improves the ripple rejection.

106. -12 V supply line. Voltage in this circuit is generated in an identical manner to the +12 V supply except that the components are mounted on A2/2 board. One additional component, R108 is fitted to dissipate some of the heat generated and allow a smaller heatsink clip to be fitted to A2/2 IC1.

107. +24 V supply line & voltage doubler circuit is used to obtain this low current supply rail which is obtained via A0/1 T1 secondary 1 winding. All the components of the doubler circuit are mounted on A2/2 board. Consider the charge on C3; when the voltage at PLF pin 7 falls below zero C3 is charged through the lower left-hand diode of bridge D4.

108. When the positive phase of A0/1 T1 begins, the positive charge on C3 will start to charge C6 through the upper left hand diode of bridge D4. If little current is drawn the charge on C6 will remain and eventually the voltage across it will build up to the peak output from A0/1 T1 and in addition the peak voltage developed across C3 i.e. approximately twice the peak output of A0/1 T1. C4 charges C6 during the negative cycles of A0/1 T1.

109. C2 regulator is similar in its operation to A0/1 IC1 with resistor chain R7-R9, R8 providing the means of adjustment to +24 V ± 0.25 V.

111. **Serial to parallel conversion.** Serial data is initially fed to IC5, pin 2 DATA input, shift register and is clocked in on the positive edge of the CLOCK input at IC5 pin 3. After eight bits have been entered, IC5 output Qs begins to change state; IC5 at this point acts like a delay unit eight clock cycles long i.e. data entered on the D input via IC5 pin 2 appears eight cycles later at Qs. It is also possible to transfer data that is clocking through on to the outputs Q1 – Q8. This is done by taking the STROBE line to logic 'high'. IC7 and IC9 are identical to IC5 in operation.

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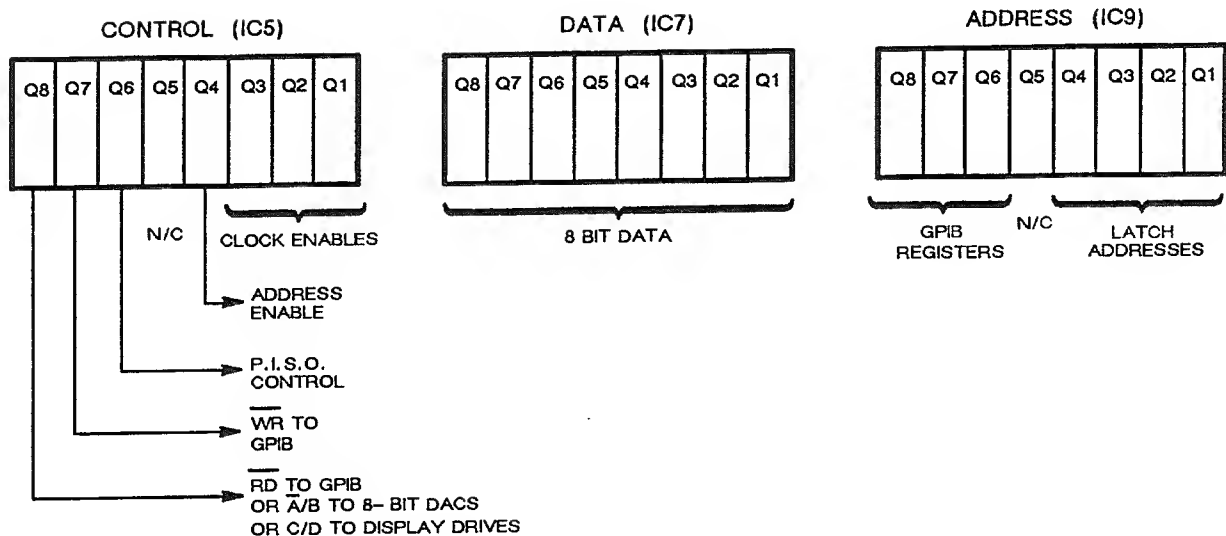


Fig. 4-13 Serial data string (A2/2)

113. The control latch, IC5, sends information to one of three possible destinations:
- Serial data for the display goes via the Display Data Converter (IC8).
 - 8-bit bytes for the keyboard and GPIB are sent via Data Converter IC7.
 - Outputs Q1 to Q5 of Address Converter IC9 drive a Register Address decoder consisting of IC29-31 which provides address and control signals for various d-a converters and other devices on the A2/2 board.

Note that pin 7 of IC5 provides a strobe line for the Register Address Decoder.

114. If *display* data is required it has to be converted back into serial form before being sent to A1/2 display drivers, IC1 and IC2. However a variety of *command* data is required when the display is initially set at switch on and the differentiation is made by taking IC5, Q8 'high' instead of 'low'. One of IC30's outputs will be taken 'low'. Data will be accepted on the returning positive edge.

115. **Parallel to serial conversion.** To change from parallel to serial format an 8-bit shift register, which may be pre-loaded, is used (IC8). Data present on inputs D0 - D7 is clocked out on Q8 and either sent to the display, in which case TR3 is switched on (Q6 of IC5 held 'low'), or sent back to the microprocessor. In the latter instance IC5, Q6 is held 'high' and TR4 acts as an inverter. C17, R24 and IC4 act as a monostable with an output duration of approximately 10 μ s. This is triggered on a negative-going edge of the STROBE line. When the STROBE line is asserted 'low', parallel data is forced into IC8. This may then be clocked out by taking IC5, Q3 'high'. The use of a single clock ensures that the clock edges and the data are synchronized.

116. **Interrupts.** The microprocessor will normally be executing a 'zero task' whilst the instrument provides the output signal requested. If a change is required it must first be interrupted and then be made to respond according to the new information presented. The interrupts may be from any of the following four sources:

- GPIB
- Keyboard
- Reverse power protection system
- Modulation signal automatic levelling loop, i.e. signal too high or too low.

117. **GPIB interrupt (High priority).** IC4e pin 3 will be asserted 'high' causing a negative-going edge to be sent to IC12d pin 12 and asserting IC13 pin 12 'low'. IC12d pin 13 will normally be at logic 'high' and IC12d NAND gate will function as an inverter causing a positive edge output to occur at the output on pin 11. This is then fed as the INTERRUPT line via PLL pin 13 to AA2/1 microprocessor. R25 prevents spurious interrupts if the GPIB is not connected. The microprocessor will react by addressing IC13 latch and reading D3 and D4 outputs to determine whether it is GPIB or keyboard requesting the interrupt. The microprocessor will then execute the necessary tasks to accept incoming data.

118. **Keyboard interrupt (High priority).** Action here is the same as described above, IC6d pin 12 goes 'low' IC6d pin 11 also goes 'low' creating a positive edge on IC12d pin 11.

119. **Reverse power protection system interrupt.** Relay AC1 RLF is normally energized when the instrument is switched on. Should there be an accidental application of reverse power AC1 RLF will trip. A2/2, TR16 is turned off and IC12c pin 8 will go 'low'. IC12c pin 9 will be 'high' therefore asserting IC12c pin 10 'high'. This will cause IC4f pin 4 to go 'low' causing a positive edge on IC12d pin 11. Pin 12 is held 'high' and a positive edge INTERRUPT pulse will again be created on IC12d pin 11 and routed to the micro-processor via PLL pin 13. To monitor keyboard interrupts (those required to reset the RPP) the outputs of IC13 are scanned. If a change is detected the normal keyboard reading sequence will occur but only RPP will have any effect. GPIB interrupts are also dealt with using the scanning process.

120. **Modulation signal automatic levelling loop (ALC) interrupt.** If the modulation signal applied is of a level that takes the control system outside preset limits (0 V and -6 V on IC15b pin 8) an interrupt will be caused. If the modulation level is insufficient, IC12a pin 1 will go 'low' and pin 3 'high'. IC12b pin 6 will normally be set 'high' thus pin 4 will go 'low'. IC12c pin 10 is then set 'high', IC4f pin 4 is sent 'low' and as before a positive edge on IC12d pin 11 INTERRUPT line is created. A similar action occurs if the modulation signal is excessive. This is the only interrupt that can be masked and this is carried out by setting IC11 Q3 'low'. If an interrupt from this system is read the microprocessor will periodically assert IC11 Q3 'high' and check to see if the modulation signal is within the specified limits.

Analogue control

121. **Modulation signal ALC.** This system is always in operation when the instrument is selected to INT MOD but can be selected in or out with the front panel MOD ALC key when in EXT MODulation mode. MOD ALC on is indicated by an LED adjacent to the key. The internal modulation signal is routed through RLA by taking IC11 Q0 'high'. R29 provides an approximate 600 Ω source impedance for the MOD IN/OUT front panel socket SKA.

122. IC15 is configured as a non-inverting amplifier with resistors R113 (adjust EXT MOD), R38, R35-R37 providing a feedback potential divider chain. TR6 is switched on via IC11 Q2 if MOD ALC is not required, this also switches TR7 off to give a fixed gain of nominally 3.54 from the circuit. If MOD ALC is selected TR7 then provides the mechanism for varying the gain of the stage by using it as an approximation to a voltage controlled resistor.

123. D14,C25 peak detect the output signal which is used as an offset against a negative voltage produced by R44,R45 and D15. Both voltages are summed at IC15 pin 9 and if the result is not zero then the output of IC15, pin 8 will integrate up or down charging C26. If IC15 pin 8 output were to increase (due to a low level signal at IC15 pin 7), then TR7 gate would also increase via R40 to turn on TR7 (R39,C24 improve the control/signal isolation).

124. When TR7 turns on its resistance between drain and source reduces and the gain of the stage increases. The output of the amplifier then goes up by a corresponding amount to give the required increase in output voltage. D16 improves speed by preventing C16 charging beyond +0.6 V. When the gate of TR7 is at 0 V, TR7 will be fully on – normal control is usually -3 or -4 V.

125. TR7's control voltage is monitored by IC18a and IC18b. If the level goes above 0 V IC18a's output switches low causing a 'LEVEL LO' interrupt. If the level goes below -6 V then IC18b output decreases and a 'LEVEL HI' interrupt is generated. It will simultaneously increase the signal level required for levelling at IC15a, pin 7. This hysteresis prevents multiple interrupts caused by a low frequency input signal whose level may be at the point of being just too high.

126. **Modulation depth/deviation control.** Three forms of modulation are possible AM, FM, or Φ M. These are controlled by three dual, digital-to-analogue converters (DACs). Both absolute level and calibration data are entered using these digital-to-analogue converters.

127. **Combining Auxiliary, External and Internal modulating signals.** The required combination of internal, external and auxiliary modulation is summed as shown in Fig. 4-14 and the resultant waveform is sent to the reference voltage pin (Pin 4) of multiplying DAC IC19.

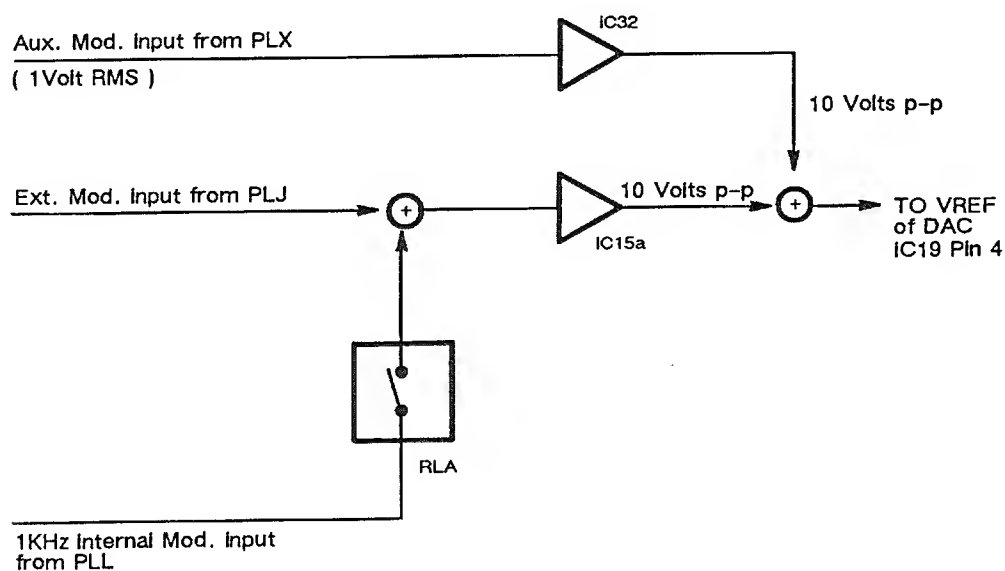


Fig. 4-14 Combining Aux., Ext. and Int. modulating signals (A2/2)

Amplitude modulation above 62.5 MHz

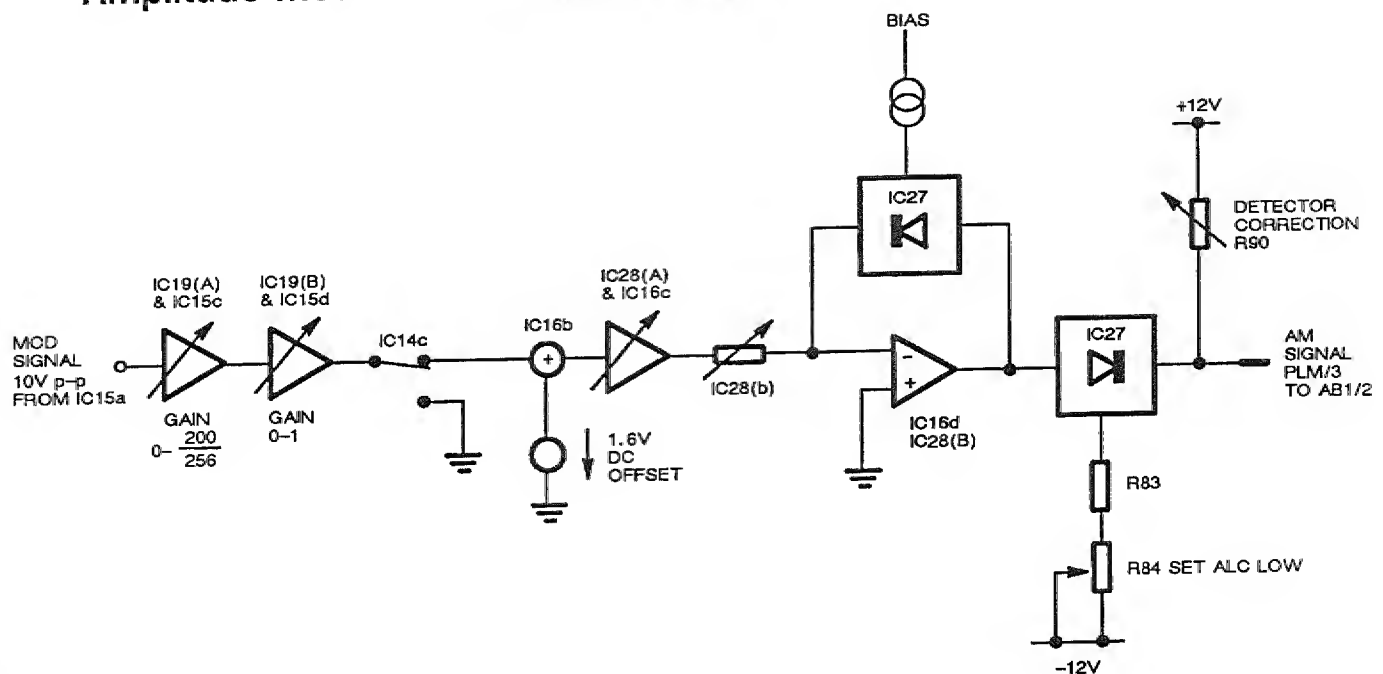


Fig. 4-15 AM signal path >62.5 MHz (A2/2)

128. The series path shown in Fig. 4-15 requires four sets of data to provide the correct signal. IC19(A) is loaded with a number proportional to the AM depth requested and IC19(B) has AM calibration data entered. IC28(B) will contain calibration data for the RF level and finally IC28(A) holds a number equal to the RF output voltage in mV (described in later paragraphs).

129. The AM depth is set by the ratio of modulation signal to DC level at IC28 input, pin 19. If the RF level is changed, the proportion of DC and modulation signal will stay constant and therefore so will the AM depth. AM depth of modulation up to 99.5% may be obtained for output levels up to +3.9 dBm but beyond this the combination of AM and power level will be restricted to ensure that peak powers of greater than +10 dBm are not requested.

130. If too great an AM depth is requested for a particular power level selected at that time, the power is reduced and a colon is flashed in the RF LEVEL display indicating the change and the new level selected.

131. The detector characteristic present on board AB1/2 is not an ideal one as can be seen in Fig. 4-16. It is therefore necessary to apply correction. At low RF levels (on AB1/2) the detected voltage rises with the square of the RF voltage. As the level increases above approximately 20 mV, however, the relationship becomes linear.

132. Consider Fig. 4-16. If we wish to obtain half the RF voltage VR_{FA} , simply halving the reference voltage (and, due to loop action the detected voltage also, $\frac{VA}{2}$), will result in too low an RF level, (VR_{FB}). For this reason the drive voltage must be greater at VB. IC27 and its associated circuit provides the necessary detector correction. The circuit is described in the following paragraph.

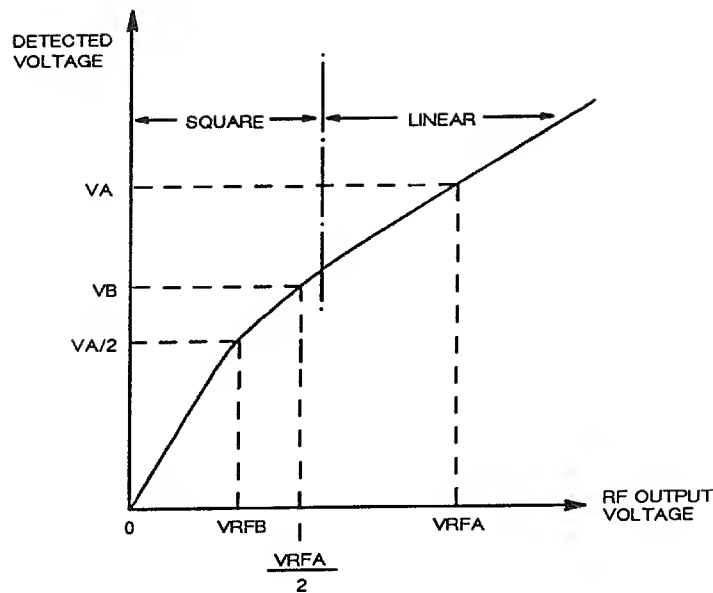


Fig. 4-16 RF detector law (A2/2)

133. **Detector correction circuit.** Two transistors in IC27 are used to pre-distort the signal that drives the envelope feedback system on the RF board, AB1/2. This only occurs at low voltage levels and the amount of shaping is determined by R90 (CORRECT DET) and the potential divider chain R91 to R93. A common drive signal appears on both transistor bases at pins 12 and 9 of IC27. The feedback signal comes from IC27 pin 13 via R85. R88 ensures that the left-hand transistor is never turned off but merely provides temperature tracking of the diode characteristic of the right-hand transistor. The latter actually introduces the square law characteristic. This modified AM drive waveform is finally fed to the RF processing board AB1/2 via PLM pin 3.

Amplitude modulation below 62.5 MHz

134. To obtain the correct depth of modulation on signals below 62.5 MHz two drive signals are required. The first driver provides a fixed modulation at PLM, pin 5 via IC21b. The second driver ensures that the RF level reference that is ultimately applied to AB1/2 comparator is increased by an amount equal to the detector voltage increase due to the AM. If this is not achieved there will be a shortfall in RF level.

135. Fig. 4-17 shows the signal path for the two AM drive signals. IC21b provides the drive for the fixed frequency modulator. The gain of this stage is such to allow the full 100% modulation. Depth is set by data entered into the digital-to-analogue converter IC19(A), and calibration data is entered via IC19(B). R111 prevents capacitive loading affecting IC21b.

136. The modulation signal is also fed via IC14c and IC16b through IC28 and uses the same signal path as signals above 62.5 MHz but in this case the square law transfer characteristic is no longer of any consequence.

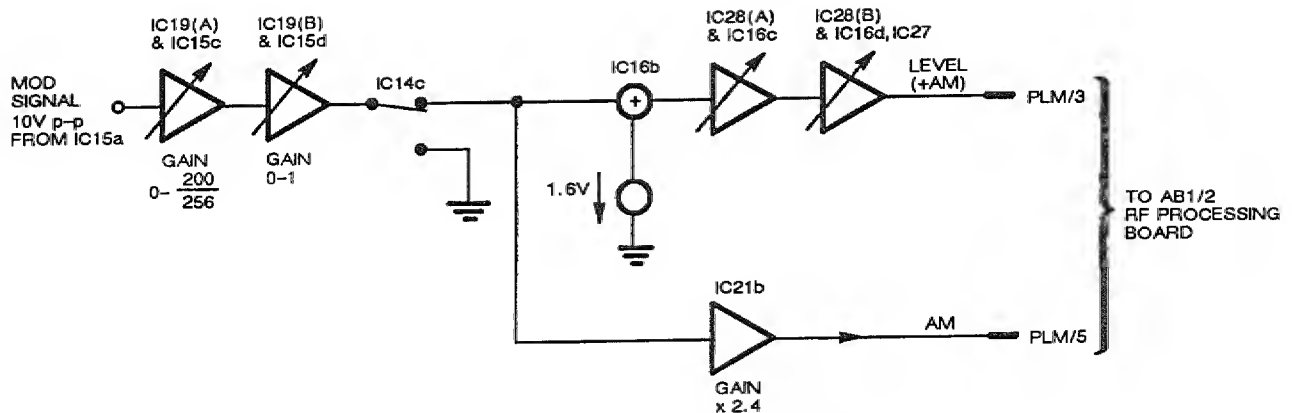


Fig. 4-17 AM signal path <62.5 MHz (A2/2)

Frequency modulation

137. In order to obtain the necessary low modulation frequency response on FM, two signal paths are used. One path drives the VCO tuning line whilst the other is used to modulate the phase of the reference signal used in the 250 – 500 MHz phase locked loop (PLL). If the second path was not included the action of the PLL would be such that where the modulation frequency is below that of the loop bandwidth (200 Hz), it would be removed from the RF signal.

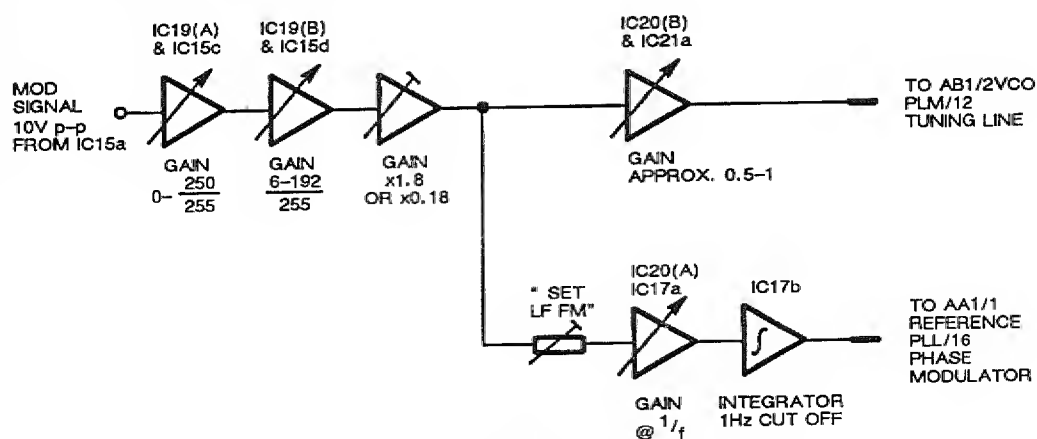


Fig. 4-18 Dual path FM drive (A2/2)

138. VCO tuning line drive. IC19 DAC changes the drive level according to the peak deviation requested. IC19(A) is loaded with a number proportional to that deviation whilst IC19(B) has a multiple of 6 which changes according to the carrier frequency selected and maximizes the resolution of IC19(A).

TABLE 4-1 DAC VALUES FOR VARIOUS FM DEVIATIONS (A2/2)

Deviation	Value in DAC
0 – 249	Deviation
250 – 499	Deviation ÷ 2
500 – 999	Deviation ÷ 5
1000 – 1999	Deviation ÷ 8
2000 – 3999	Deviation ÷ 16
4000 – 7999	Deviation ÷ 32

139. Table 4-1 shows how a resolution of 0.4% of full-scale deviation is achieved. IC16a has a gain set by R50/R51 or R52/R53 dependent on the value of deviation selected: For values less than 10 kHz it is x0.18 and for deviations between 10 – 100 kHz it is x1.8. MOS switch IC14 effects the change of gain via two output lines from IC11, Q4 and Q5. Control data on these lines are shown in Table 4-2. Virtual earth switching ensures that the resistance of the switch when on has negligible effect on the gain of the stage. D22,D23, ensure no distortion occurs when a channel is not in use. R31 and R32 provide the correct bias level for IC14 switches.

TABLE 4-2 DECODING OF FM/ Φ M FUNCTIONS (A2/2)

IC14 Q4 Q5		Function
0	0	FM 0 – 9.99 kHz
0	1	Φ M 0 – 9.99 rads
1	0	FM 10 – 99.9 kHz
1	1	Not used

140. IC20(B) is fed from IC16a and the non-inverting input on the associated IC21a, pin 3 is taken to ground on board AB1/2 via PLM, pin 2. This minimizes spurious modulation caused by induced voltages.

141. **Reference phase modulator, low FM path.** This second path drives a phase modulator on board AA1/1. To obtain an equivalent frequency modulation the modulation signal must be applied through an integrator. To consider why this is necessary, imagine the effect of a steady voltage being applied to the modulator. Without an integrator a steady phase error would be created. With the integrator however, an increasing phase error with respect to time will occur and this gives the required frequency shift.

142. To maintain the correct loop operation the modulation of both the VCO and the reference phase signal must be identical therefore producing no error signal at the output of AA1/1 main synthesizer phase detector. To this end IC20(A) is loaded with data that is proportional to the frequency at which the 250–520 MHz synthesizer is operating. As the synthesized frequency increases, the ratio of deviation to synthesizer frequency reduces and a smaller phase change at the phase detector will cancel it out. The reduction of gain in IC20(A), due to its configuration, will track this requirement.

143. The 'SET LF FM' potentiometer R58 and resistors R57, R59 ensure that the above described correction can be attained. Correct setting of R58 will ensure a substantially flat frequency response from less than 10 Hz to well above 25 kHz.

144. IC17b with its associated circuit forms an integrator with a low frequency roll off at approximately 1 Hz. DC feedback is maintained through R71, R72, R62 and R64 and the integrating action is given by R63 and C33. The low frequency cut-off is due to the input coupling capacitor C32 and feedback decoupling capacitor C40. The integrated signal is fed to AA1/1 via PLL pin 16. In order to optimize the response of low frequency square waves the overall amplitude response of IC17b circuit actually has a slight rise around 1 Hz before dropping off below this frequency at 12 dB/octave.

Phase modulation

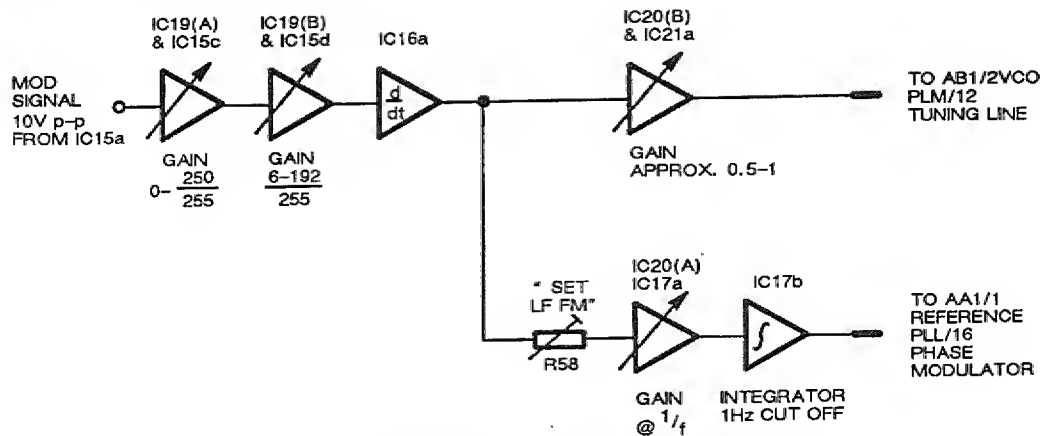


Fig. 4-19 Phase modulation signal path (A2/2)

145. Since this is 'angle' modulation, like FM, the signal path is similar to that described in the frequency modulation paragraphs previously. The only difference being that IC16a is converted from a gain stage to a differentiator providing a 6 dB/octave pre-emphasis. R55, R56 and C29 are set for the main time constant whilst R54 restricts the gain at high frequencies to reduce noise in that area. R56 'SET Φ M' allows calibration of the system.

RF level control

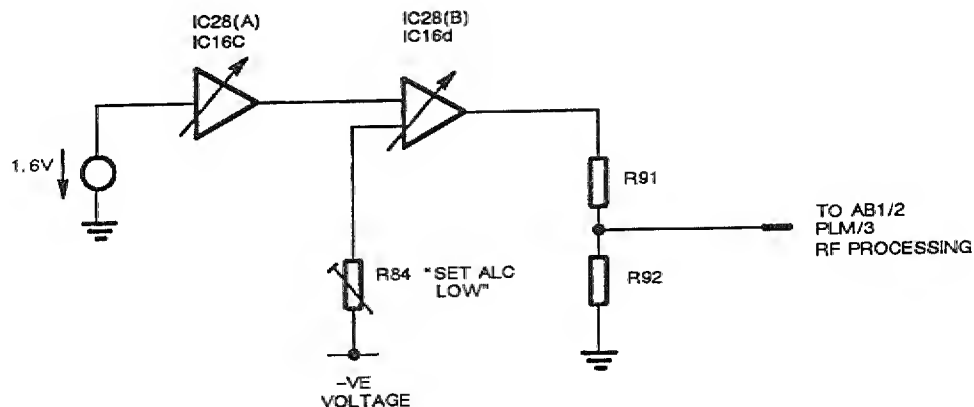


Fig. 4-20 Simplified RF level control signal path (A2/2)

146. This control circuit is used over the complete carrier frequency range. RF processing board AB1/2 requires a voltage that approximates to an offset plus a variable voltage that is dependent on the RF level requested. The square law consideration discussed in the AM modulation paragraphs is of little importance for simple level changes because the range is limited from -8 dBm to +10 dBm. The voltage at PLM pin 3 must correspond to approximately twice the actual peak RF level requested due to the 50 Ω source resistor on board AB1/2.

147. IC16b with R70 and R74 provide a constant voltage of -1.6 V. C52 decouples the reference line to ground. Data is entered into the digital-to-analogue converter, IC28 in one of two formats. For RF output levels below +2.9 dBm, a number proportional to the output voltage is sent to IC28(A) whilst a calibration value (which could be up to 255₁₀) is entered into IC28(B).

148. If the RF level requested is greater than +2.9 dBm, then the value in IC28(A) is reduced by a factor of $\sqrt{10}$ and the calibration value is increased by the same amount.

149. R84 'SET ALC LOW' and R88 allow the required offset to be introduced. This is effected at Pin 9 of IC27. The DC level is then transferred to AB1/2 via the base emitter junction of the right-hand transistor of IC27, potential divider R91, R92 and PLM pin 3.

RF filter tuning

150. Two tracking filters are used on board AB1/2. One is a notch used to reduce the second harmonic component of the oscillator output; the other is a band-pass filter used to reduce unwanted components on the doubler output. The latter has no means of adjustment and so calibration data is entered into A2/2 IC23(B) to ensure that the band-pass filter operates at the correct frequency. The notch filter is then adjusted to reject the second harmonic of the oscillator output with the oscillator set to its lowest operating frequency (250 MHz). The tuning law of the band-pass filter and notch are sufficiently alike to allow the same tracking data to be used in both cases.

151. IC23, pin 18 is coupled to the -12 V line, this is inverted and then multiplied by IC17d. TR13 ensures that the maximum tuning range is available, allowing PLM pin 15 to be taken to within 0.5 V of the +24 V rail. R80, R81 provide the correct bias for TR13 and R82 increases the gain of IC23(B) from x1 to approximately x2.

Reverse power protection switching and attenuator drive

152. IC22, IC18c and IC18d with their associated circuits control the operation of AC1 attenuator relays. Latch IC22 is fed with data dependent on the level of fixed attenuation required, details of which can be seen in Table 4-3.

TABLE 4-3 ATTENUATOR SWITCHING LOGIC (A2/2)

Attenuation	Q0	Q1	Q2	Q3	Q4
0 dB	1	1	1	1	1
10	1	1	1	0	1
20	1	0	1	1	1
30	0	1	1	1	1
40	0	1	1	0	1
50	0	0	1	1	1
60	0	1	1	1	0
70	0	1	1	0	0
80	0	0	1	1	0
90	0	1	0	1	0
100	0	1	0	0	0
110	0	0	0	1	0
120	0	0	0	0	0

153. When the required selection is made the respective Q output line(s) are grounded and the associated transistor (TR8-TR12) is turned on. Base current flows via the load resistors (R75-R78) and diodes D17-D21 protect the transistors from the large negative-going inductive spikes created when the relays are turned off. Relay current flows via PLN pins 2-7. Thus if a particular pad is required current is supplied to that pad's relay.

154. IC18c and IC18d are comparators monitoring the voltage levels present on the attenuator. If PLN pin 9 voltage should exceed +0.04 V (when a voltage overload is applied to the RF OUTPUT socket) IC18c will switch its output to a high level. D24 and D26 then conduct and turn off TR16. This in turn will cause the RPP relay AC1 RLF to drop out and at the same time initiate an interrupt, RPP TRIPPED L, to the micro-processor. This would be in the form of a logic 'low' level applied to IC13 pin 6 via R104.

155. Similarly, if a negative voltage overload is applied to the RF OUTPUT socket this will cause PLN, pin 10 voltage to fall below -0.04 V. IC18d output will be set 'high' and again TR16 will be turned off via D15, D26 and R101. R103 ensures that the energy stored in the RPP relay is dissipated in the least time possible.

156. **RPP reset.** If either IC18c or IC18d output goes 'high', R100 pulls the comparison level of IC18d above 0 V. Since AC1 negative detector D2 will be unable to reach this level IC18d would remain at logic 'high' output even after the overload is removed. It is therefore necessary to apply an external reset. When the RPP is tripped the keyboard is disabled with the exception of the RF LEVEL key. The REV PWR annunciator will flash on the RF LEVEL display to indicate the presence of an overload. No further keyboard operation can be made until the RPP is reset by pressing the RF LEVEL key.

157. On pressing the key IC22, Q5 output will be set from 'low' to the 'high' state, the positive edge is transferred via C38, to the junction of R96, R97. If the magnitude of the detected voltage is less than 40 mV IC18d output will change from 'high' to a 'low' state and TR16 will again be turned on. AC1, RLF energizes and normal operation is resumed. If the overload is still present IC18d output will remain 'high' and the RPP will not reset.

Jitter correction drive

158. In order to reduce phase jitter of the carrier frequency which is introduced by the fractional N technique, an offsetting phase error is required. A circuit on the Synthesizer board AA1/1 generates this but a reference voltage, inversely proportional to the synthesized frequency is required. IC23(A) and its associated circuit provide this function.

159. R66, R68 and R67, CORRECT JITTER, provide an adjustable reference that feeds digital-to-analogue converter IC23(A). IC17c and IC23A are configured to give a gain that is inversely proportional to the value of data entered into the digital-to-analogue converter. The eight most significant bits of the synthesizer frequency are entered into the digital-to-analogue converter and thus the output of IC17c pin 8 will be a voltage that goes down as synthesizer frequency goes up. It is sent to AA1/1 via PLL pin 1 as the JITTER CORRECTION REF.

DISPLAY AND KEYBOARD (A1/2)

Circuit diagram : Fig. 7-3

160. The keyboard facilitates instrument operation by interrupting the microprocessor (through a priority tree) which runs an interrogation of the keyboard matrix to locate the switch selection. The microprocessor then runs a new task appropriate to the key(s) pressed. Information giving the current state of the instrument is continually displayed and includes frequency, RF level and modulation.

161. Data is displayed on a combined two phase multiplexed liquid crystal display (LCD). Eight light-emitting diodes (LEDs) are also used to indicate the function currently selected. Three light-emitting diodes are dedicated to displaying the currently selected internal modulation frequency. Two specialized integrated circuits convert serially transmitted information into the waveforms required to drive the LCD. Drive information for the LEDs is provided by 8-bit latches.

Keyboard operation

162. Switches are arranged in a six-by-six matrix and are connected in rows to IC3 data latch. Initially the rows are set to a logic 'low' level. The columns of the matrix are connected to R9 pull-up resistors, which initially set all the columns to logic 'high' level. One of the resistors, R9(h) is a pull-up for D9-D14 six input gate. This gives an OR function using negative logic convention.

163. The columns drive both the six input gate and IC5 data latch. IC5 controls the data bus via SKK pins 5-8 and 13-16. When a key is pressed a connection will be made from the column that the key is in to the row that the key is in. This causes the column to be asserted 'low' because all of IC3 Q outputs are held logic 'low'. A connection from the diode gate is also made to the microprocessor via SKK pin 11. This line KEYBOARD INT L when asserted 'low' causes the microprocessor to commence running a new task. This will in turn assert all but one of IC3 Q outputs logic 'high'; each output in turn then reverts to logic 'low' commencing with Q0. As this occurs the columns are monitored by IC5.

164. If the 6-bit word being output by the matrix is not all '1's then the word is digitally rotated to find which column has a logic 'low' on it. The combination of row and column data thus obtained is used to address a look up table which gives the code of the key pressed.

LED display

165. The eight diodes D1-D8 provide 'state' information relating to the function switches. Diodes D15-17 provide information on modulation frequency selected. This allows unambiguous keyboard operation. IC4 is an eight-bit data latch that drives the LEDs through R10-R13 current limiting resistors. Only three resistors are required for the eight LEDs because only one diode of D4-D8 will be lit at any one time. Data is placed on the bus and then chip select CS4 is taken to logic 'high' momentarily. All IC4 outputs are continuously enabled and thus any of the inputs, D0-D7 which were 'high' when CS4 went 'high' will give a logic 'high' output on Q0-Q7. The nominal diode current taken by a diode when operating is approximately 15 mA. Diodes D15-17 are controlled via IC3 and decoded by IC6. The coding is as follows:

IC3		D15	D16	D17
D6	D7			
0	0	OFF	OFF	OFF
0	1	ON	OFF	OFF
1	0	OFF	ON	OFF
1	1	OFF	OFF	ON

LCD display

166. IC1 and IC2 are the LCD controllers which accept complex strings of serial information on pin 9 via the Serial Input (SI) line. They are able to store this and use it to control which of the 128 display segments are turned on. Chip select lines CS1 and CS2 determine which IC is to receive data and the Command/Data (C/D) line determines the way that the data is processed.

167. Serial Clock Low (SCK L) line is clocked from A2/2 board via SKK pin 2. The positive-going edge of SCK L cues the selected IC so that the serial input, S1 line can be read. The display has two phases of backplane drive to enable two segments to be connected with a single drive point. This halves the number of drive points required.

168. R8 sets the internal clock frequency for both IC1 and IC2 and is divided by 211 which actually results in a backplane frequency of approx. 40 Hz for display driving. The common connection between pin 2 of IC1 and IC2 ensures that both are synchronized. Reset lines are coupled together and then connected via SKK, pin 18 to a latch on A2/2 board. At switch on and at any time the +5 V rail falls below a preset value the reset line will be asserted logic 'low' and all data will be cleared from IC1 and IC2. It is necessary to hold this line 'low' until the correct supply voltage is available to ensure synchronization of the display backplane drives.

169. The display drive waveform is switched between three voltage levels provided by TR1 and R1-R7. These are nominally (i) VLCD₃ (+0.9 V) (ii) VDD (+5 V) (iii) VLCD₁ (+3 V), midway between VDD and VLCD₃. The voltage on TR1 collector varies with temperature to match changes that occur in the LCD fluid.

Two phase multiplexing

170. Liquid crystal displays are passive unlike LED active displays, which convert energy into light. In the 2022E, multiplexed LCDs use a feature of the fluid in the device to provide the display required. Changes in the polarization of light passing through it do not occur until a certain RMS voltage is reached. Once this level has been exceeded the segments to which the signal is being applied appear dark.

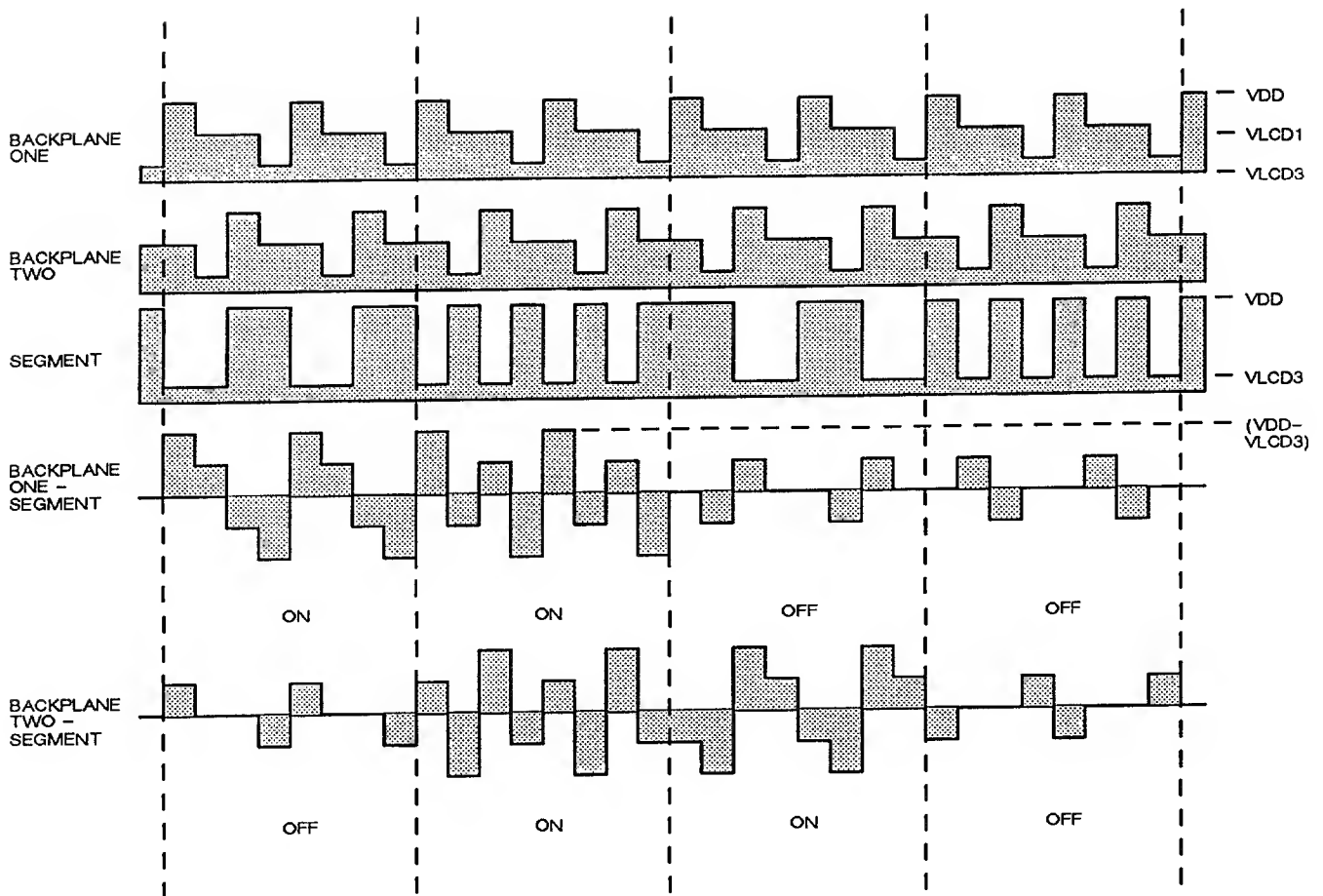


Fig. 4-21 Typical waveforms, LCD drive waveforms (A1/2)

171. Fig. 4-21 shows typical waveforms generated at IC1 and IC2. There is a $\sqrt{5}:1$ difference in the RMS voltage between segment and backplane plates depending on whether the segment is on or off. The backplanes remain as shown with a 180° phase difference whilst the segment drive takes up one of four possible forms to produce the four states required.

10 dB STEP OUTPUT ATTENUATOR (AC0/A2/2)

Circuit diagram : Figs. 7-5 & 7-9

172. Instructions to operate the attenuator pads are initiated by means of the keyboard and are then processed by the microprocessor via data lines D0-D4. A2/2 board IC22 receives a logic 'low' instruction to cause one (or more) of five control transistors TR8-TR12 to turn on. This in turn completes the current path for one or more selected relays on board AC1 via PLN pins 2-7. Relays RLA-RLE are normally de-energized until the current path for the attenuator pad(s) relay is completed. When this occurs current flows through the respective attenuator pad(s) relay and the contacts then make to bring the pad(s) into circuit.

173. Diodes D17-D21 on A2/2 board act as clamps to protect the open collector drivers TR8-TR12 from inductive spikes. When a relay is de-energized the stored magnetic field causes a large negative-going voltage spike on the control line which is clamped by the diodes. Adjustment to the attenuator pads are made by means of screws in the lid. Frequency response is optimized by the adjustment of small flags which are moved by these screws. Each pad is set up separately and requires the use of specialist measuring facilities. It is therefore recommended that this is carried out by the nearest Marconi Instruments Agent or Service Division.

174. Each attenuator pad consists of 3 precision resistors that provide attenuation of 10 dB, 20 dB or 30 dB. Logic selection for each of the 10 dB steps from 0 to 120 dB is shown in Table 4-4.

TABLE 4-4 ATTENUATOR LOGIC (AC0 and A2/2)

dB		0	10	20	30	40	50	60	70	80	90	100	110	120
Pads in circuit	A 30 dB				X	X	X	X	X	X	X	X	X	X
	B 20 dB			X			X			X			X	X
	C 30 dB										X	X	X	X
	D 10 dB			X			X			X			X	X
	E 30 dB							X	X	X	X	X	X	X

X = Relay energized

Reverse Power Protection (AC0 and A2/2)

175. Resistors R16 and R17 form a high impedance RF signal divider at the output of the attenuator which is used to sense the RF present at the output of the attenuator. Diodes D1 and D2 peak detect the signal level onto C14 and C16. The resulting DC is connected for use in the RPP system. If the signal level exceeds a preset limit relay RLF de-energizes and sets the contacts to open circuit the output to SKAF, thus protecting the attenuator from excessive power dissipation.

176. Decoupling capacitors C1-C12 and inductors L1-L8 reduce coupling of RF voltages present inside the attenuator onto drive lines outside the box.

GPIB ADAPTER MODULE (AD0)

Circuit diagram : Fig. 7-10

177. This optional module, when fitted to the rear panel, allows direct connection to a GPIB controller and provides full talker/listener facilities to IEEE 488 specifications.

178. GPIB talker/listener integrated circuit IC2, is connected to A2/2 board via SKP providing both talker and listener capabilities, details of these are given in Chapter 3 of the Operating Manual. IC2 contains the gating registers and control circuit needed to interface between the GPIB and the instrument's 8-bit bus. Fig. 4-22 shows the basic structure of the device. In its most elementary form data is entered into one of the internal registers and then transferred to the GPIB or instrument bus depending on whether a talk or listen mode is chosen. Further information on the general features and applications of the GPIB system can be obtained from the separate GPIB manual (see Vol. 1, Optional accessories).

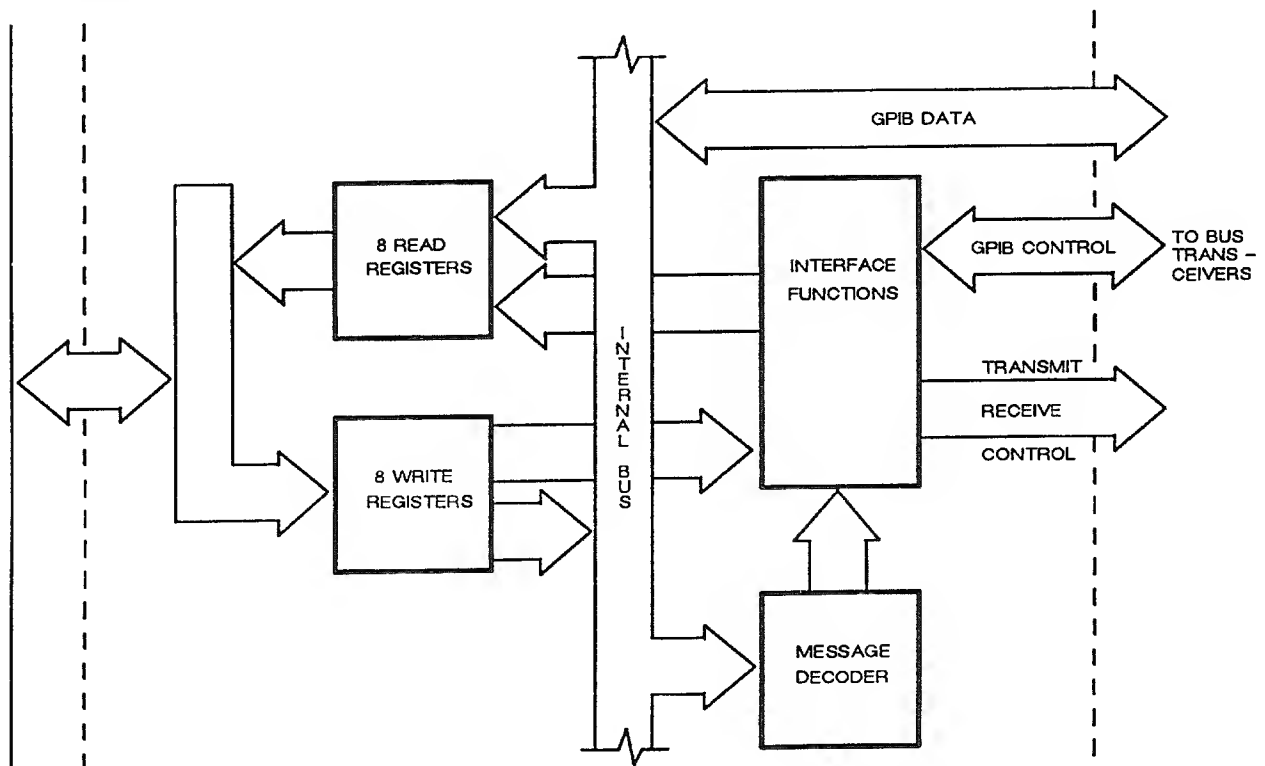


Fig. 4-22 Internal structure of GPIB talker/listener integrated circuit, IC2 (AD0)

179. IC1, R1 and C8 operate as an independent clock whose frequency (between 1 and 2 MHz) is used to generate a delay of approximately 2 μ s allowing the bus to settle after sending data. IC1a is a Schmitt triggered input inverter with R1 and C8 providing positive feedback to complete the oscillatory circuit. IC1b buffers the clock signal, which is fed directly to IC2, GPIB chip.

180. Sixteen lines are buffered by IC3-IC6, these act as transceivers and are used to translate the negative true logic and act as drivers. Data lines, DAV, NDAC, NRFD and EOI lines have bi-directional buffers. The remaining lines with the exception of the SRQ line are receivers. IC1e,f provides the logic 'low' level for the receive instruction T/R to IC4 pins 7 and 9; or the talker 'high' level for IC4, IC5 and IC6 and also provides additional buffering for the three ICs in line. IC2 pin 2 controls the mode of the EOI line.

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SECOND FUNCTION OPERATIONS

181. Second function operations provide the means of controlling various secondary features and calibrations within the instrument. There are three levels of operation, two of which require unlocking in order to gain access. Each level of operation and method of access is described below.

182. Normal operation

Second functions	'0'	Unlock
	'1'	Status information
	'2'	GPIB address setting
	'3'	Manual latch setting
	'4'	SRQ mask setting
	'5'	Read identity string
	'6'	Front panel 'Test display'
	'7'	Reserved for future use
	'8'	Reserved for future use
	'9'	Read elapsed time since last reset

These functions are unprotected and may be accessed directly:- Press 2ND FUNCT followed by the numeral required.

183. First level operation

Second functions	'10'	Record external freq. std. choice
	'11'	Read identity string
	'12'	Write user-definable string (GPIB only)
	'13'	Read user-definable string (GPIB only)
	'14'	Set RF level units setting
	'15'	Set RF level offsets
	'16'	Recall STORE 10 at switch-on
	'17'	Reserved for future use
	'18'	Reserved for future use

These functions have first degree protection and are accessed by the following procedure:- Press 2ND FUNCT 0, then the L (decrement) and MOD ALC keys simultaneously, holding both these down until a '1' appears in the Frequency display. Follow this by again pressing 2ND FUNCT, and the numerals required.

184. Second level operation

Second functions	'190'	Set identity string
	'191'	FM tracking calibration
	'192'	RF level calibration
	'193'	Voltage tuned filter (VTF) calibration
	'194'	AM calibration
	'195'	Calibration and storage of amended EAROM checksum
	'196'	Protection of store settings
	'197'	Display blanking of recalled stores
	'198'	Read total instrument operating time
	'1990'	Reset of second function 9 elapsed time.
	'1991'	Reset non-volatile stores.

These functions have second degree protection and are accessed by the following procedure:- 2ND FUNC 0, then in the following order ↓ (decrement), MOD ALC, 4 and kHz keys, holding down all four until a '2' appears in the Frequency display. Follow this by again pressing 2ND FUNCT and the numerals required.

SECOND FUNCTION OPERATIONS (see SECURITY NOTICE on page ii)

181. Second function operations provide the means of controlling various secondary features and calibrations within the instrument. There are three levels of operation, two of which require unlocking in order to gain access. Each level of operation and method of access is described below.

182. Normal operation

Second functions	'0'	Unlock
	'1'	Status information
	'2'	GPIB address setting
	'3'	Manual latch setting
	'4'	SRQ mask setting
	'5'	Read identity string
	'6'	Front panel 'Test display'
	'7'	Reserved for future use
	'8'	Reserved for future use
	'9'	Read elapsed time since last reset

These functions are unprotected and may be accessed directly:- Press 2ND FUNCT followed by the numeral required.

183. First level operation

Second functions	'10'	Record external freq. std. choice
	'11'	Read identity string
	'12'	Write user-definable string (GPIB only)
	'13'	Read user-definable string (GPIB only)
	'14'	Set RF level units setting
	'15'	Set RF level offsets
	'16'	Recall STORE 10 at switch-on
	'17'	Reserved for future use
	'18'	Reserved for future use

These functions have first degree protection and are accessed by the following procedure:- Press 2ND FUNCT 0, then the L (decrement) and MOD ALC keys simultaneously, holding both these down until a '1' appears in the Frequency display. Follow this by again pressing 2ND FUNCT, and the numerals required.

184. Second level operation

Second functions	'190'	Set identity string
	'191'	FM tracking calibration
	'192'	RF level calibration
	'193'	Voltage tuned filter (VTF) calibration
	'194'	AM calibration
	'195'	Calibration and storage of amended EAROM checksum
	'196'	Protection of store settings
	'197'	Display blanking of recalled stores
	'198'	Read total instrument operating time
	'1990'	Reset of second function 9 elapsed time.
	'1991'	Reset non-volatile stores

These functions have second degree protection and access to Second level operation is restricted to authorized calibration units only. Interference with these second functions could invalidate the instrument's calibration.



185. Second function '3' Manual latch setting. Second functions that are used in normal operation of the instrument are described in the Operating Manual Vol. 1. Second function 3 Manual latch setting, however, is used only in maintenance applications and is therefore described here. This facility allows the operator to direct a 6 or 8 bit binary instruction to any of the instrument's internal latches or registers for testing and fault finding. The latch is accessed by first selecting 2ND FUNCT 3 mode then keying in the address number, 00 to 35. Latch address numbers are identified in both Chap. 7, Servicing diagrams and Chap. 5, Maintenance.

186. Selection of second function 3 results in the following display:-

--	
	3

The instrument now awaits entry of the latch number which will be displayed in the carrier frequency window until selection is completed. When this occurs the display will change to one of two formats depending on whether a 6-bit or an 8-bit latch has been addressed.

187. 6-bit latches. When the address latch number has been entered the display will change and the current value of data normally applied to the latch is presented in *binary* notation as shown in the example below:-

X X X X X X	
Y Y	3

Where XXXXXX = binary data
 YY = latch number
 3 = second function selection

188. Data can now be entered in binary (6 digits 000000 to 111111), with data being shifted in, most significant bit first. When data is satisfactorily set press the STORE key to terminate the entry; the decimal points will flash briefly to indicate that the data has been sent.

189. 8-bit latches. Selection of an 8-bit latch or register will result in an identical initial display as that shown for a 6-bit latch selection. However, when address selection is complete data is displayed not in binary but decimal notation in the following manner:-

Z Z Z - - -	
Y Y	3

Where ZZZ = present decimal data
 --- = new data entry point
 YY = latch number
 3 = second function selection

185. Second function '3' Manual latch setting. Second functions that are used in normal operation of the instrument are described in the Operating Manual Vol. 1. Second function 3 Manual latch setting, however, is used only in maintenance applications and is therefore described here. This facility allows the operator to direct a 6 or 8 bit binary instruction to any of the instrument's internal latches or registers for testing and fault finding. The latch is accessed by first selecting 2ND FUNCT 3 mode then keying in the address number, 00 to 35. Latch address numbers are identified in both Chap. 7, Servicing diagrams and Chap. 5, Maintenance.

186. Selection of second function 3 results in the following display:-

--	
	3

The instrument now awaits entry of the latch number which will be displayed in the carrier frequency window until selection is completed. When this occurs the display will change to one of two formats depending on whether a 6-bit or an 8-bit latch has been addressed.

187. **6-bit latches.** When the address latch number has been entered the display will change and the current value of data normally applied to the latch is presented in *binary* notation as shown in the example below:-

X X X X X X	
Y Y	3

Where XXXXXX = binary data
 YY = latch number
 3 = second function selection

188. Data can now be entered in binary (6 digits 000000 to 111111), with data being shifted in, most significant bit first. When data is satisfactorily set press the STORE key to terminate the entry; the decimal points will flash briefly to indicate that the data has been sent.

189. **8-bit latches.** Selection of an 8-bit latch or register will result in an identical initial display as that shown for a 6-bit latch selection. However, when address selection is complete data is displayed not in binary but decimal notation in the following manner:-

Z Z Z - - -	
Y Y	3

Where ZZZ = present decimal data
 --- = new data entry point
 YY = latch number
 3 = second function selection

Decimal data entered will shift in most significant digit first. On completion press STORE key, when the data on the right of the display will be sent to the latch. This is indicated by the instrument copying the new entered data into the left side of the frequency window and replacing the right side with " --- ", ready for a further entry.

190. Any new data sent to a 6-bit or 8-bit latch will remain valid until the manual latch addressing mode is terminated by pressing one of the mainfunction keys. At this time the latch data will be restored to its normal status.

191. **Second function '190' Set identity string.** This facility is second degree protected and is only normally required to initialize the instrument. The identity string shows the instrument type number and serial number. This information can be read via the GPIB. A typical display is described in the Operating Manual Vol. 1, Second function 5, Read identity string. Instrument type number and software issue number is shown first e.g. 52022-930, then the software issue number e.g. 004. This cannot be changed via the keyboard as it is built into the software. Pressing the '.' decimal point key then allows the second half of the string containing the serial number of the instrument to be entered.

192. Entering digits first clears the display and then rotates the numbers in from the right-hand side of the frequency display. When setting the first half of the string the most significant digit will be entered but will rotate off the end of the display. Press STORE to terminate this entry. Press '.' (decimal point) to display the second part of the string and key in the nine digits required to enter the serial number, in this event the two most significant digits will not be displayed. Again press the STORE key to terminate the entry. In each case pressing the STORE key will show the new data in the normal display format.

193. **Second function '191' FM tracking calibration.** The FM tracking calibration data consists of two tables of calibration points. The first, which covers the frequency range 250.0000 MHz to 352.9999 MHz, has 25 calibration points spaced 4.12 MHz apart, with the exception of point 24 which is 100 Hz less than 4.12 MHz (4.1199 MHz) to avoid overlapping with the higher table. The second table covers frequencies from 353.0000 MHz to 499.9999 MHz and also has 25 points, each 5.88 MHz apart except for the 25th point. This is again 100 Hz less (5.8799 MHz), to avoid overlapping with point 24. Details of the calibration procedure are given in Chap. 5 Maintenance.

194. **Second function '192' RF level calibration.** The output level is calibrated at 11 selected reference points, each point is numbered from 00 to 10 with the selected point displayed in the modulation window. Point 00 is at 15 MHz and points 01 to 10 are spaced at intervals of 100 MHz, starting at 100 MHz and finishing at 1010 MHz. Existing calibration data is shown on the left side of the frequency window in decimal form, new data when it is entered is displayed on the right. Pressing the STORE key transfers the new data to the non-volatile (EAROM) memory.

195. **Second function '193' Voltage tuned filters (VTF) calibration.** The voltage tuned filter (VTF or Output harmonic control) calibration table consists of 6 points running from 500 MHz to 1010 MHz in 100 MHz steps. Display and calibration procedures are identical to those described in the FM tracking and RF level calibration paragraphs.

196. **Second function '194' AM calibration.** Only two calibration points exist for AM. Point 00 is calibrated at 15 MHz and point 01 is calibrated at 100 MHz. Calibration is as described in previous paragraphs with the user entering decimal data on the right side of the frequency window then pressing the STORE key to save the new data in the EAROM.

197. **Second function '195' Calculation and storage of amended EAROM checksum.** A check on the serviceability of both PROM and RAM is carried out before the instrument's initial operating mode is displayed and a checksum is initiated on the EAROM stored data. If either PROM or RAM checks are in error the instrument will be unable to take up the initial operating mode and instead will display an error message, either 06 or 08, depending on the fault. Error messages are described in the Operating Manual Vol. 1. If a new non-volatile EAROM has been fitted or if new RF level calibration or FM tracking data has been entered (as a result of recalibration) the checksum will not agree and Error number 07 will be displayed in the carrier frequency window until a key is pressed. To recalculate the EAROM checksum enter 2ND FUNC 195 (which will display the current checksum) and press the STORE key. The instrument will re-calculate the checksum, store it in EAROM and display 000 to indicate the completion of the task.

198. **Second function '196' Protection of store settings.** This facility disables the operation of the STORE key in the normal mode of operation in order to provide protection against inadvertent alteration. On selecting second function 196 the frequency window gives a display of either '0', '1', '2' or '3'. These numbers indicate the following:-

- 0 = stores unlocked, offsets unlocked
- 1 = stores locked, offsets unlocked
- 2 = stores unlocked, offsets locked
- 3 = stores locked, offsets locked

Attempts to overwrite the store contents when protected will result in Error message 18 being displayed in the carrier frequency window.

199. **Second function '197' Display blanking of recalled stores.** This facility enables restrictions to be exercised on the display of data set in stores should this be of a classified nature. Front panel display information is blanked when any store (other than 00) is recalled. All information concerning the existing status, with the exception of error messages and total shift data is prevented from reaching the display. Select '1' followed by the STORE key to enable the facility. To disable the facility and return the instrument to the normal display mode press '0' and STORE keys. Recall of store 00 will always give a valid display of that stores contents regardless of the state of second function '197' and will also return the instrument to the normal display mode.

200. **Second function '198' Read total instrument operating time.** This *read only* facility gives the total number of operating hours since instrument manufacture. Selection of this second function will display the record of elapsed time (in hours), in the carrier frequency window with a resolution of 0.5 hrs. When first receiving the instrument a display of time will be evident, reflecting the time spent during manufacture.

Note ...

There is no facility for resetting the total instrument operating time.

201. **Second function '1990' Reset second function 9 elapsed time.** This elapsed time facility can be reset to zero by means of this second function control. When wishing to reset, first select second function '1990' then press the 'STORE' key.

202. **Second function '1991' Reset non-volatile stores.** This function permits all of the instrument's 100 stores to be reset to their default settings. To operate, select second function '1991' then press the 'STORE' key. Note that it will take the instrument about 40 seconds to do this.

Chapter 5-0

MAINTENANCE

CONTENTS

Para.

- 1 Introduction
- 3 Safety precautions
- 4 Handling precautions
- 7 Recommended test equipment
- 8 Access and removal of boards
- 9 AA1/1 and AA2/1 boards
- 11 AB1/2 board and removal of AB0 unit
- 13 A2/2 board
- 16 A1/2 keyboard
- 17 Rear panel mounting of RF OUTPUT socket

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5-1	Recommended test equipment	2
5-2	Decibel conversion table	4

Fig.

5-1	Access and layout	7
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INTRODUCTION

1. This chapter provides servicing support information for the three chapters which follow :

- 5-1 : PERFORMANCE TESTING – procedures for verifying that the equipment complies with the Performance Data in Chap. 1.
- 5-2 : ADJUSTMENT AND CALIBRATION – tests and adjustments for restoring the equipment to peak performance.
- 5-3 : FAULT DIAGNOSIS – procedures for localizing faults, first to sub-assembly level (normally a printed circuit board), and then to component level.

2. In case of difficulties which cannot be resolved with the aid of this manual, please contact our Service Division at the address at the rear of the manual or your nearest Marconi Instruments representative. Always quote the type number and serial number found on the instrument data plate.

SAFETY PRECAUTIONS

3. Although this equipment has been designed and constructed in accordance with international safety standards, it is important that the advice given under **SERVICING PRECAUTIONS** at the front of this manual should be observed in all maintenance procedures to ensure safe working practices.

HANDLING PRECAUTIONS

4. **Integrated circuits and semiconductor devices** are used throughout this instrument and, although these have inherent long term reliability and mechanical ruggedness, they are susceptible to damage by overloading, reverse polarity and excessive heat or radiation and the use of insulation testers.

5. **Static sensitive components.** The CMOS integrated circuits used in this instrument have extremely high input resistance and can be damaged by accumulation of static charges (see page iii - **SERVICING PRECAUTIONS**). Boards that have such integrated circuits all carry warning notices against damage by static discharge. Care must also be taken when using freezer sprays to aid fault finding. These can create a static charge likely to change the programmed memory of (E)PROMS.

6. **Bulkhead connectors and gaskets.** Special care should be taken to ensure that no RF leakage occurs. To this end all bulkhead connectors and lid sealing gaskets should be secure. It is essential that the unit lids be correctly relocated in their slotted recesses after removal. When disconnecting an RF connection between units ensure that the metal clad connectors do not accidentally cause short circuits on adjacent PCBs. Whenever possible ribbon cable connectors are polarized but care should still be taken to ensure that these are not misplaced. The printed board legends also have a cross hatching printed to indicate the direction by which any given ribbon cable should leave that board.

RECOMMENDED TEST EQUIPMENT

7. The test equipment recommended for use in Chaps. 5-1, 5-2 and 5-3 is shown in Table 5-1. Alternative equipment may be used provided it complies with the stated measurement requirements.

TABLE 5-1 RECOMMENDED TEST EQUIPMENT

Item	Description	Measurement requirements	Recommended model*
a	Modulation meter with distortion measuring facility	Range Φ M: 0.01 to 9.99 radians FM: 10 Hz to 99.9 kHz AM: 0 to 99.5% Accuracy FM & Φ M: $\pm 5\%$ of deviation at 1 kHz AM: $\pm 4\%$ of depth setting +1% Distortion AM, FM & Φ M: <5% total harmonic distortion	2305 & Distortion options kit (or TF 2331A)
b	Frequency counter	Freq. range: 10 kHz to 1 GHz Accuracy: Better than ± 2 in 10^7 over the temperature range 0 to 40°C	2435

* Marconi Instruments type unless otherwise indicated

TABLE 5-1 RECOMMENDED TEST EQUIPMENT (continued)

Item	Description	Measurement requirements	Recommended model
c	Standard frequency source (1,5 or 10 MHz)	Output level: >1 V RMS	Rubidium or Caesium reference unit
d	RF Power Meter with Power Sensor	Output level: -127 dBm to +6 dBm Level accuracy: ± 1 dB from 10 kHz to 1 GHz	6960 & 6912
e	AC Voltmeter	Output level: 1 V $\pm 10\%$ EMF	2610
f	AF Signal Source	Frequency range: 50 Hz - 25 kHz Output level: 0.90-1.10 V	Any suitable model
g	RF Millivoltmeter	VSWR: <1.5:1 Freq. range: 10 kHz-350 MHz	TF 2603
h	T Connector	VSWR: <1.5:1 Freq. range: 10 kHz-350 MHz	TM 7984
i	N type 50 Ω load	VSWR: <1.5:1 Freq. range: 10 kHz-350 MHz	TM 7967
j	Short circuit monitor	VSWR: <1.5:1 Freq. range: 350-1000 MHz	
k	20 cm Air spaced line	VSWR: <1.5:1 Freq. range: 350-1000 MHz	GR 874-L20
l	20 cm Adjustable line	VSWR: <1.5:1 Freq. range: 350-1000 MHz	GR 874-LK20L
m	DC microvoltmeter	Voltage range : >3 μ V FSD	LEVELL Type TM8
n	Spectrum analyzer	Freq. range: 15 MHz-1.5 GHz	
o	Variable DC power supply	Voltage: ± 5 V	TF 2158
p	Distortion factor meter	Distortion AM,FM & Φ M: <5% total Distortion MOD OSC: <1% total	TF 2331A
q	Signal generator (low noise)	Frequency range: 10 kHz-1024 MHz RF level: >0 dBm Residual FM: typically less than 1 Hz up to 512 MHz, 2 Hz up to 1024 MHz	TF 2017
r	RF Mixer	1-1000 MHz	Mini-circuits ZFM-2
s	Low-pass filter	2 MHz LPF	---

TABLE 5-2 DECIBEL CONVERSION TABLE

Ratio down		Decibels	Ratio up	
Voltage	Power		Voltage	Power
1.0	1.0	0	1.0	1.0
.9886	.9772	.1	1.012	1.023
.9772	.9550	.2	1.023	1.047
.9661	.9333	.3	1.035	1.072
.9550	.9120	.4	1.047	1.096
.9441	.8913	.5	1.059	1.122
.9333	.8710	.6	1.072	1.148
.9226	.8511	.7	1.084	1.175
.9120	.8318	.8	1.096	1.202
.9016	.8128	.9	1.109	1.230
.8913	.7943	1.0	1.122	1.259
.8710	.7586	1.2	1.148	1.318
.8511	.7244	1.4	1.175	1.380
.8318	.6918	1.6	1.202	1.445
.8128	.6607	1.8	1.230	1.514
.7943	.6310	2.0	1.259	1.585
.7762	.6026	2.2	1.288	1.660
.7586	.5754	2.4	1.318	1.738
.7413	.5495	2.6	1.349	1.820
.7244	.5248	2.8	1.380	1.905
.7079	.5012	3.0	1.413	1.995
.6683	.4467	3.5	1.496	2.239
.6310	.3981	4.0	1.585	2.512
.5957	.3548	4.5	1.679	2.818
.5623	.3162	5.0	1.778	3.162
.5309	.2818	5.5	1.884	3.548
.5012	.2512	6	1.995	3.981
.4467	.1995	7	2.239	5.012
.3981	.1585	8	2.512	6.310
.3548	.1259	9	2.818	7.943
.3162	.1000	10	3.162	10.000
.2818	.07943	11	3.548	12.59
.2512	.06310	12	3.981	15.85
.2239	.05012	13	4.467	19.95
.1995	.03981	14	5.012	25.12
.1778	.03162	15	5.623	31.62

TABLE 5-2 DECIBEL CONVERSION TABLE (continued)

Ratio down		Decibels	Ratio up	
Voltage	Power		Voltage	Power
.1585	.02512	16	6.310	39.81
.1413	.01995	17	7.079	50.12
.1259	.01585	18	7.943	63.10
.1122	.01259	19	8.913	79.43
.1000	.01000	20	10.000	100.00
.07943	6.310×10^{-3}	22	12.59	158.5
.06310	3.981×10^{-3}	24	15.85	251.2
.05012	2.512×10^{-3}	26	19.95	398.1
.03981	1.585×10^{-3}	28	25.12	631.0
.03162	1.000×10^{-3}	30	31.62	1000
.02512	6.310×10^{-4}	32	39.81	1.585×10^3
.01995	3.981×10^{-4}	34	50.12	2.512×10^3
.01585	2.512×10^{-4}	36	63.10	3.981×10^3
.01259	1.585×10^{-4}	38	79.43	6.310×10^3
.01000	1.000×10^{-4}	40	100.00	1.000×10^4
7.943×10^{-3}	6.310×10^{-5}	42	125.9	1.585×10^4
6.310×10^{-3}	3.981×10^{-5}	44	158.5	2.512×10^4
5.012×10^{-3}	2.512×10^{-5}	46	199.5	3.981×10^4
3.981×10^{-3}	1.585×10^{-5}	48	251.2	6.310×10^4
3.162×10^{-3}	1.000×10^{-5}	50	316.2	1.000×10^5
2.512×10^{-3}	6.310×10^{-6}	52	398.1	1.585×10^5
1.995×10^{-3}	3.981×10^{-6}	54	501.2	2.512×10^5
1.585×10^{-3}	2.512×10^{-6}	56	631.0	3.981×10^5
1.259×10^{-3}	1.585×10^{-6}	58	794.3	6.310×10^5
1.000×10^{-3}	1.000×10^{-6}	60	1000	1.000×10^6
5.623×10^{-4}	3.162×10^{-7}	65	1.778×10^3	3.162×10^4
3.162×10^{-4}	1.000×10^{-7}	70	3.162×10^3	1.000×10^7
1.778×10^{-4}	3.162×10^{-8}	75	5.623×10^3	3.162×10^7
1.000×10^{-4}	1.000×10^{-8}	80	1.000×10^4	1.000×10^8
5.623×10^{-5}	3.162×10^{-9}	85	1.778×10^4	3.162×10^8
3.162×10^{-5}	1.000×10^{-9}	90	3.162×10^4	1.000×10^9
1.000×10^{-5}	1.000×10^{-10}	100	1.000×10^5	1.000×10^{10}
3.162×10^{-6}	1.000×10^{-11}	110	3.162×10^5	1.000×10^{11}
1.000×10^{-6}	1.000×10^{-12}	120	1.000×10^6	1.000×10^{12}
3.162×10^{-7}	1.000×10^{-13}	130	3.162×10^6	1.000×10^{13}
1.000×10^{-7}	1.000×10^{-14}	140	1.000×10^7	1.000×10^{14}

ACCESS AND REMOVAL OF BOARDS

8. Access to the interior of the instrument can be gained by first removing the rear casting which is retained by two centre fixing cross headed screws. Both top and bottom outer covers can then be removed.

Access to AA1/1 and AA2/1 boards

9. Remove eight of the screws that secure AA0 cover plate. There are five screws on either side of the unit but the two centrally mounted ones should not be removed because they secure AA0 unit to the side-frames (see Fig. 5-1a for details). AA0 cover plate can now be raised to access board AA2/1 which is attached to the underside of AA0 cover plate. Board AA1/1 is situated inside AA0 unit.

10. If it is required to remove AA2/1 then connectors PLAA, PLAB and PLAC should be detached from the board. Alternatively the cover plate can be rotated through 180° and secured with two screws into the servicing position as shown in Fig. 5-1a.

Access to AB1/2 board and removal of AB0 unit

11. Place the instrument upside down and remove the eight outermost fixing screws (shown in Fig. 5-1a). Remove the cover plate which will give access to board AB1/2.

12. The two remaining centrally mounted fixing screws secure AB0 unit to the side frames. To remove AB0, unscrew the two remaining centrally mounted fixing screws and conhex connectors SKW and SKZ. Raise AB0 unit at the rear of the instrument, pivoting about the front edge until it is possible to remove sockets SKN and SKM from A2/2 board. Finally remove the RF output connector, PLAF, from the attenuator and withdraw AB0 unit. When replacing AB0 unit, ensure that the GPIB module AD0 is correctly located between the two guides on the underside of AB0. If difficulty is experienced, remove AD0 (see para. 14) before attempting to replace AB0.

Access and removal of A2/2, Power supply and Control board

13. Access to this board is achieved by removing AB0 unit as described in the previous paragraph. To remove A2/2 PCB, disconnect the sockets from the following plugs, PLF, PLH, PLAG, PLJ, PLL and PLK, then disconnect SKP from the GPIB module AD0. The board can then be released from the instrument after removing the nine fixing screws.

14. Before access can be gained to the components on the rear panel, GPIB module AD0 (if fitted) must be withdrawn from the instrument. Remove the two cross-headed screws securing the module to the rear panel. Carefully slide out the board assembly from the instrument as shown in Fig. 5-1b. Also withdraw the inter-connecting lead and disconnect SKP socket from the GPIB module.

15. Remove the two upper screws that secure the rear panel to the side frame and loosen only the two lower securing screws as shown in Fig. 5-1d. The rear panel can now be partially hinged to allow access to SKR, STD FREQ IN socket. Detach this and the rear panel is then free to angle down.

Note ...

When replacing GPIB module AD0, attach the interconnecting lead and socket SKP to the rear of the board. Then slide the unit into the instrument ensuring that the component side of board AD1 is facing the side frame of the instrument. Also check that the board locates correctly between the guides shown in Fig. 5-1b.

Access and removal of A1/2 keyboard

16. Limited access to the keyboard can be obtained without removing either AA0 or AB0 units. First ensure that the AC supply is disconnected from the instrument. Now remove the two outer instrument covers and then the four screws (two in each side frame) securing the front panel to the side frame. Turn the instrument upside down and remove the nut securing the SUPPLY ON-OFF switch. Push the switch back through the front panel. Disconnect the MOD IN-OUT socket SKJ from A2/2 board. It is now possible to hinge the front panel about the side of the RF OUTPUT socket. Access can now be gained to the rear of A1/2 keyboard which can be removed after withdrawing six cross-headed securing screws.

Rear panel mounting of RF OUTPUT socket

17. General instructions for rack mounting are given in Chap. 2 of the Operating Manual. The RF OUTPUT socket can be mounted on the rear panel without recourse to additional wiring. A front panel blanking grommet is supplied to insert in the vacated position if required.

18. First remove RF unit AB0 as described in previous paragraphs. Now remove the four cross-headed screws securing the front panel to the side frames and disconnect socket SKK from A2/2 board. The front panel can now be hinged to allow access. Keyboard A1 can now be removed from the front panel support by removing the six cross-headed screws. Access to the RF OUTPUT socket is now possible. Unfasten the retaining nut holding the socket to the front panel and refit the socket to the rear panel position after removing and discarding the blind grommet. Re-assemble the front panel unit and refit AB0.

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Chapter 5-1

PERFORMANCE TESTING

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INTRODUCTION

1. The test procedures in this chapter enable you to verify that the electrical performance of the Signal Generator complies with the Performance Data given in Chap. 1 (in the Operating Manual). The test equipment recommended for this purpose is listed in Chap. 5-0. All tests may be performed with the covers in place and are intended to be carried out in the order given. For convenience, the test equipment and specification for each test are summarized before the test procedure.
2. If the test results are outside limits, refer to the related part of the adjustment and calibration procedure (Chap. 5-2).

TEST PRECAUTIONS

3. To ensure minimum errors and uncertainties when making measurements, it is important to observe the following precautions:-
 - (1) Always use recently calibrated test equipment, with any correction figures taken into account, so as to establish a known or traceable limit of performance uncertainty. This uncertainty must be allowed for in determining the accuracy of measurements.
 - (2) A common external frequency standard, with an accuracy within ± 1 part in 10^6 , should be used for the generator and other frequency controlled test equipment.
 - (3) Use the shortest possible connecting leads; ideally the generator should be directly coupled to the test equipment.
 - (4) Allow a warm-up time of half an hour before commencing tests.

- PERFORMANCE TESTS -

Frequency accuracy

4. TEST EQUIPMENT

2022E PERFORMANCE DATA

(a) Frequency Counter 2435

Freq. range: 10 kHz to 1.01 GHz.
Accuracy: Equal to freq. std.



Fig. 5-2 Test gear arrangement to check frequency accuracy

Procedure

(1) Connect test equipment as shown in Fig. 5-2 and set the 2022E controls as follows :

CARR FREQ : 10 kHz
AM : OFF
FM/ΦM : OFF
RF LEVEL : -10 dB

(2) Carry out spot checks throughout the range of the instrument ensuring that frequencies can be selected correctly and that they are within specification.

(3) If you are using an external frequency standard, connect this to the rear panel STD FREQ IN socket. One of three frequencies can be used (1, 5 or 10 MHz) provided that an internal link selection within the 2022E corresponds to the frequency of the external standard. The link setting can be determined by selecting Second function 1 'Status' mode, which will display 1, 5 or 10 in the Modulation window. Instructions on changing the link setting are given in Chap. 5-2, para. 11.

(4) The level of an external frequency standard should be greater than 1 V RMS.

RF output

5. TEST EQUIPMENT

2022E PERFORMANCE DATA

(d) RF Power Meter 6960
and Power Sensor 6912

Level: -127 dBm to +10 dBm
Level accuracy: Better than ± 1 dB
from 10 kHz-1.01 GHz
(-10 dBm to +6 dBm)
1 dB from 10 kHz-1.01 GHz
(above -10 dBm).
>2 dB from 10 kHz-1.01 GHz
(below -10 dBm).

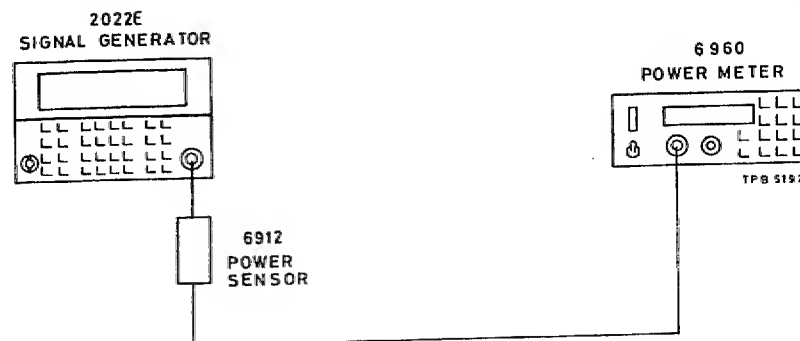


Fig. 5-3 Test gear arrangement to check RF output

Procedure

(1) Connect test equipment as shown in Fig. 5-3 and set the 2022E controls as follows :

CARR FREQ: 500 MHz
AM : OFF
FM/ΦM : OFF
RF LEVEL : -10 dBm (70.7 mV PD)

(2) Note the power reading at -10 dBm and check that this is within specification. Maintain this level setting and select other carrier frequencies e.g. 100 kHz, 1 MHz, 100 MHz and 1000 MHz.

(3) Further check other level settings up to a maximum of +10 dBm (0.707 V PD).

(4) Set the RF output level to 0 dBm. Check on the power meter that the 2022E output remains flat to within ± 1 dB from 30 kHz to 1010 MHz.

6. The 10 dB step attenuator AC0 contains three 30 dB pads, one 20 dB pad and one 10 dB pad. Each of these may be selected individually by utilizing the Second function 3 mode. Levels below -10 dBm can best be checked by this method as follows:-

(1) Set the 2022E RF OUTPUT to +10 dBm and set a reference level of 0 dB on the Power Meter 6960. AC0, step attenuator is controlled from A2/2 board address 05. To select each relay in turn enter by means of the keyboard controls Second function 3, then 05. If unfamiliar with this procedure see 'Manual latch setting' in Chap. 5-3, para. 62.

(2) The data showing in the Frequency window is that which is currently addressed to the attenuator latch in binary notation. Enter new data by means of '1' or '0' numerals via the instrument keyboard. Numbers are rotated in from the right. When the data is set press the STORE key and the appropriate relay will energize. See Table 5-3 for each attenuator relay selection.

TABLE 5-3 AC0/AC1 ATTENUATOR CHECK

D5	Binary number					Relay energized	Attenuation
	D4	D3	D2	D1	D0		
0	1	1	1	1	0	RLA	30 dB
0	1	1	1	0	1	RLB	20 dB
0	1	1	0	1	1	RLC	30 dB
0	1	0	1	1	1	RLD	10 dB
0	0	1	1	1	1	RLE	30 dB

(3) Check that the output falls to the appropriate level on the power meter as each attenuator pad is selected. Typical accuracy expected is as follows: 10 dB ± 0.2 dB, 20 dB ± 0.25 dB and 30 dB ± 0.3 dB.

(4) A spectrum analyzer may be used as an alternative to check levels down to -90 dBm with limited accuracy.

Modulation oscillator performance

7. TEST EQUIPMENT

2022E PERFORMANCE DATA

(b) Frequency Counter 2435	Freq.:	400 Hz, 1 kHz, 5 kHz.
(e) True RMS Voltmeter 2610	Accuracy:	$\pm 5\%$.
(p) Distortion Factor Meter TF 2331A	Distortion:	$< 1\%$ total harmonic distortion
	Output level:	1 V $\pm 10\%$ EMF from a nomi- nal 600 Ω source impedance.

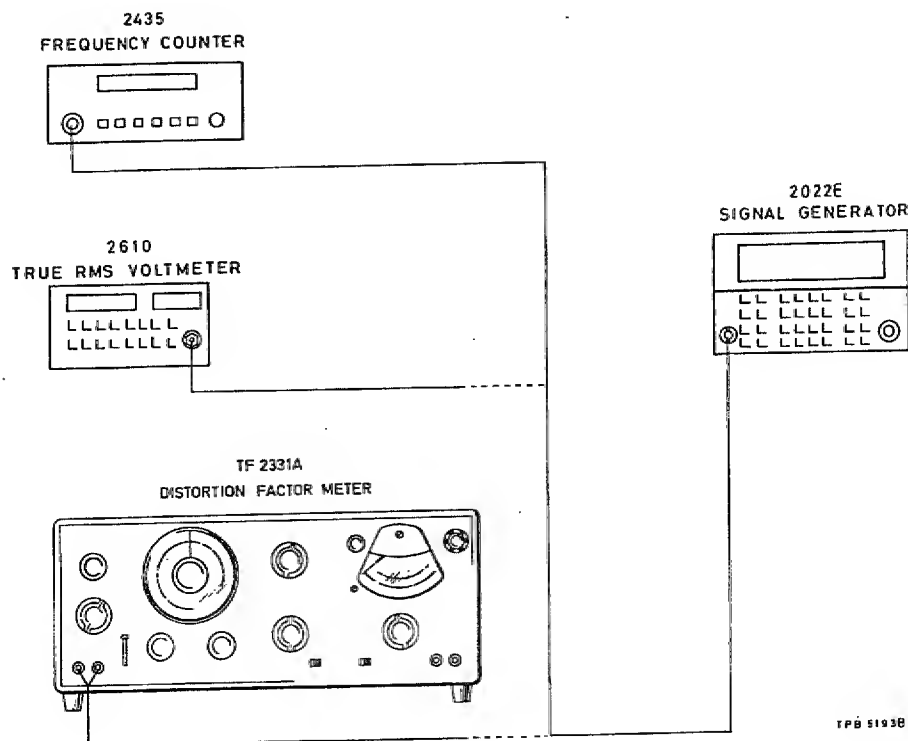


Fig. 5-4 Test gear arrangement to check Mod. osc. performance

Procedure

(1) Connect test equipment as shown in Fig. 5-4 and set the 2022E controls as follows:-

FM/ Φ M : FM (INTERNAL)
MOD ON/OFF : ON

- (2) Check that the frequency of the MOD IN/OUT signal is within specification.
- (3) Remove the frequency counter and connect the voltmeter to the 2022E MOD IN/OUT socket and check that the output level is within specification.
- (4) Remove the voltmeter and connect the distortion factor meter and check that distortion is within specification.
- (5) Press MOD ALC button to select the next modulation frequency and repeat tests for all three frequencies.

FM deviation and distortion

8. TEST EQUIPMENT

2022E PERFORMANCE DATA

(a) Modulation Meter 2305
with Distortion options kit

Range:

10 Hz to 125 kHz for
carriers from 10 kHz to
125 MHz.

10 Hz to 250 kHz for
carriers from 125 MHz
to 250 MHz.

10 Hz to 500 kHz for
carriers from 250 MHz
to 500 MHz.

10 Hz to 999 kHz for
carriers from 500 MHz
to 1.01 GHz.

Deviation accuracy: >5% of deviation at
1 kHz mod. freq.

excluding residual FM.

Distortion:

<3% total harmonic
distortion at 1 kHz
mod. freq. and max.

deviation for any carr.
freq. above 250 kHz.



Fig. 5-5 Test gear arrangement to check FM deviation and distortion

Procedure

(1) Connect test equipment as shown in Fig. 5-5 and set the 2022E controls as follows:-

CARR FREQ: 250 MHz
FM/ΦM : FM
Deviation : 250 kHz
RF LEVEL : 0 dBm

(2) On the modulation meter select FM, 300 Hz – 3.4 kHz filter, noise averaging.

(3) Check on the modulation meter that the deviation indicated is within $\pm 5\%$ of that set.

- (4) Repeat for random carrier frequencies from 500 kHz to 1010 MHz.

Note...

Measurement at 250 MHz with 250 kHz deviation is equivalent to measurements at 500 MHz with 500 kHz deviation and 1 GHz with 1 MHz deviation due to the operation of the instrument.

- (5) Repeat for random deviation settings from 1 kHz to 250 kHz.

Note ...

For lower deviation settings the residual FM of the 2022E and 2305 will have to be taken into consideration.

- (6) Set the 2022E controls as follows :

CARR FREQ : 400 MHz
FM/ΦM : FM
Deviation : 99.9 kHz
RF LEVEL : 0 dBm

- (7) On the 2305 select "DISTORTION" and check the distortion indicated is less than 2%.

- (8) Repeat with random carrier frequencies between 500 kHz and 1010 MHz.

Phase modulation and distortion

9. TEST EQUIPMENT

2022E PERFORMANCE DATA

(a) Modulation Meter 2305
with Distortion options
kit.

Range: 0.01 to 9.99 radians.
Deviation accuracy: >5% of deviation at
1 kHz mod. freq.
excluding residual
phase mod.
Distortion: <5% total harmonic
distortion at 1 kHz
mod. freq and max.
dev. at any carrier
freq. above 250 kHz.

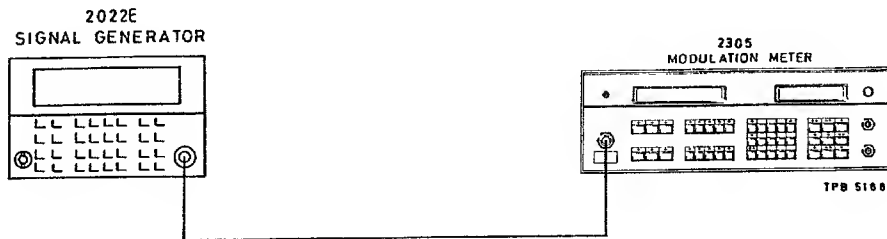


Fig. 5-6 Test gear arrangement for checking phase mod. and distortion

Procedure

(1) Connect test equipment as shown in Fig. 5-6 and set the 2022E controls as follows :

CARR FREQ: 250 MHz
FM/ Φ M : Φ M
Deviation : 9.99 Radians
RF LEVEL : 0 dBm

Because Φ M and FM mostly share common circuitry it is necessary to check only one deviation setting.

(2) On the 2305 Φ M function key and check that the deviation reading is within specification.

(3) Select 2305 DIST function key and check that the distortion is within specification.

AM depth and distortion (Internal)

10. TEST EQUIPMENT

2022E PERFORMANCE DATA

(a) Modulation Meter 2305 with Distortion options kit.	Range:	0 to 99.5%.
	Accuracy:	>4% of depth setting +1% for 1 kHz mod. freq. and depths up to 95% for carrier freqs. up to 62.5 MHz (80% for carrier freqs. up to 400 MHz).
	Freq. response:	± 3 dB from 20 Hz - 50 kHz.
	Distortion:	<3% total harmonic distortion at 1 kHz modulation frequency for depths up to 80% for car- rier frequencies up to 400 MHz. <5% total harmonic distortion at 1 kHz modulation frequency for depths up to 95% for car- rier frequencies up to 62.5 MHz.



Fig. 5-7 Test gear arrangement to check AM depth and distortion

Procedure

(1) Connect test equipment as shown in Fig. 5-7 and set the 2022E controls as follows :

CARR FREQ: 15 MHz
AM : ON
Modulation : 95%
RF LEVEL : 0 dBm

A fixed frequency modulator is used to provide the modulation at carrier frequencies below 62.5 MHz and envelope feedback is used for carrier frequencies above 62.5 MHz.

(2) On the 2305 select the 30 Hz to 50 kHz filter and AM function key. Check that the displayed reading is within specification.

(3) Select 2305, DIST function key and check that the distortion is within specification.

(4) Reset 2022E controls :

CARR FREQ: 200 MHz
AM : ON
Modulation : 80%
RF LEVEL : 0 dBm

11. Again check the depth and distortion as described in steps (2) and (3) using the 2305. Finally repeat step (4) with the RF LEVEL setting reduced to -7 dBm, readings should remain unchanged.

External modulation (ALC ON)

12. TEST EQUIPMENT

2022E PERFORMANCE DATA

- (a) Modulation Meter 2305
- (e) True RMS Voltmeter 2610
- (f) AF Signal Source (low distortion)

Input level: Deviation is calibrated for input levels between 0.9 V and 1.1 V RMS. HI or LO on display indicate if outside this range.

Freq. response: AM ± 3 dB from 20Hz to 50kHz
 (relative to 1kHz mod. with ALC ON) FM ± 1.5 dB from 50Hz to 80kHz
 Φ M ± 1 dB from 50Hz to 10kHz.

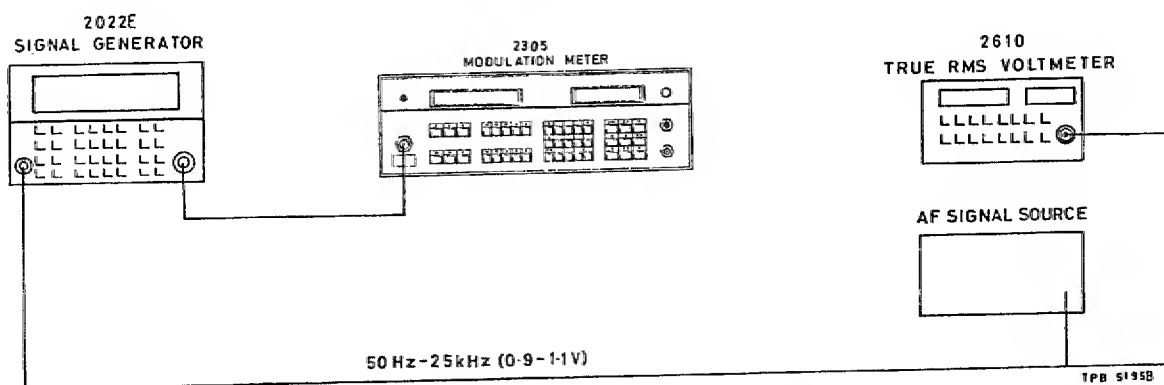


Fig. 5-8 Test gear arrangement to check external modulation

Procedure

(1) Because AM, FM and Φ M external modulation use a common circuit configuration, checking need only be carried out with one type of modulation input. Connect the test equipment as shown in Fig. 5-8 and set the 2022E controls as follows :

CARR FREQ : 250 MHz
 FM/ Φ M : FM
 INT/EXT : EXT
 Deviation : 250 kHz
 MOD ALC : ON (LED lit)

- (2) Apply a 1 kHz, 1.00 V RMS input from a low distortion AF signal source to the 2022E MOD IN-OUT socket.
- (3) On the 2305 select the 10 - 300 kHz filter and FM function key. Check that the displayed FM deviation reading is within specification.
- (4) Vary the input voltage between 0.9 V and 1.1 V and check that the modulation display does not indicate either a HI or LO message. Also check that the deviation remains constant over the range.
- (5) Select 2305 REL function key and vary the frequency of the external mod. signal between 50 Hz and 80 kHz. Check that the deviation remains within ± 1.5 dB of the value set at 1 kHz mod. frequency.

- (6) Set the 2022E to 80% AM EXT and ALC ON. Return the AF source frequency to 1 kHz and set the 2305 to monitor AM, absolute, noise average.
- (7) Select 2305 REL function. Vary the frequency of the AF source signal between 20 Hz and 50 kHz and check that the deviation remains within ± 3 dB of the value set at 1 kHz modulation frequency.

External modulation (ALC off)

- 13. (1) Connect test equipment as shown in the Fig. 5-8. Maintain 2022E settings with the exception of the MOD ALC key. Press this to disable the ALC (adjacent LED should be extinguished).
- (2) Select 2305 ABS function key and apply a 1 kHz, 1.00 V RMS signal to the MOD IN-OUT socket of the 2022E. Check that the FM deviation displayed on the 2305 is within specification.

Auxiliary modulation

14. TEST EQUIPMENT

- (a) Modulation Meter 2305
- (f) AF Signal Source

2022E PERFORMANCE DATA

A rear panel BNC socket provides an auxiliary modulation input with a nominal sensitivity of 20% of the set modulation deviation/depth for a 1 V PD input. Input impedance 600 Ω nominal.

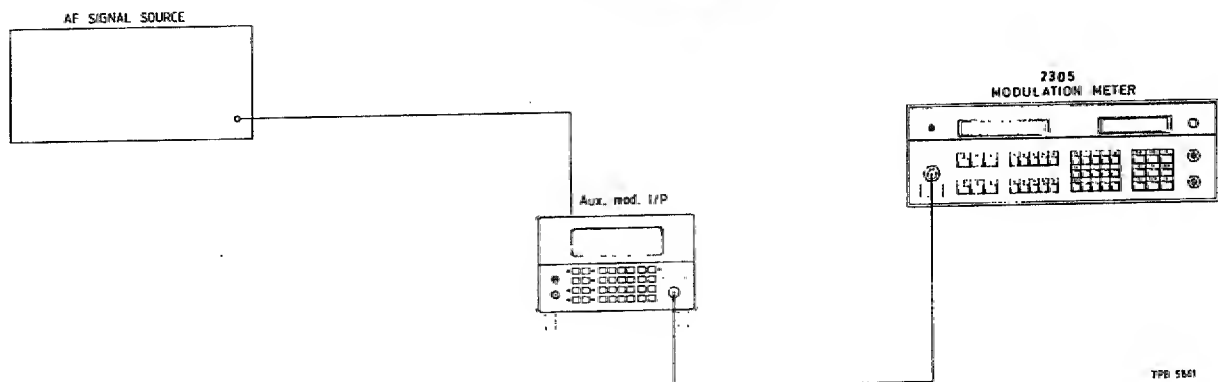


Fig. 5-9 Test gear arrangement to check auxiliary modulation

Procedure

- (1) Connect the test equipment as shown in Fig. 5-9.
- (2) Set the AF signal source to give a frequency of 1 kHz at 1.00 V RMS.
- (3) Set the 2022E controls as follows :

CARR FREQ : 100 MHz
 RF LEVEL : 0 dB
 FM : 50 kHz
 INT/EXT : EXT
 MOD ALC : OFF (LED OFF)

- (4) Set the 2305 controls as follows:-

AUTOTUNE
 300 Hz - 3.4 kHz FILTER
 DE-EMPHASIS : OFF
 FUNCTION : FM, ABS, $\frac{P-P}{2}$

- (5) Check that the 2305 indicates a nominal deviation of 1 kHz.

VSWR (50 kHz – 350 MHz)

15. TEST EQUIPMENT

- (g) RF Millivoltmeter TF 2603
- (h) T connector, TM 7984
- (i) N type 50 Ω load TM 7967

2022E PERFORMANCE DATA

VSWR: <1.5:1 for all output levels

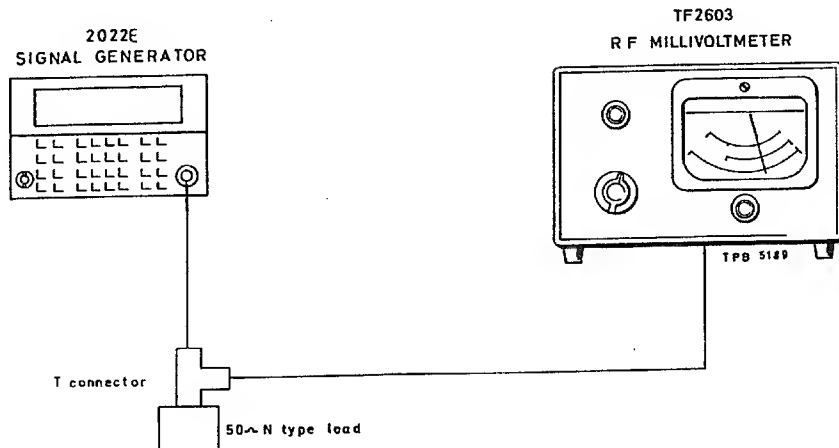


Fig. 5-10 Test gear arrangement to check VSWR up to 350 MHz

Procedure

- (1) Connect test equipment as shown in Fig. 5-10 and set the 2022E controls as follows :

CARR FREQ: 100 MHz
RF LEVEL : -10 dBm (70.7 mV PD)

- (2) With the 50 Ω load disconnected note the reading in the TF 2603.
- (3) Now insert the 50 Ω load and note the new reading. The impedance, Z, is calculated using the following formula,

$$Z = \frac{50 E}{V} - 50 \Omega$$

where E = open circuit output level
and V = output across the 50 Ω load.

From the above, VSWR = $\frac{Z}{50}$ or $\frac{50}{Z}$ and should be better than 1.5:1.

VSWR (above 350 MHz)

16. TEST EQUIPMENT

2022E PERFORMANCE DATA

- (j) Short circuit monitor
- (k) 20 cm Air spaced line GR 874-L20
- (l) 20 cm Adjustable line GR 874-LK20L
- (m) DC microvoltmeter

VSWR: <1.5:1 for all output levels

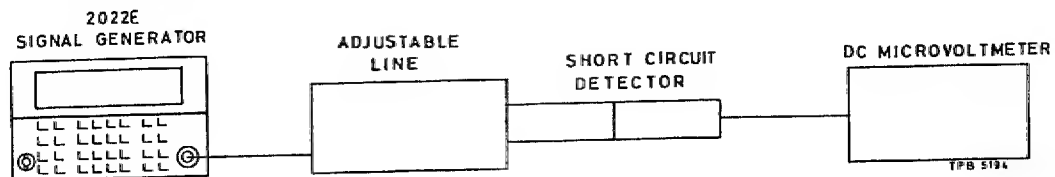


Fig. 5-11 Test gear arrangement to check VSWR above 350 MHz

- (1) Connect the test equipment as shown in Fig. 5-11 and set the 2022E controls as follows :

CARR FREQ: 500 MHz
RF LEVEL : -10 dBm (70 mV)

- (2) Set the adjustable line to $\lambda/2$ of the signal by applying the formula

$$\lambda = \frac{300}{f}$$

where λ is the wavelength in metres
and f is the frequency in MHz.

For example, at 500 MHz, $\lambda = \frac{300}{500} = 0.6$ m

therefore $\lambda/2 = 30$ cm

- (3) Adjust the line length for maximum indication on the meter and note the reading. Adjust the line length for minimum indication on the meter ($\lambda/4$).

Note ...

The short circuit current monitor uses a diode to detect the maximum and minimum values (V_{max} . and V_{min} .) This diode is being used at the lowest part of its characteristic and the square law applies.

The VSWR is therefore equal to $\sqrt{\frac{V_{max}}{V_{min}}}$ and should be better than 1.5:1.

Carrier harmonics and sub-harmonics

17. TEST EQUIPMENT

2022E PERFORMANCE DATA

(n) Spectrum analyzer

- | | |
|--|--|
| 1. Harmonically related signals for output levels up to +10 dBm. | Better than -25 dBc. |
| 2. Sub-harmonics for output levels below +10 dBm. | None for carrier freqs. below 500 MHz.
-25 dBc above 50MHz. |
| 3. Non-harmonically related signals for output levels below +10 dBm. | <-70 dBc for carrier freqs. of 62.5MHz and above.
<-60 dBc below 62.5MHz. |



Fig. 5-12 Test gear arrangement to check carrier harmonics and sub-harmonics

Procedure

- (1) Connect the test equipment as shown in Fig. 5-12 and set the 2022E controls as follows :

RF LEVEL : 10 dBm
CARR FREQ: 15 MHz
AM,FM,ΦM : OFF

- (2) The spectrum analyzer used should be capable of measuring at least the 3rd harmonic of the carrier frequency. Check that the amplitude of any harmonic does not exceed specification at carrier frequencies of 15, 63, 126, 252, 300 and 500 MHz. Repeat above checks with further RF level settings of 0 dBm and -7 dBm. The carrier frequencies selected will check for harmonics in the following circuits :

15 MHz	BFO band
63 MHz	Incorporates two stages of freq. division
126 MHz	Uses a single divider stage
252 MHz	Fundamental band
300 MHz	Checks the tracking of the tuning notch
350 MHz	" " " " " "
500 MHz	Doubler band

PERFORMANCE TESTING

(3) Sub-harmonics are only produced when carrier frequencies above 500 MHz are selected. Check at the three RF level settings given (+10 dBm, 0 dBm and -7 dBm) that the sub-harmonics do not exceed specifications at each of the following carrier frequencies : 501 MHz, 700 MHz, 900 MHz and 1000 MHz.

Residual FM

18. TEST EQUIPMENT

2022E PERFORMANCE DATA

- (a) Modulation Meter
- (q) Low noise signal generator
- (s) 2 MHz low-pass filter

Residual FM
(FM OFF): <7 Hz RMS (10 Hz equivalent peak) deviation in a 300 Hz to 3 kHz bandwidth at 499 MHz and improving by 6 dB per octave with reducing carrier frequency down to 62.5 MHz.
<3.5 Hz RMS (5 Hz equivalent peak) below 62.5 MHz.

Note ...

Owing to the low residual specification of the 2022E the FM residual measurement system should have a typical residual noise figure of less than 1.5 Hz up to 500 MHz and 2.5 Hz up to 1000 MHz. (The following set-up makes use of the low noise low frequency end of the 2305.)

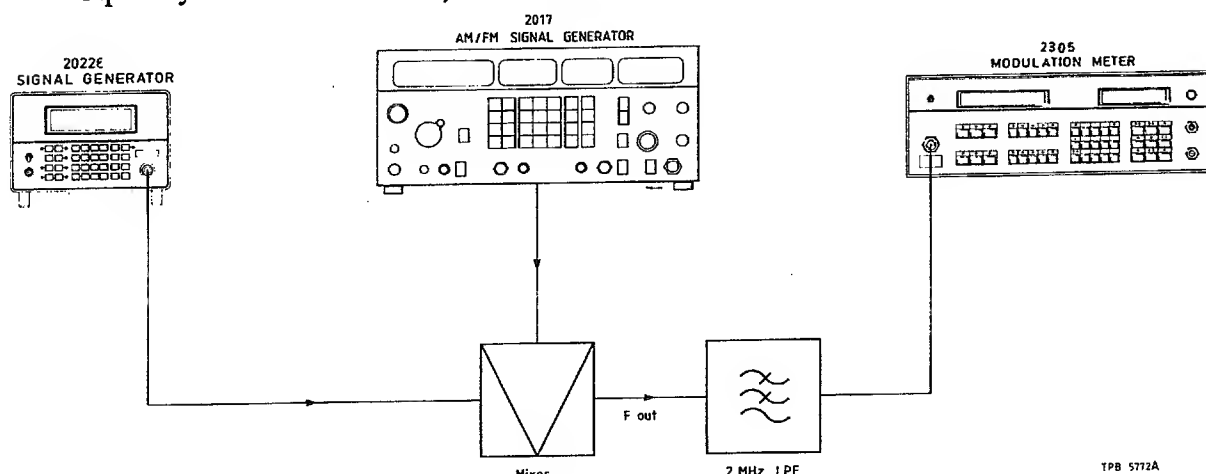


Fig. 5-13 Test gear arrangement to check residual FM

Procedure

- (1) Connect the equipment as shown.
- (2) Set the 2305 controls as follows: FM, absolute, 300 Hz to 3.4 kHz filter, noise average.
- (3) Set the 2022E to give a carrier frequency of 499 MHz, RF LEVEL 0 dBm, FM OFF.
- (4) Set the 2017 to give a carrier frequency of 500 MHz, RF LEVEL 0 dBm, FM OFF.

Note ...

The 2017 should always be set 1 MHz higher than the frequency set on the 2022E.

PERFORMANCE TESTING

- (5) Check that the residual FM reading on the modulation meter is 10 Hz or less.
- (6) Set the 2022E frequency to 62 MHz and the 2017 frequency to 63 MHz and check that the residual FM reading on the modulation meter is 5 Hz or less.
- (7) Set the 2022E frequency to 1000 MHz and the 2017 frequency to 1001 MHz and check that the residual FM reading on the modulation meter is 20 Hz or less.

Reverse power protection

19. TEST EQUIPMENT

2022E PERFORMANCE DATA

- (e) True RMS Voltmeter 2610
- (o) Variable DC power supply
TF 2158

Protection: The generator output is protected against reverse power of up to 25 W from a source VSWR 5:1 from DC to 1.01 GHz.

Procedure

- (1) Switch the 2022E on so as to internally connect the RF OUTPUT socket of the instrument. Set the RF LEVEL to 0 dBm (this will protect the resistors in the attenuator in the event of an RPP malfunction). Then set the DC power supply to +5 V and apply this to the 2022E RF OUTPUT 50 Ω socket causing the RPP circuit to trip (taking care not to damage the connector pin).
- (2) An indication that the reverse power unit has been tripped will now be given by the REV PWR annunciator which will flash on the RF LEVEL display.
- (3) Remove the +5 V source and check that there is no continuity between the 'N' type connector centre pin and earth (again taking care not to damage the connector pin). If the RPP has not tripped, a resistance of approximately 1 k Ω may be measured between the centre pin and earth.
- (4) Reset the RPP by pressing the RF LEVEL key and ensure that the REV PWR indication is now off. Set the DC power supply to -5 V and apply this again to the RF OUTPUT 50 Ω socket checking that the RPP trips once more. Remove the DC source and reset the RPP.
- (5) Operation of the RPP trip circuit can also be checked if required without the application of a voltage to the RF OUTPUT 50 Ω socket using Second function 3 (Manual latch setting). Access to the attenuator latch for AC0 and the means of entering the necessary data to achieve this is described in para. 6. Setting a binary '1' level in D5 (see Table 5-3) will cause the RPP to trip.

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Chapter 5-2

ADJUSTMENT AND CALIBRATION

CONTENTS

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- 5 Second function '191' FM tracking calibration
- 6 Second function '192' RF level calibration
- 7 Second function '193' Voltage tuned filters (VTF) calibration
- 8 Second function '194' AM calibration
- 9 Second function '195' Calibration and storage of amended EAROM checksum
- 10 EAROM initialization
- 11 External frequency standard adjustment (1, 5 or 10 MHz)

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Fig.

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INTRODUCTION

1. This chapter describes adjustments which will restore the instrument to its peak operating condition. Test equipment recommended for this purpose is listed in Chap. 5-0 and summarized for board test procedure. Before carrying out any adjustment procedures refer to Chap. 5-0 for safety considerations and access instructions.
2. Information is given for the overall realignment of the instrument with details of preset components, affected circuits and the use of second function controls where these are needed in recalibration procedures.
3. After completing repairs to a circuit or replacement of a board it may be necessary to carry out realignment. If a full overall realignment is required it should be carried out in the order shown in Table 5-4 below.

TABLE 5-4 REALIGNMENT ORDER

Order	Adjustment	Table of reference	2ND FUNCT
1	Set +12 V	5-7	None
2	+5 V	5-7	None
3	-12 V	5-7	None
4	+24 V	5-7	None
5	+21 V	5-9	None
6	LCD off	5-6	None
7	Internal audio level	5-8	None
8	250 MHz	5-10	None
9	353 MHz	5-10	None
10	160 MHz	5-10	None
11	160 MHz 'LF AM Mod'.	5-10	None
12	Correct jitter	5-7	None
13	Cal. band-pass tracking	5-7	193
-	and Notch	5-10	3
14	Cal. RF power >62.5 MHz	5-7	192
15	Cal. RF power <62.5 MHz	5-7	192
16	Cal. AM >62.5 MHz	5-7	194
17	Cal. AM <62.5 MHz	5-7	194
18	External mod.	5-6	None
19	Set LF FM and	5-6	191
-	FM tracking	5-20	191
20	Set Φ M	5-6	None
21	Set Int. Std. Freq.	5-6	None

4. If only one board is affected and a full overall realignment procedure is not needed then the individual board can be realigned with reference to Tables 5-5 to 5-10. Some of the tables make reference to certain alignment procedures using second functions 191-194. A comprehensive description of these is included in paragraphs 5 to 10.

Note ...

Before any adjustments are made all screening covers should, where possible, be firmly fitted.

Second function '191' FM tracking calibration

5. The FM tracking calibration data comprises two tables of calibration points. These are listed in Table 5-20 (Chap. 5-3). To enter data, carry out the following procedure :

- (1) Unlock the instrument to allow second level operation.
- (2) Select CARR FREQ 250 MHz and a carrier frequency increment of 4.12 MHz, FM INT, 99.9 kHz.
- (3) Enter 2ND FUNCT 191.
- (4) Monitor the actual deviation obtained on a modulation meter (2305). If no data has been stored, enter the value shown in Table 5-20, e.g. 194. Now using the up (↑) or down (↓) key adjust the calibration data until the modulation meter reads closest to the value 99.9 kHz and press the STORE key, (see following Notes before calibrating).
- (5) Reselect CARR FREQ followed by the up key to increment the carrier frequency by 4.12 MHz. Re-enter 2ND FUNCT 191 and the approximate data, (e.g. 204) then adjust the value using the up or down key as described in step (4) and STORE. Repeat the above procedure for succeeding 4.12 MHz increments entering data in each until reaching a carrier frequency of 353 MHz. At this point reselect CARR FREQ 352.999 MHz, 2ND FUNCT 191, enter data and STORE.
- (6) Select CARR FREQ, 353 MHz and a carrier frequency increment of 5.88 MHz, re-enter 2ND FUNCT 191 then continue entering data as previously described in steps (4) & (5) until reaching a carrier frequency of 500 MHz. At this point select instead CARR FREQ 499.9999 MHz, re-enter 2ND FUNCT 191, enter data and STORE. This completes the FM tracking.

Notes ...

- (1) The audio frequency response must have previously been adjusted using A2/2 R58, 'SET LF FM'.
- (2) A suitable bandwidth must be selected on the modulation meter to avoid errors due to demodulated noise e.g. (50 Hz - 15 kHz).

Second function '192' RF level calibration

6. The RF level is calibrated at 11 selected reference points, each point is numbered from 00 to 10 with the selected point displayed in the modulation window. Calibration is carried out first at 15 MHz and then in 100 MHz steps from 100 to 1000 MHz.

- (1) Unlock the instrument to allow second level operation.
- (2) Select CARR FREQ, 15 MHz, RF LEVEL, +2.9 dBm and an RF level increment of 9.9 dB.
- (3) Enter 2ND FUNCT 192.
- (4) Monitor the RF OUTPUT using a Power Meter (6960) and Power Sensor (6912).

(5) Enter a value of data that will give a reading of +2.9 dBm on the power meter using the up or down keys as required (there is no auto incrementing on this function).

(6) Select RF LEVEL then the down key to obtain a level of -7 dBm; adjust AB1/2 R101, 'LF ALC LOW' for a 9.9 dB difference between this reading and that obtained in step (5), (dB rel. key can be used on 6960). Reselect the up key to obtain 2.9 dBm output and iterate until the values obtained in step (5) and (6) are as close to 2.9 dBm and -7 dBm as possible, then STORE the calibration data.

(7) Select CARR FREQ, 200 MHz and a carrier frequency increment of 100 MHz, RF LEVEL, 2.9 dBm. Now repeat the procedure described in steps (4) and (5) decrementing the level to -7 dBm and in this case adjusting A2/2 R84, 'HF ALC LOW' to obtain the 9.9 dB difference.

(8) Select CARR FREQ and using the down key decrement the carrier frequency to 100 MHz, select RF LEVEL, 2.9 dBm. Re-enter 2ND FUNCT 192 followed by a value of data to obtain a reading of 2.9 dBm on the power meter then STORE. Now select CARR FREQ and with the up key increment the carrier to select a frequency of 300 MHz. Re-enter 2ND FUNCT 192 and enter data to give a power meter reading of 2.9 dBm and STORE. Continue to increment the carrier frequency in 100 MHz steps entering data and storing in each case until reaching the last data point, 10 (1000 MHz). This completes the RF level calibration.

Second function '193' voltage tuned filters (VTF) calibration

7. The VTF or Output harmonic control calibration table consists of 6 points calibrated in 100 MHz steps from 500 MHz to 1000 MHz. Each point is numbered from 00 to 05 with the selected data point displayed in the modulation window. Calibration is carried out as follows:-

- (1) Unlock the instrument to allow second level operation.
- (2) Select CARR FREQ, 500 MHz and a carrier frequency increment of 100 MHz.
- (3) Monitor AB1/2 'ALC HF' test point with a digital voltmeter.
- (4) Enter 2ND FUNCT 193.
- (5) Enter or adjust data to obtain the greatest positive reading possible (typically +10 V), then press the STORE key to terminate the entry. Typical values of calibration data expected can be seen in Table 5-21 (Chap. 5-3). Values of voltage shown in that table however cannot be compared because they are taken from a different circuit reference.
- (6) Select CARR FREQ followed by the up key to select a carrier frequency of 600 MHz. Repeat the procedure described from step (4) and continue the calibration for each step until reaching the last data point, 05 (1000 MHz). This completes the VTF calibration.

Second function '194' AM calibration

8. Only two points are calibrated. At point 00 data is entered at a carrier frequency of 15 MHz and point 01 at a carrier frequency of 100 MHz. 00 or 01 is displayed in the modulation window after selecting 2ND FUNCT 194 and the relevant carrier frequency. Calibrate as follows:-

- (1) Unlock the instrument to allow second level operation.
- (2) Select CARR FREQ, 15 MHz, AM, INT, 95%, RF LEVEL, +3 dBm.
- (3) Monitor the RF OUTPUT socket using a modulation meter (2305).
- (4) Enter 2ND FUNCT 194.
- (5) Enter or adjust data to obtain a mod. meter reading of 95% then STORE to terminate the entry.
- (6) Select CARR FREQ, 200 MHz, AM, INT, 90% and an RF level increment of 9.9 dB.
- (7) Again enter 2ND FUNCT 194 and enter or adjust data to obtain a reading on the mod. meter of 90% then STORE the value.
- (8) Select RF LEVEL followed by the down key to give a power level reading of -6.9 dBm. Adjust A2/2 R90 'CORRECT DETECTOR' to give a mod. meter reading of 90% AM. Reselect up and down keys and repeat the adjustment until a reading of 90% is obtained at both 6 dBm and -6.9 dBm. This completes the AM calibration.

Second function '195' calculation and storage of amended EAROM checksum

9. If the instrument has been recalibrated, or if data in the EAROM, AA2/1 IC10, has been accidentally erased, or if an unserviceable EAROM has been replaced then a new checksum should be stored and initialization should be carried out. When recalibrating the instrument following EAROM replacement it should not be necessary to adjust any of the internal preset components; calibration data can be found by accessing the data from the front panel second function controls and in the following order 191,193,192,194. Enter the calibration information for each of the above second functions and store in each case. When this is completed select 2ND FUNCT 195 and STORE. The instrument will re-calculate the checksum, store this in the non-volatile memory and display 000 to indicate completion.

EAROM initialization

10. Data stored within the EAROM but not part of the checksum will also have to be re-entered. A replacement EAROM is normally supplied with all '1's stored, therefore flags on most second functions and other settings referred to have been arranged such that the most useful are selected when a replacement EAROM is installed. Each of the following should be checked, re-entered if necessary, depending on individual user requirements, and in the order given below.

- (1) RF level offsets data (second function 15) off '0' on '1'. This facility must not be used until the instrument is calibrated.
- (2) Checksum data for calibration values (second function 195).
- (3) Timer information, both for the resettable (second function 9) and the fixed timer (second function 199) – see Note below.
- (4) Identity strings (second function 190) – Chap. 4 para. 191 refers. These can be recalled using either second functions 5 or 11.
- (5) User defined strings entered by means of second function 12.
- (6) Instrument settings stored by the user. Store protection (second function 196) and Display blanking of recalled stores (second function 197). Each store has a separate checksum which is automatically entered on storing a valid setting. Stores not having a value entered will initiate a EAROM recall error message 15 when recalled.
- (7) Calibration information from second functions 191–194.
- (8) External frequency standard 10,5 or 1 MHz (second function 10).
- 9) If the optional GPIB facility is fitted set the address as required (second function 2).

The total instrument operating time indicator, if accessed by second function 198 will probably read 131, 071 hours. After approximately 15 minutes instrument running this will overflow and reset to 0 hours.

TABLE 5-5 A1/2 KEYBOARD AND DISPLAY BOARD ALIGNMENT

Test equipment	Method	Adjustment window/Comments
Visual examination only required.	Adjust R2 whilst observing the segment of the display from an acute angle. Adjust so that 'off' segments are barely turned off.	Some contrast may be lost if incorrectly adjusted.

TABLE 5-6 A2/2 POWER SUPPLY AND CONTROL BOARD ALIGNMENT

Adjustment	Test equipment	Method	Adjustment window/Comments
R5 'Set +12 V'	DVM	Detach all board external loads and adjust to +12.1 V	± 0.1 V
R15 'Set +5 V'	DVM	Detach all board external loads and adjust to +5.05 V	± 0.05 V
R8 'Set -12 V'	DVM	Detach all board external loads and adjust to -12.1 V.	± 0.1 V
R89	DVM	Detach all board external loads and adjust to +24.25 V.	± 0.25 V
R67 'Correct Jitter'	Modulation meter connected to a spectrum analyzer.	Select CARR FREQ, 250.0005 MHz. Look for a tone and null this.	If this is incorrectly set there may be additional coherent signals present with the carrier frequency.
'Cal. band-pass filter'	DVM	Select CARR FREQ, 500 MHz Monitor 'ALC HF' test point on AB1/2. Adjust CAL DATA (using 2ND FUNCT 193) for greatest positive reading. Repeat at 100 MHz intervals up to 1 GHz.	Increments are extremely fine and a setting within ± 5 counts will give adequate results.
'Cal. RF power and R84 HF ALC low'	RF power meter	Select CARR FREQ, 200 MHz, RF LEVEL +2.9 dBm. Adjust for +2.9 dBm output (using 2ND FUNCT 192). Select RF LEVEL -7 dBm and adjust R84 then optimize with +2.9 dBm adjustment. Finally calibrate at 100 MHz and subsequent 100 MHz intervals up to 1 GHz.	Adjust R84 to give a 9.9 dB difference between the 2.9 dBm and -7 dBm readings at 200 MHz.

TABLE 5-6 A2/2 POWER SUPPLY AND CONTROL BOARD ALIGNMENT (contd.)

Adjustment	Test equipment	Method	Adjustment window/Comments
'Cal. AM ≥ 62.5 MHz' and R90 Correct det'.	Modulation meter	Select CARR FREQ, 200 MHz, RF LEVEL, 6 dBm, AM, AM 80%. Adjust (using 2ND FUNCT 194) until reading is correct. Select RF LEVEL, -6.9 dBm, AM, 90% and adjust R90 for correct AM depth. Re-check cal. data setting at 6 dBm.	
'Cal. RF power' and R101 (AB1/1) 'LF ALC low'	Power meter	Select CARR FREQ, 15 MHz, RF LEVEL, 2.9 dBm. Adjust (using 2ND FUNCT 192) cal. data for 2.9 dBm output. Select RF LEVEL, -7 dBm and adjust R101 (AB1/2) for -9.9 dB w.r.t. 2.9 dBm reading. Recheck the 2.9 dBm setting.	It is unlikely that there will be a significant dif- ference in the calibration data.
'Cal. AM <62.5 MHz'	Modulation meter.	Select CARR FREQ, 15 MHz, RF LEVEL, +3 dBm, AM, 95%. Adjust (using 2ND FUNCT 194) for correct value.	It is unlikely that a significant change in cal. data will be required.
R113 'External Mod'	Modulation meter. Accurate 1 V RMS 1 kHz external source.	Select CARR FREQ, 250 MHz, FM dev., 99.9 kHz. Apply Ext. Mod. source, MOD ALC on. Note the reading. Switch MOD ALC off and adjust R113 for iden- tical dev. reading. Recheck MOD ALC on reading.	

TABLE 5-6 A2/2 POWER SUPPLY AND CONTROL BOARD ALIGNMENT (contd.)

Adjustment	Test equipment	Method	Adjustment window/Comments
'Cal. FM and R58 Set LF FM'	Modulation meter and Audio source 100 Hz, 0 kHz, 1 V RMS.	Select CARR FREQ, 250 MHz, FM dev. 99.9 kHz. Apply 10 kHz Ext. Mod. source, MOD ALC on. Adjust cal. data (using 2ND FUNCT 191) for 99.9 kHz dev. Now set Ext. Mod. source to 100 Hz and adjust R58 for 99.9 kHz dev. Remove Ext. Mod. source and select Int. Mod. and re-calibrate at frequencies shown in Table 5-20.	If calibration number does not change by more than one or two digits, check to see if FM is within specification before proceeding with re-calibration.
R56 'Set Φ M'	Modulation meter	Select CARR FREQ, 250 MHz, Φ M 9.99 rads. dev. Adjust R56 for the same reading.	Can be demodulated as FM and dev. set to 9.99 kHz. 1 kHz internal source frequency is extremely accurate.
(A0/1)R1 'Int. Std. Adjust'.	Frequency counter	Adjust A0/R1 for correct reading.	2022E frequency accuracy is directly dependent on this setting.

TABLE 5-7 AA1/1 SYNTHESIZER BOARD ALIGNMENT

Adjustment	Test equipment	Method	Adjustment window/Comments
R43 'Set audio level'	AC voltmeter	Select 1 kHz INT MOD and monitor the voltage on the MOD IN/OUT socket. Adjust R81 for 1.00 V RMS.	
(A0/1)R1 'Int. Std. Adjust'	Adjustment carried out in conjunction with A2/2 board alignment – see Table 5-6.		
(A2/2)R67 'Correct jitter'	Adjustment carried out in conjunction with A2/2 board alignment – see Table 5-6.		Allows for variations in component value.
(A2/2)R58 'Set LF FM'	Adjustment carried out in conjunction with A2/2 board alignment – see Table 5-6.		Allows for variations in component value.

TABLE 5-8 AA2/1 MICROPROCESSOR BOARD ALIGNMENT

Adjustment	Test equipment	Method	Adjustment window/Comments
R1 'Set +4.5 V'	Digital voltmeter	Monitor TP1 and adjust R1 for +4.5 V.	Between +4.5 and +4.55 V.
EAROM Recalibration	All recalibration data relating to second functions 191,192,193 and 194.		Should not be necessary to re-adjust preset controls if this is the only requirement.

TABLE 5-9 AB1/1 RF PROCESSING BOARD ALIGNMENT

Adjustment	Test equipment	Method	Adjustment window/Comments
C38 '250 MHz'	Digital voltmeter	Select CARR FREQ, 250 MHz. Adjust C38 for 2.0 V on PLAD pin 16.	± 0.1 V
C31 '353 MHz' (carrier frequency)	Digital voltmeter	Select CARR FREQ, 33 MHz. Adjust C31 for 2.0 V on PLAD pin 16.	± 0.1 V

TABLE 5-9 AB1/1 RF PROCESSING BOARD ALIGNMENT (contd.)

Adjustment	Test equipment	Method	Adjustment window/Comments
C7 '160 MHz'	Digital voltmeter	Select CARR FREQ, 10 MHz. Adjust C7 for 12.0 V on PLAD pin 1.	± 1 V
C18 'LF AM MOD'	Digital voltmeter	Select CARR FREQ, 10 MHz RF LEVEL, 0 dBm. Connect DVM to ALC LF test point and adjust C18 for maximum positive voltage.	Nominally +6 V to +7 V.
'Cal FM and (A2/2)R58 Set LF FM'	See A2/2 board alignment (Table 5-6)		
'Cal RF power and (A2/2)R84 HF ALC low'	See A2/2 board alignment (Table 5-6)		
'Cal RF power and R101 LF ALC low'	See A2/2 board alignment (Table 5-6)		
'Cal band-pass filter and L13 notch'	Digital volt- meter and 500 MHz Spectrum Analyzer	Calibrate band-pass filter (see A2/2 board alignment). Note calibration value at 500 MHz. Select CARR FREQ, 499 MHz, RF LEVEL, +6 dBm, (using 2ND FUNCT 3 address[12]) enter value noted above into the filter tracking DAC. Adjust L13 for minimum output at 499 MHz.	There will be some effect due to hand capacitance although the adjustment is not critical. Should obtain typically 20 dB rejection from the notch.
C16 'LF AM mod.'	Digital voltmeter	Select CARR FREQ 15 MHz. Monitor 'ALC LF' test point and adjust for maximum reading.	The voltage measured will depend on the RF LEVEL selected.

TABLE 5-9 AB1/1 RF PROCESSING BOARD ALIGNMENT (contd.)

Adjustment	Test equipment	Method	Adjustment window/Comments
'Cal. AM ≥62.5 MHz and (A2/2)R90 Correct det'	See A2/2 board alignment (Table 5-6)		
'Cal AM ≤62.5 MHz'	See A2/2 board alignment (Table 5-6)		

TABLE 5-10 ATTENUATOR ASSEMBLY ALIGNMENT

Adjustment	Test equipment	Method	Adjustment window/Comments
'CAL RF power'	Power meter	Select CARR FREQ, 15 MHz, 100, 200, 300, 400, 500, 600, 700, 800, 900 and 1000 MHz, RF LEVEL, 0 dBm. Adjust cal. data (using 2ND FUNCT 192) to give 0 dBm output.	No attempt should be made to adjust the frequency compensation screws on The attenuator assembly. Refer to factory.

External frequency standard adjustment (1, 5 or 10 MHz)

11. One of three external standard frequencies may be used providing a link on AA1/1 board is correctly positioned. Fig. 5-13 shows the position of the three link positions for 1, 5 or 10 MHz. Withdraw the link manually from the board (normally selected to 10 MHz) and reposition as required. On completion apply power and using 2ND FUNCT 10 record the current selection and STORE. Further check by selecting 2ND FUNCT 1 'Status' mode that the correct reading is evident in the modulation window.

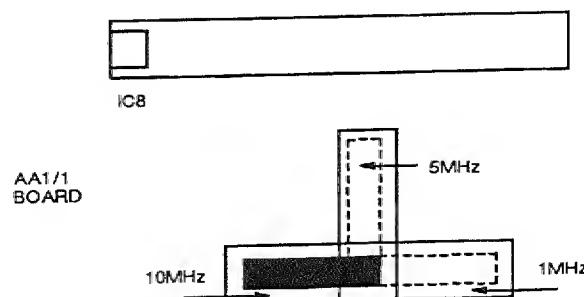


Fig. 5-13 External frequency standard adjustment (1, 5 or 10 MHz)

Chapter 5-3

FAULT LOCATION

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INTRODUCTION

1. This chapter deals with diagnostic procedures and tests to aid fault localization. Information is given in three groups:-

- (1) Fault finding to board level from front panel symptoms and error messages, followed by diagnostic charts for each functional area of the instrument.
- (2) Manual latch setting procedures for entering binary data to specified latches, allowing diagnosis of internal bus or latch faults.
- (3) Fault finding to component level, giving test data and procedures for each board.

2. The functions of each board are generally well defined and independent of each other as far as possible. The recommended method of confirming a board fault is to substitute a known good board (e.g. from a spare serviceable instrument). This can save considerable fault finding time.

3. Easily accessible test points are provided on the boards to allow you to quickly confirm that voltage rails are correct. These are simply solder pads with a central hole surrounded by a white circle. The nominal voltage expected at that point is also indicated as shown in Fig. 5-14.

4. Test equipment recommended for fault finding is listed in Chap. 5-0. Before carrying out any internal operations refer to Chap. 5-0 for safety considerations and access instructions.

FAULT FINDING TO BOARD LEVEL

5. The following section describes fault finding routines using tables which may be used to help diagnose faults down to board level. The fault finding routines start from a generalized fault condition and guide you to the most likely area of the fault. The generalized fault conditions used as a starting point are as follows:

- (a) Front panel failure
- (b) Output frequency error
- (c) Output RF level error
- (d) RPP failure
- (e) AM fault
- (f) FM/ΦM fault
- (g) Residual noise on carrier frequency
- (h) Excessive carrier harmonics
- (i) GPIB fault

17. The following boards are those that are concerned with the generation of the output frequency and could be at fault.

AA1/1	Synthesizer
AB1/2	RF signal processing
A2/2	Power supply/Control
AA2/1	Microprocessor

18. Before carrying out extensive tests on a board check the following connectors which could be at fault:

SKV - SKW	160 MHz sync from AB1/2 to AA1/1
SKY - SKZ	250-500 MHz sync from AB1/2 to AA1/1
PLAB	Microprocessor to synthesizer
PLM - PLAD	A2/2, Control to AB1/2

19. Signal frequency faults can be divided broadly into three categories:

- (1) RF signal processing - division, multiplication or mixing
- (2) Frequency synthesis
- (3) Variations in the reference frequency

Initially it is advisable to begin by checking the fundamental octave, 250-500 MHz. If this is not where the fault lies, suspect a category (1) fault.

20. **Box A (see Table 5-14) AB1/2 control lines.** Select and switch between the two carrier frequency settings shown in Table 5-15. Switching between the two should cause all four bits of data to change. If the frequency is not correct on the fundamental band suspect either the synthesizer or reference frequency standard, depending on the size of the error.

TABLE 5-15 AB1/2 CONTROL DATA

Selected frequency	A0 pin 6 (2nd brown lead)	A1/2 pin 11 (2nd red lead)	A2 pin 5 (White lead)	OSC HIGH pin 10 (2nd yellow lead)
10 MHz	0	1	1	0
200 MHz	1	0	0	1

21. **Box B (Size of frequency error).** With reference to box B, shown in Table 5-14, two selected frequencies, 471 MHz and 317.4 MHz, are called for. These are chosen such that only the four modulus divider IC9 on AA1/1 is in use. A "zero" error implies an error that is within the drift limit of the internal reference frequency measurement accuracy.

22. **Box C (Significant frequencies).** The two frequencies chosen here, 252.57365 and 382.3073 MHz, cause all of the frequency setting latch outputs to change state. First enter 252.5736 MHz and then use a 50 Hz positive increment. STORE this in location 02. Now enter 382.30730 MHz and STORE in location 03. If RECALL is now used the increment keys can be used to change rapidly between one setting and the other. The increment up key will require pressing each time RECALL 02 is used to set the last 3 bits in IC23 correctly.

TABLE 5-16 FREQUENCY LATCH SETTING DATA

Frequency	IC13	IC19	IC3	IC24	IC23
252.57365 MHz	011001	01	010101	010101	010101
382.3073 MHz	100110	10	101010	101010	101010
DATA BIT	D ₅ ----D ₀	D ₁ ----D ₀	D ₅ ----D ₀	D ₅ ----D ₀	D ₅ ----D ₀

6. Choose the description that most closely describes the fault condition and use the fault finding guide to establish the area of the fault. Before using the fault finding tables read the accompanying notes. The construction of the instrument is such that it should be possible to locate and correct all faults without resorting to special adapters or extender cables. Where board exchange is practised or where the repair to a board is such that recalibration may afterwards be required – see Chap. 5-2, Adjustment and Calibration.

Front panel failure

7. A chart to aid fault finding in this area is given in Table 5-11. A front panel failure is defined as a fault in which the keyboard or the information given on the LCD and LEDs is abnormal.

8. The fault is likely to be on one of three boards or the interconnections between these.

Suspect boards	Interconnections
AA2/1 Microprocessor	AA2/1 (PLAC) – A2/2 (PLL)
A2/2 Power supply & control	A2/2 (PLF) – Transformer T1
	A2/2 (PLH) – A0/1 power devices TR1,IC1
	A2/2 (PLK) – A1/2 (SKK)
A1/2 Keyboard & display board	A1/2 (SKK) – A2/2 (PLK)

Fig. 5-15 shows the format in which data is transferred between boards and Table 5-11 should assist in diagnosing which of the three boards is at fault. Generally information from the microprocessor is transmitted in serial form to A2/2. Here its format is modified to suit the device being controlled. The LCD drivers use a special format serial link whilst the keyboard and LEDs are controlled using a parallel bus.

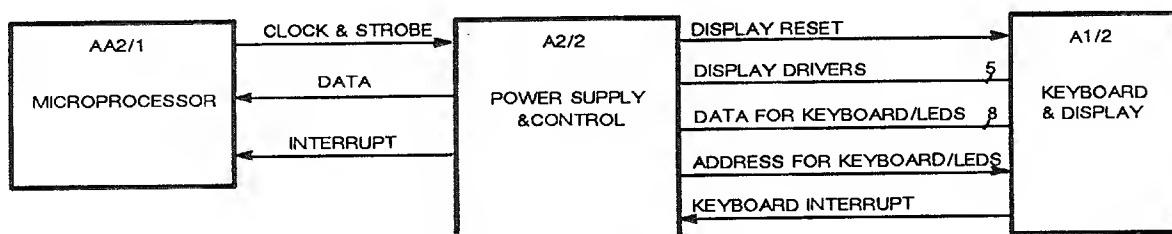


Fig. 5-15 Data transfer between boards

9. The microprocessor is interrupt driven, so that key presses need to cause an interrupt before the processor will take data from A2/2 to check the state of the keyboard. If the microprocessor is serviceable but a fault exists in the memory, then an error number may be displayed depending on the location of the fault. Error numbers are displayed in the carrier frequency window as shown below. Table 5-12 gives details of all available error numbers.

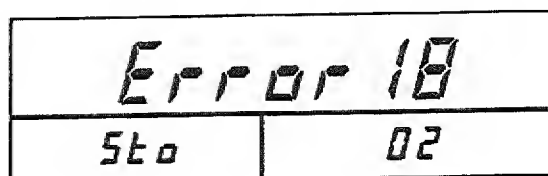


TABLE 5-12 ERROR MESSAGES (AA2/1)

Error No.	Error condition
01*	Request outside limits
02*	Incorrect key code sequence
03*	Too many digits
04*	Incorrect unit
05*	RPP trip
06	RAM check failure (IC12)
07	EAROM checksum failure (IC13)
08	EPROM checksum failure (IC7)
09*	External modulation outside ALC range (LOW)
10*	External modulation outside ALC range (HIGH)
11	External standard selected but not applied
12	External standard frequency not locking
13	Latch write error
14	EAROM write error
15	EAROM recall error
16	GPIB bus error
17	Unrecognized GPIB mnemonic/character
18	Attempt to write to protected store

* These error numbers refer to GPIB error conditions and therefore do not indicate on the front panel display.

10. **Error 06 RAM check failure.** This test is carried out by writing a series of '1's and '0's into the RAM - see para. 62 - and then reading them back.

Error 07 EAROM checksum failure. This is carried out by summing the calibration data and a checksum byte. If the result is not FF then error 07 will be displayed.

Error 08 EPROM check failure. This is similar to the EAROM check. Data that is stored in memory is also checked. If error 07 is displayed when a store is recalled it indicates that the stored data has been corrupted.

FM and Φ M faults

41. An FM fault finding guide is given in Table 5-19. (It is assumed that the fault cannot be rectified by simply recalibrating the instrument.) Frequency modulation at rates greater than 1 kHz is mainly derived by simply applying the signal to the VCO tuning line. A differentiator in the signal path creates phase modulation (6 dB/octave pre-emphasis). The deviation that is applied over the fundamental octave is scaled appropriately for the doubler and divider bands.

42. Angle modulation at low frequencies is achieved by introducing a phase modulator into the reference signal path of the synthesizer. By integrating the signal driving the phase modulator an equivalent of frequency modulation is then obtained.

43. The following boards and connectors are possibly connected with an FM or Φ M fault :

Suspect boards	Interconnections	
A2/2 Modulation control	A2/2 (PLM)	AB1/2 (SKAD) Signal from mod. control
AA1/1 Low freq. modulation source	A2/2 (PLL) -	AA1/1 (PLT) Mod. signal from AA1/1 to A2/2
AB1/2 FM and VCO drive	A2/2 (PLJ) -	Modulation in/out

44. **Box A (see Table 5-19) Error 7, EAROM checksum error.** First check that the reason for this display is not operator error (EAROM checksum not reset via 2ND FUNCT 195 after recalibration procedures). Information on the resetting of the EAROM checksum, if required, is given in Chap. 5-2, para. 9. Assuming that a fault is present it is most likely to be caused by corruption of data for some reason. As an aid to diagnosing a fault in the FM tracking store, Table 5-20 gives a list of carrier frequencies used as FM tracking points together with the typical values of FM tracking data. Normally instruments will be within approximately 20% of the values listed. There should be no abrupt changes in value except possibly where the oscillator ranges change over at 353 MHz.

45. In the course of fault finding it may be required to check the input and output levels of the various digital-to-analogue converters. This can best be carried out using a digital AC voltmeter and 2ND FUNCT 3 mode to access each IC as required. The latch address numbers are given both in Chap. 7 and in Table 5-4.

46. **Box B (FM level).** Set the carrier frequency to 250 MHz, FM 99.9 kHz. Use 2ND FUNCT 3 to set address 10 to '200'. Check that the signal on AB1/2 PLAD pin 12 (black wire) is 5.2 V p-p.

TABLE 5-20 TYPICAL FM TRACKING DATA

OSC 1		OSC 2	
Frequency	Data	Frequency	Data
250 MHz	194	353 MHz	125
254.12	204	358.88	132
258.24	212	364.76	137
262.36	218	370.64	141
266.48	221	376.52	143
270.60	223	382.40	144
274.72	223	388.28	144
278.84	222	394.16	143
282.96	219	400.04	141
287.08	215	405.92	139
291.20	211	411.80	136
295.32	207	417.68	133
299.44	202	423.56	130
303.56	197	429.44	128
307.68	193	435.32	125
311.80	189	441.20	123
315.92	186	447.08	121
320.04	184	452.96	120
324.16	182	458.84	119
328.28	181	464.72	118
332.40	180	470.60	118
336.52	180	476.48	119
340.64	182	482.36	120
344.76	183	488.24	122
348.88	185	494.12	124
352.9999	189	499.9999	127

47. **Box C (Frequency response).** Apply an external modulation of 1 V RMS at a frequency first of 1 kHz and then at 100 Hz. If there is a marked difference in the frequency response between the two then suspect the low frequency modulation path. An alternative method of checking the reference phase modulator is to examine the AC signal on the VCO tuning line AB1/2 PLAD pin 16 (red wire). If the FM tracking is set correctly there should be less than 5 mV p-p of the 1 kHz signal.

Note ...

The 1 kHz MOD IN/OUT output from 2022E can be used to trigger an oscilloscope enabling the above to be seen more easily.

48. **Box D (Excessive residual FM).** If excessive FM is present on the carrier frequency a higher than normal deviation can be expected. To check for residual noise set 0 Hz, FM and monitor the output of a low noise modulation meter (2305) set to measure FM. If noise is excessive follow the additional procedures given in Table 5-19, and para. 50.

49. **Box E (LF FM level fault).** Select a carrier frequency of 250 MHz and a deviation of 99.9 kHz. Check at AA1/1 PLT pin 10 (black wire) for a 1 kHz, 150 mV p-p signal.

50. **Box D (Residual noise on carrier frequency).** If excessive noise is present on the carrier frequency several possible sources must be considered. Initially check to ascertain which of the following is the problem source then carry out the necessary remedial action.

(1) **AM noise (carrier frequencies above 62.5 MHz).** Due to the action of the levelling loops it is unlikely that changes in amplitude of signals prior to the output amplifier will be transferred to the final signal. If it is found that the correction voltage on AB1/2 testpoint "ALC HF" (junction of IC15 pin 6 and R112) is noisy this is likely to be caused by disturbances on the reference level line. Use an oscilloscope to check the signal on AB1/2 PLAD pin 3 (green wire). With no AM applied it should be a DC level free from fluctuations. If not suspect the modulation control circuit on A2/2 board. To access this remove unit AB0 and retrace the modulation path from A2/2 PLM pin 3.

(2) **AM noise (carrier frequencies below 62.5 MHz).** The response of the levelling loop is extremely slow on this frequency range and because of this noise on the reference line AB1/2 PLAD pin 3 (green wire) will have less effect than noise on the AM drive line AB1/2 PLAD pin 5 (white wire). Check this for any fluctuations and retrace these to A2/2 board if necessary.

(3) **FM noise.** Check to establish first that the fault is common to carrier frequency selections of both above and below 62.5 MHz or confined to one range only. Ensure that the measuring instrument is not at fault.

Below 62.5 MHz only. Here the 160 MHz loop is suspect. If the frequency of the disturbance is comparatively high (above several hundred hertz), check AB1/2, 160 MHz VCO circuit particularly around TR1. Scintillation in the capacitors can cause an audio crackling noise. This can be checked by monitoring the 2305 LF output with a loudspeaker.

Above and below 62.5 MHz. With noise in this category it will be necessary to determine whether oscillators or the control signal is at fault. Selecting carrier frequencies of 352 and 354 MHz respectively will change from one oscillator to the other. This will indicate a fault on one or the other oscillator unit if either of these are faulty. Use of the MOD ON-OFF selection will switch AA1/1 phase modulator on and off. If the FM is set to 0 Hz, this is the next most likely cause. Also check AA1/1 PLT pin 10 (black wire) LF FM line. To check the performance of the modulator signal path select EXT MOD and a deviation of 99.9 kHz. If the noise increases use Second function 3 to control the gain of A2/2 IC20, (address 09 and 10), A2/2 IC11 (address 04) and A2/2 IC19 (address 07 and 08) until the noise level drops. The cause should then be apparent.

Note ...

Other inadequately screened instruments radiating magnetic fields at the line frequency can also be the cause of excessive hum components. If noise is present on both oscillators with the FM modulation off and there is no apparent noise on the FM line A2/2 PLM pin 12 (black wire) – look for 100 μ V or less (in the 50 Hz – 50 kHz bandwidth), suspect the loop error amplifier if this is excessive. Check the noise on the VCO TUNE A line at A2/2 SKM pin 16 (red wire); this should be approximately 1 mV p-p. Measurement bandwidth is unimportant in this case.

Excessive carrier harmonics

51. If the harmonics are found to be in excess of the specification suspect AB1/2 RF processing board. Check the instrument and establish which carrier frequency range is at fault then carry out the remedial action suggested below.

52. **Carrier frequencies up to 62.5 MHz.** The harmonic level for these frequencies are determined by three factors :

- (1) The performance of fixed filters made up of printed circuit inductors and ceramic plate capacitors.
- (2) The drive levels to the mixer that creates the BFO signal.
- (3) The linearity of the BFO output amplifier. Of the three, (2) or (3) are most likely to be the cause of the problem.

53. Basic operation of the mixer drive may be checked by measuring the voltages on the two following test points :

AB1/2 'ALC DOUBLER' (adjacent to IC12a), should be 4 V \pm 0.25 V.
 'ALC LF' (adjacent to R13) with a 50 Ω load connected should be as follows :

6.5 V - 7.5 V at a level of -10 dBm and
 6 V - 7.5 V at a level of 0 dBm.

Notes ...

- (1) When monitoring the 'ALC DOUBLER' voltage, some variation of voltage will be observed across the frequency band.
- (2) Poor alignment of the LF AM MOD tuning capacitor C18 may also be a cause of a voltage abnormality on the 'ALC LF' test point.

54. Fault finding on the two stage output amplifier should be simple with each stage being independently biased. R133 and R138,139 are present to prevent ultra high frequency oscillations which would otherwise give misleading results. Voltages expected are +3.1 V at TR14 collector, and +6.5 V at TR17 collector. C160 may be disconnected if required allowing for the injection of a test signal to be applied through the amplifier.

55. **Carrier frequencies from 62.5 MHz to 250 MHz.** The factors that influence the harmonic content for this frequency range are the following :

- (1) Signal divider output balance
- (2) Fixed LC filters
- (3) Linearity of output amplifiers

Of the three (1) or (3) are the most likely cause of the problem. The second harmonic performance for the half octaves 62.5 MHz - 88.25 MHz and 125 MHz - 176 MHz are determined by the balancing of the Q and \bar{Q} outputs of AB1/2, IC11. The signal quality may be checked before reaching the output amplifier by connecting a 500 Ω oscilloscope probe across C60.

56. A self biasing arrangement, designed to maintain maximum sensitivity of the divider, should result in a voltage of approximately +3.6 V on AB1/2 IC11 pins 6 and 11. The output amplifier levelling loop should be +11.5 V to +12.5 V at 0 dBm with a 50 Ω load connected. (Note that D42 and D43 are matched devices). A test signal can be injected by disconnecting one side of C102 at the junction of R92. Apply the signal to C102, via AC coupling and at a level of 0 dBm.

57. **Carrier frequencies from 250 MHz – 500 MHz.** This frequency range is derived from the fundamental oscillators and uses a combination of a tracking notch filter and a fixed low-pass filter. Generally the second harmonic that reaches the output amplifier is low enough so that the amplifier distortion is what is actually seen at the output. The notch provides cover for the half octave 250 – 353 MHz. Use is made of the same data as that obtained for the band pass filter. To ensure correct tracking L13 (wire loop) is mechanically adjusted to cancel the second harmonic at 250 MHz. If the output amplifier is suspected carry out the checks given in the previous paragraph.

58. **Carrier frequencies from 500 – 1010 MHz.** This doubler range uses a voltage tuned band-pass filter to reject unwanted components. No mechanical adjustment exists for this filter; it relies on the approximate tracking of D34 – D37 varactor diodes although this tracking is not critical. The drive voltage is obtained by interpolating between points that are found by looking for the minimum insertion loss of the filter. The table below gives an approximation of the voltage that should be present on AB1/2 PLAD pin 15 (yellow wire).

**TABLE 5-21 TYPICAL CALIBRATION DATA AND DRIVE VOLTAGES
BAND-PASS FILTER**

Carrier frequency (MHz)	Drive voltage (AB1/2, PLAD, pin 15)	Calibration data
500 (250)	5 V	40
600 (300)	8 V	64
700 (350)	10.5 V	80
800 (400)	13.5 V	110
900 (450)	17.5 V	140
1000 (499.9)	23.0 V	180

Note ...

At higher power levels (above 0 dBm) where the harmonic distortion may rise above -30 dBc, the output level may be affected due to the peak detecting used to level the signal. This will not normally be significant but unexpected changes of level will result if additional capacitive loading is applied, especially to the output pin of IC14.

GPIB faults

59. Few checks are necessary on this board apart from the clock waveform on IC1 pin 8. The frequency here (although not critical) should be typically 1.2 MHz. If there is no response from the instrument to a GPIB command first ensure that the address that data is sent to corresponds to that held by the instrument. Second function 2 may be used for this. Also check the 'INT REQ' line on AD1. This should change from 'LO' to 'HI' temporarily when the instrument is addressed.

60. If the instrument acknowledges the presence of the board AD1, and it is possible to change the address, it is likely that IC2 is serviceable.

61. To check that data is transferred from the GPIB cable to IC2 use a logic probe to check that all data lines toggle when different data is sent over the bus. IC2 pin 26 will be 'low' whilst waiting for data.

MANUAL LATCH SETTING (Use of 2nd function 3)

62. This unprotected second function control allows you to enter data to any specified latch directly (with the exception of the LCDs on keyboard A1/2 which has an alternative second function control of its own). The data will remain valid until the manual latch addressing mode is terminated by pressing one of the main function keys. Then all normal latch data will be reinstated. See also Chap. 4 'Second function operations' for further details of 2ND FUNCT 3. Each latch is identified on the circuit diagram with an address number e.g. [03], [05] etc. See Table 5-11 for details of all available address numbers and latch descriptions. Two formats must be considered : 6-bit data and 8-bit data.

Data entry (6 and 8-bit)

63. **6-bit data.** Having determined from the circuit diagram that the latch of interest to be addressed has 6 bits, data in the form of ones or zeros should be entered until six segments of the frequency display are occupied. To do this select 2ND FUNCT '3' then, using the keyboard controls, select the required address. Data presented on the frequency display will be that which is addressed to the latch at the present time.

64. The required data can now be entered (until six segments of the frequency display are occupied). This is entered from the right and the most significant bit is displayed on the left,

i.e. D₅ D₄ D₃ D₂ D₁ D₀

Pressing the 'STORE' key will cause the data to be set into the appropriate latch; all five decimal points will be displayed briefly to indicate that the data has been accepted.

Note ...

If a read only latch has been selected by mistake Error 13 'Latch write error' will be displayed.

65. **8-bit data.** To enter data in this format each bit is assigned a binary weighting according to its position. The sum of all eight bits is taken and entered. Procedure for entering data is as described in the previous paragraph and pressing the 'STORE' key causes the latch to be set.

66. **Data entry.** 'RF level calibration' and 'RF level' require 12 bits, so a high byte and a low byte must be entered. (Only the 4 lower bits of the high byte are significant).

- 6-bit addresses 00, 02-06, 33-37 inclusive
- 8-bit addresses 07-30, 01 inclusive
- Read addresses 02, 03, 25-32 inclusive
- Write addresses 00, 01, 04-24, 33-37 inclusive

8-bit data is entered in decimal notation, whilst 6-bit is in binary

e.g.	D ₀	1	D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀
	D ₁	2	1	0	0	1	1	0	1	1
	D ₂	4	128 + 0 + 0 + 16 + 8 + 0 + 2 + 1							
	D ₃	8								
	D ₄	16				Enter 155				
	D ₅	32								
	D ₆	64								
	D ₇	128								

67. The LED latch, IC4 on A1/2 board, may be conveniently used to illustrate the procedure. The latch address is [01], therefore key in the following:-

2ND FUNCT, 3,0,1,1,6,9, STORE	D7	D6	D5	D4	D3	D2	D1	D0							
	1	0	1	0	1	0	0	1							
	128	+	0	+	32	+	0	+	8	+	0	+	0	+	1

The following LEDs will then be lit

D7 2ND FUNCT

D₅ AMD₃ CARR FREQ
$$D_0 \Delta$$

68. **Second function 3 application.** The facility is an invaluable aid when you wish to assess latch serviceability and/or its data outputs. Connect a storage oscilloscope whose trigger input is connected to the address line and monitor the data lines as they reach first the latch inputs, and then the latch outputs. This will show if the latch is operating correctly.

Notes ...

- (1) A separate second function control (Second function 6) is available to check the LCD when required, therefore A1/2, IC1, IC2 cannot be written manually.
- (2) Writing arbitrary data to A1/2, address [00] could lock out the operator. Users with GPIB control however can write to the latch without hindrance.
- (3) Writing arbitrary data to addresses [01] - [05] (GPIB write registers) may affect GPIB operation if in use. It is therefore preferable to carry out this operation from the keyboard.

TABLE 5-22 2022E LATCH ADDRESSES

2ND FUNCT 3 Address No.	Latch description	Location IC No.	Board	Circuit diagram reference
00	Keyboard row set and LED driver	3	A1/2	7-3
01	Front panel LED driver	4	A1/2	7-3
02	READ keyboard column	5	A1/2	7-3
03	READ interrupts	13	A2/2	7-4
04	Select modulation function	11	A2/2	7-4
05	Attenuator pads	22	A2/2	7-4
06	RF range	25	A2/2	7-4
07	Fine modulation	19A	A2/2	7-4
08	Coarse modulation	19B	A2/2	7-4
09	LF FM extension	20A	A2/2	7-4
10	FM tracking	20B	A2/2	7-4
11	Jitter correction	27A	A2/2	7-4
12	Voltage tuned filters	27B	A2/2	7-4
13	RF level calibration low byte	24A	A2/2	7-4
14	RF level calibration high nibble	24A	A2/2	7-4
15	RF level low byte	24B	A2/2	7-4
16	RF level high nibble	24B	A2/2	7-4
17	GPIOB register WRITE	2	AD0	7-10
18			AD0	7-10
19			AD0	7-10
20			AD0	7-10
21			AD0	7-10
22			AD0	7-10
23			AD0	7-10
24			AD0	7-10
25	GPIOB register READ		AD0	7-10
26			AD0	7-10
27			AD0	7-10
28			AD0	7-10
29			AD0	7-10
30			AD0	7-10
31			AD0	7-10
32			AD0	7-10
33	10 Hz positive increments	23	AA1/1	7-6
34	640 Hz positive increments	24	AA1/1	7-6
35	Mod. control and -2.56 MHz increments	19	AA1/1	7-6
36	10.24 MHz positive increments	13	AA1/1	7-6
37	40 kHz negative increments	3	AA1/1	7-6

FAULT FINDING TO COMPONENT LEVEL

69. Assuming that the fault finding tables have been used to localize a fault, it is likely that the general location will be known. This section therefore gives guidance to allow individual component failures to be located. Information on each of the boards is given as follows:-

70. A1/2 Display and keyboard

Keyboard - Row set latch, column read buffer
LED displays - Driver latches
LCD - Voltage references, LCD drivers, Latch addresses.

71. A2/2 Power supply and control

Power supplies - +5 V, +12 V, -12 V, +24 V
Modulation - ALC, mod. control, RF level/square law correction
Serial - parallel conversion
Interrupt control
Filter tuning drive
Jitter correction drive
Attenuation drive and reverse power sensing
Latch addresses, A2/2.

72. AA1/1 Synthesizer

160 MHz loop
Internal/External standard locking
Internal mod. source - oscillator and switch
Synthesizer frequency errors
250 - 500 MHz loop - Four modulus divider, presettable divider,
fractional N and correction
40 kHz Phase detector and error amplifier
Phase modulator.

73. AA2/1 Microprocessor

+21 V EAROM supply
Parallel-serial conversion
Synthesizer drive latches
Clock divider

Microprocessor system.

74. AB1/2 RF processing board

160 MHz oscillator
160 MHz modulator
BFO mixer
BFO output amplifier and levelling loop
250-500 MHz oscillators
Signal dividers (two stage)
Mixer driver/doubler drive and levelling loop
Signal doubler and band-pass filter
62.5-1010 MHz output amplifier and levelling loop
Control logic states.

Display and keyboard (A1/2)

75. **Row latch IC3.** A positive-going transition on IC3, pin 9 will cause data present on inputs D0–D5 to be transferred to outputs Q0–Q5. Outputs will normally be logic 'low'. Use second function 3 and a storage oscilloscope to monitor the operation. Modulation lights D15–D17 are controlled via bits 6 and 7 of this latch. The LEDs are selected as shown below:–

TABLE 5-22a

IC3		LED status		
D6	D7	D15	D16	D17
0	0	OFF	OFF	OFF
0	1	ON	OFF	OFF
1	0	OFF	ON	OFF
1	1	OFF	OFF	ON

76. **Column read buffer IC5.** When a key is pressed the output of that particular column line will go to logic 'high' for approximately 1.5 ms every 6 ms. The column input should remain 'low' for the duration of the key press after the initial key search is complete.

77. **LCD reference voltages and driver waveforms.** LCD references voltages are generated by TR1 and should be as follows :

TR1 collector +0.8 V	}	All LCD segments may appear on if these voltages are low
R6,R7 junction +2.9V		

The LCD driver waveforms, a nominal 130 – 150 kHz square wave, can be checked on the lower end of R8. Once display initializing is complete the reset line should be set at logic 'high'. Short circuiting this line to earth will blank the display.

78. Backplane drive waveforms can be conveniently checked with reference to Fig. 5-16. The amplitude of the backplane segment waveform is determined by the setting of R2 'SET LCD OFF VOLTAGE'. The period of the square waves should be either 12.5 or 25 ms and the combination of their frequency and phase with respect to the backplane determines the state of the display. See Chapter 4, Technical Description, for further details.

Note ...

The sequence of data that has to be sent to IC1, IC2 is quite complex, therefore it is not practicable to drive the board from other than the instrument's own micro-processor and control circuit.



Address Number	Description	D ₀	D ₁	D ₂	D ₃	D ₄	D ₅	D ₆	D ₇
[00] IC3	Keyboard Row setting	Δ, AM, 8, 3, INT/EXT, RETURN	STORE, RF LEVEL, 5, -, +, MOD ON-OFF	RECALL, 7, 2, MHz, V, TOTAL Δ	MOD ALC, 4, ., kHz, mV, +,	CARR FREQ, 1, 9, Hz, μV, 2ND FUNCT	FM, φM, 0, 6, % rad dB, CARR ON-OFF,	See Table 5-22a	
	Outputs	Pin 2	Pin 5	Pin 7	Pin 10	Pin 12	Pin 15		
[01] IC4	LED driver	Δ	RECALL	MOD ALC	CARR FREQ	FM/φM	AM	RF LEVEL	2ND FUNCT
	Outputs	Pin 2	Pin 5	Pin 6	Pin 9	Pin 12	Pin 15	Pin 16	Pin 19
[02] IC5	Column Read								
	Outputs	Pin 3	Pin 5	Pin 7	Pin 9	Pin 11	Pin 13	X	X

Power supplies, Modulation control and Data conversion (A2/2)

81. Check that the following supplies are present :

+5 V supply - Requires ± 12 V supplies to operate

Collector A0T1	-	10 - 11 V (with no loads)
IC3 pin 7	-	+11.5 V
IC3 pin 1	-	+6.25 V (with no loads)
R12,R13 junction	-	+5 V

± 12 V supplies - These have an internal reference of approximately 1.25 V which can be measured between the ADJ and V OUT pins.

C9 +ve	-	+10.75 V
C7 -ve	-	-10.75 V

+24 V supply - Uses a capacitive doubler

C6 +ve	-	+50 V
C8 +ve	-	+22.8 V

82. **Modulation ALC.** TR7 acts as a voltage dependent resistor which changes the gain of non-inverting stage IC15a. IC15b is an error amplifier. IC18a,b are out of limit comparators. Select 99.9 kHz FM, EXT. Apply 1 V RMS, 1 kHz to the MOD IN/OUT socket and select MOD ALC, OFF. The following voltages should then be checked :

IC15a pin 5	-	2.8 V p-p	IC15 pin 8	-	-6 V
IC15a pin 7	-	10 V p-p	IC18 pin 7	-	-2.4 V
D14 cathode	-	+4.2 V	TR7 drain	-	0.56 p-p

Select MOD ALC ON and, using a 10 M Ω probe, check at D14 cathode for 20 mV p-p ripple at 1 kHz. IC15 pin 8, typically -3.5 V, will vary depending on the performance of TR7. When voltage goes negative, the stage gain of IC15a reduces.

83. **Modulation control path.** Three dual, digital-to-analogue converters are used here, IC19, IC20 and IC24. Select CARR FREQ, 200 MHz, FM INT, 99.9 kHz. Using 2ND FUNCT 3 enter 200 into latch address 10 and check the following voltages.

IC15 pin 1	-	7.8 V p-p
IC15 pin 14	-	3.7 V p-p
IC16 pin 8	-	6.6 V p-p
IC17 pin 7	-	4.5 V p-p
IC17 pin 1	-	190 mV p-p
IC21 pin 1	-	5.3 V p-p (short circuit pin 3 to ground)

Using 2ND FUNCT 3 again, enter 1000001 into latch address 04. This brings IC16a differentiator into circuit. The voltage at IC16a pin 8 should not change but there may be high frequency noise on the signal. This will confirm the correct operation of the angle modulation path.

84. RF level/AM signal path. With no modulation selected, set latch address 13 to 100 and latch 15 to 200, then check the following voltages :

IC16 pin 7	-	+1.6 V
IC21 pin 7	-	0 V
IC16 pin 14	-	-0.87 V
IC16 pin 1	-	+1.91 V
IC27 pin 13	-	+1.24 V
IC27 pin 10	-	+1.13 V

The voltage on PLM pin 3 is that derived on IC27 pin 10, divided down by R91/R92, and assumes that AB1/2 is not connected. If it is, then a further drop in voltage can be expected due to the additional loading. Set latch 14 to 10 and check that IC16 pin 1 is +0.625 V and IC27 pin 10 is +40 mV.

85. If the square law correction circuit around IC27 is operating, set latch 13 to 10. The voltage at IC27 pin 10 will be less than 1/20th of the reading than with the latch set to 200, as shown in Fig. 5-17.

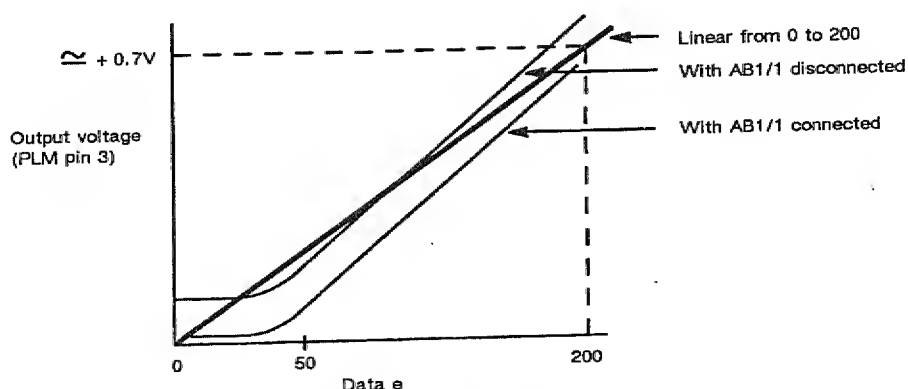


Fig. 5-17 Effect of square-law correction circuit A2/2

86. Select CARR FREQ 10 MHz, INT MOD 80%, RF LEVEL 0 dBm. Enter 200 into latch address 07 and check the following AC voltages.

IC14 pin 4	-	4.8 V p-p
IC16 pin 7	-	2.4 V p-p
IC21 pin 7	-	10.8 V p-p
IC16 pin 14	-	1.3 V p-p
IC27 pin 10	-	1.6 V p-p

If the waveform at PLM pin 3 is seen to be distorted when applying higher percentages of AM at a level of -10 dBm, this effectively confirms the operation of the square law correction circuit and is quite normal.

87. Serial to parallel conversion. Description of the data format and how it is transmitted over the serial bus is described in Chapter 4, Technical Description. However it may not be practicable to monitor the data flow directly unless a fast storage system is available.

88. The most convenient way to check individual shift registers is to look for changes of state on the outputs corresponding to data being clocked in and strobed. Since any key press will require the interrogation of the keyboard by AA2/1 microprocessor, it should be apparent that activity exists. IC5, IC7 and IC9 control the serial to parallel conversion while IC10 decodes 4 address lines to provide chip enables for individual latches. The outputs of this are normally logic 'high' level.

89. When any key is pressed a 10 μ s pulse should be seen on IC4c. When function keys are pressed, pulses should also be seen on IC6 pin 3 and IC8 pin 3.

90. **Interrupt control.** Pressing a key should cause an interrupt on the RST 7.5 INTERRUPT line of AA2/1 PLAC pin 3 and also the following activity on A2/2.

- IC6 pin 12 - Normally 'high' going 'low' for the duration of the key press.
- IC6 pin 11 - (AND gate) goes 'low'
- IC12 pin 11 - Goes 'high'.

The remainder of IC12 is used to control the routing for other interrupts. Pins 1 and 2 are normally 'high', pin 1 going 'low' if EXT MOD, ALC ON is selected but with no modulation source applied. IC12 pin 3 then goes 'high' and pin 4 'low', pin 6 should also have been set to 'high' via IC11 pin 10. The RPP TRIPPED line should be 'high' allowing IC12 pin 10 to go 'high'. This is inverted and fed to IC12 pin 13.

91. **Filter tuning drive.** IC23B controls the DC level on TR13 collector. Enter data into latch address 12. Output voltage should increase linearly with data magnitude and reach +23 V at least (possibly before the maximum data point 255 is reached).

92. **Jitter correction voltage.** The voltage on IC17 pin 8 should vary inversely with frequency. Set CARR FREQ 250 MHz and check the voltage at IC17 pin 8, which should read approximately -4 V. The voltage should decrease in magnitude as the carrier frequency is decreased until at 499 MHz the voltage is approximately -2 V.

93. **Attenuator drive and Reverse power sensing.** The following checks may be carried out with the attenuator unit out of circuit. IC22 outputs should go 'low' (<1 V) providing the base current for transistors TR8 - TR1 and the collectors should rise to almost the supply rail (+5 V). IC18c and IC18d compare the voltages on pins 10 and 13 with those on pin 9 (+40 mV) and pin 12 (-40 mV). Outputs will normally be low (-10.5 V). Application of a voltage above or below ± 40 mV should turn TR16 off and the voltage on R103 should then fall from virtually +5 V to 0 V.

Power supply/Control latch address data

94. The control data for A2/2 is shown in the table below.

TABLE 5-24 POWER SUPPLY/CONTROL LATCH ADDRESS DATA

Address Number	Description	D ₀	D ₁	D ₂	D ₃	D ₄	D ₅	D ₆	D ₇
[03] IC13	Interrupt READ	MOD LEVEL LOW	MOD LEVEL HIGH	RPP	KEYBOARD	GP1B	CHECK IC11 PIN 10	X	X
	Outputs	Pin 3	Pin 5	Pin 7	Pin 9	Pin 1	Pin 13		
[04] IC11	Function setting	INT MOD	AM ON	MOD ALC OFF	INTERRUPT ENABLE	FM >10 kHz	FM ON	X	X
	Outputs	Pin 2	Pin 5	Pin 7	Pin 10	Pin 12	Pin 15		
Address Number	Description	D ₀	D ₁	D ₂	D ₃	D ₄	D ₅	D ₆	D ₇
[05] IC22	Attenuator Drive						RPP RESET		
	0 dB	1	1	1	1	1			
	10 dB	1	1	1	0	1			
	20 dB	1	0	1	1	1			
	30 dB	1	1	1	1	0			
	40 dB	1	1	1	0	0			
	50 dB	1	0	1	1	0			
	60 dB	0	1	1	1	0			
	70 dB	0	1	1	0	0			
	80 dB	0	0	1	1	0			
	90 dB	0	1	0	1	0			
	100 dB	0	1	0	0	0			
	110 dB	0	0	0	1	0		X	X
	120 dB	0	0	0	0	0			
Outputs		Pin 2	Pin 5	Pin 7	Pin 10	Pin 12	Pin 15		

TABLE 5-24 POWER SUPPLY/CONTROL LATCH ADDRESS DATA (continued)

[06] IC25	RF control, and LCD reset					LCD RESET	X	X	X
	10 kHz-16.5 MHz	0	1	1	0				
	16.5-62.5 MHz	0	1	1	1				
	62.5-88.25 MHz	0	0	0	0	A "HIGH"			
	88.25-125 MHz	0	0	0	1	LEVEL			
	125-176.5 MHz	1	0	0	0	WILL			
	176.5-250 MHz	1	0	0	1	BLANK			
	250-353 MHz	1	1	0	0	THE			
	353-500 MHz	1	1	0	1	DISPLAY			
	500-706 MHz	0	1	0	0				
	706-1010MHz	0	1	0	1				
	Outputs	Pin 2	Pin 5	Pin 7	Pin 10	Pin 12			
[07] IC19(A)	Modulation level control AM	Is loaded with a calibration value of data							
	FM Deviation 0 - 249 250 - 499 500 - 999 1000 - 1999 2000 - 3999 4000 - 7999	A number proportional to the peak deviation requested is entered Deviation Deviation +2 Deviation +5 +8 +16 +32							
[08] IC19(B)	Modulation level control AM	Is loaded with a number equal to twice the depth requested (to the nearest 0.5%) Deviation (0 - 999) - setting of 07 latch							
	FM deviation	0 - 249	250 - 499	500 - 999	1000-1999	2000-3999	4000-7999		
	10 kHz-62.5 MHz	6	12	30	60	120	240		
	62.5-125 MHz	12	24	60	120	240	-		
	125-250 MHz	24	48	120	240	-	-		
	250-500 MHz	48	96	240	-	-	-		
	500-1000 MHz	24	48	120	-	-	-		
[09] IC20(A)	LF FM extension	Loaded with the eight most significant bits of the synthesizer frequency (when expressed as a binary number).							
[10] IC20(B)	FM calibration	Loaded with calibration data that is used to track the FM sensitivity curves of the oscillators. See Table 15.							
[11] IC27(B)	Jitter correction	Loaded with the eight most significant bits of the synthesizer frequency (when expressed as a binary number).							
[12] IC27(B)	Filter tracking	Loaded with data interpolated from calibration points to tune the band-pass filter and notch filter. Data ranges typically from 60 to 250.							
IC28(A) [13] [14]	RF level calibration	Entered with data interpolated from calibration points across the band, for a given frequency the value entered is multiplied by $\sqrt{10}$ when the output level is above +3 dBm.							
IC28(B) [15] [16]	RF level	A number proportional to RF level is entered.							

Frequency synthesizer and internal modulation source (AA1/1)

95. 160 MHz loop. Check that a 160 MHz signal is present at the junction of R2/C1. A signal within the range -20 dBm to 0 dBm should be sufficient to ensure correct divider operation, a greater or lesser signal will be likely to produce a fault condition. Expected voltages of this stage and the timing sequence of signals are given below. Figure 5-18 shows idealized timing waveforms around IC6. In practice delays are only those of TTL gates and the narrower pulses will not be seen to actually reach 0 V or +5 V.

- IC6 pin 3 (10 MHz) - 3 V p-p or greater, an approximate square wave
- IC6 pin 11 (10 MHz) - From internal standard, 3 V p-p or greater
- IC6 pin 5 (10 MHz) - Negative-going pulses from TTL 'high'
- IC6 pin 8 (10 MHz) - Positive-going pulses from TTL 'low'
- TR1, TR2 collectors - nominally +12 V

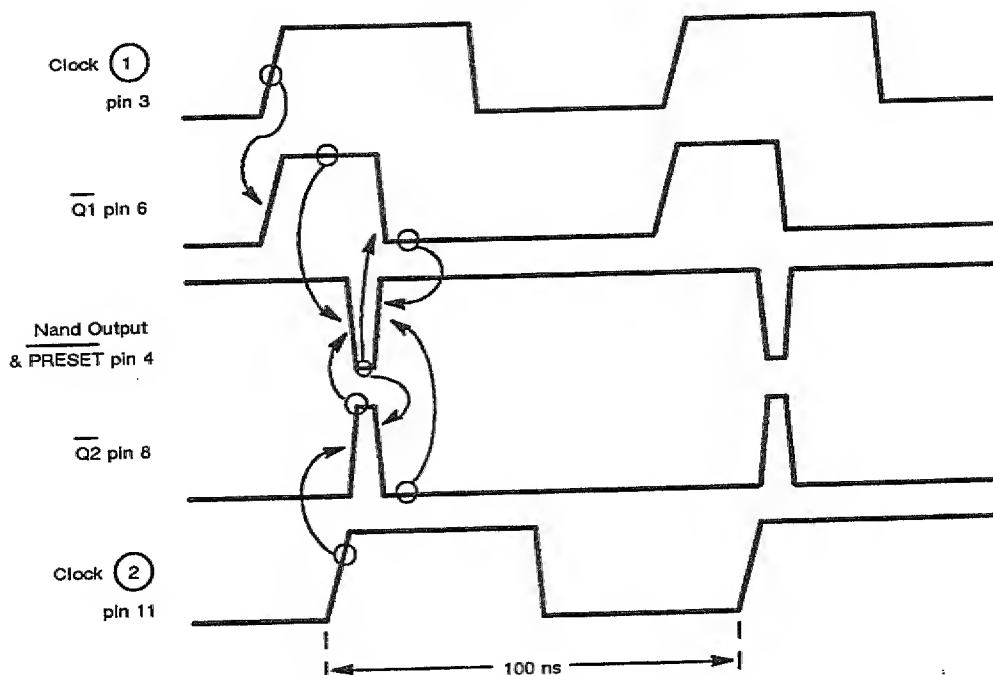


Fig. 5-18 160 MHz phase detector IC6, timing signals

96. **Internal/External frequency standard.** Apply an external frequency standard of 1.5 or 10 MHz. Ensure that the internal link from IC8 to IC7 is set for the frequency standard in use. Select 2022E to CARR FREQ, EXT and check the following:-

- IC34 pin 3 - Squarewave, equal to the frequency standard
- IC12 pin 1 - +10 V; indicates that the amplitude of the external standard is sufficient
Error No. 11 should show on the display if this voltage is low
- IC2 pin 3 - Inverted version of IC34 pin 3 waveform.

97. Waveforms similar to those shown in Fig. 5-19 should be seen in the proximity of IC7. The voltage present on TR3, TR4 collectors will depend on the difference between the internal and external frequency standards.

- IC12 pins 7,8 - -10 V
- IC12 pin 6 - +10 V
- IC12 pin 10 - +0.9 V

If an error is detected by the microprocessor, AA2/1, it will continually select and deselect the external standard. IC2, pin 2, therefore will be continually taken 'high' and 'low' with a repetition time of approximately 250 ms.

98. **Internal modulation source.** Select AM, INT, 1 kHz, MOD ON, from the front panel and check for the following :

IC35 pin 7	-	-5.4 V
IC35 pin 9	-	TTL 'HIGH'
IC35 pin 10	-	TTL 'LOW'
D16 cathode	-	3.2 V
IC36(a) pin 1	-	0.7 V pk-pk 1 kHz sine wave
IC36(c) pin 8	-	2.9 V pk-pk 1 kHz sine wave

Checking other frequencies – check CMOS switch operation :

Modulation rate	IC35	
	Pin 9	Pin 10
400 Hz	LOW	HIGH
5 kHz	HIGH	HIGH

In all cases the level at D16, IC36(a), IC36(c), IC35 pin 7 should remain constant.

99. **Synthesizer frequency errors (AA1/1).** If a frequency error has been traced to AA1/1 board then the information following should enable the fault to be identified. Frequencies selected for testing should be restricted to the fundamental octave of the synthesizer (250 – 500 MHz).

100. **Frequency errors less than 40 kHz.** Errors in this range are likely to be caused by a fault in the 'Fractional N' system. Check the following :

IC23	-	12-bit data latch
IC24	-	" " "
IC25	-	12-bit adder
IC26	-	" "
IC27	-	" "
IC29	-	8-bit adder. Sums 8 most significant bits of IC25-27
IC30	-	with 9610 (to cause accumulator to overflow at 400010)
IC31	-	12-bit latch
IC32	-	" "
IC33	-	Digital-to-analogue converter operating with 8 most significant bits of the accumulator output
TR9/10	-	Voltage controlled delay 2-4 ns.

101. Set the CARR FREQ to 250 MHz and using the Δ facility increment the frequency by 10 Hz. Bit D₀ of IC23 will be set and the accumulator formed by IC23-27, IC29-32, will continually count up to 4000₁₀ and then reset. The repetition rate will be 10 Hz with one 10 Hz increment applied.

IC33 pin 5	-	-4 V DC. Varies inversely with carrier frequencies between 250-500 MHz.
IC12 pin 14	-	Staircase waveform comprising 256 steps with a 100 ms period, 4 V p-p amplitude, giving the appearance of a positive-going ramp.

- IC32 pin 9 - TTL waveform, normally logic 'high', going low to IC31 pin 9 reset counters etc. very briefly.
- TR9 base - Narrow negative-going pulses with a 25 μ s period.
- TR9 collector - Narrow positive-going pulses with a 25 μ s period.
- Positive $\frac{dV}{dt}$ approximately 5 V in 100 ns. The loading of an oscilloscope probe will affect this slightly.
- TR10 collector - Short positive-going pulses with a 25 μ s period.

102. Waveforms at key locations within the synthesizer can be seen using the Q output of IC11b to synchronize the oscilloscope.

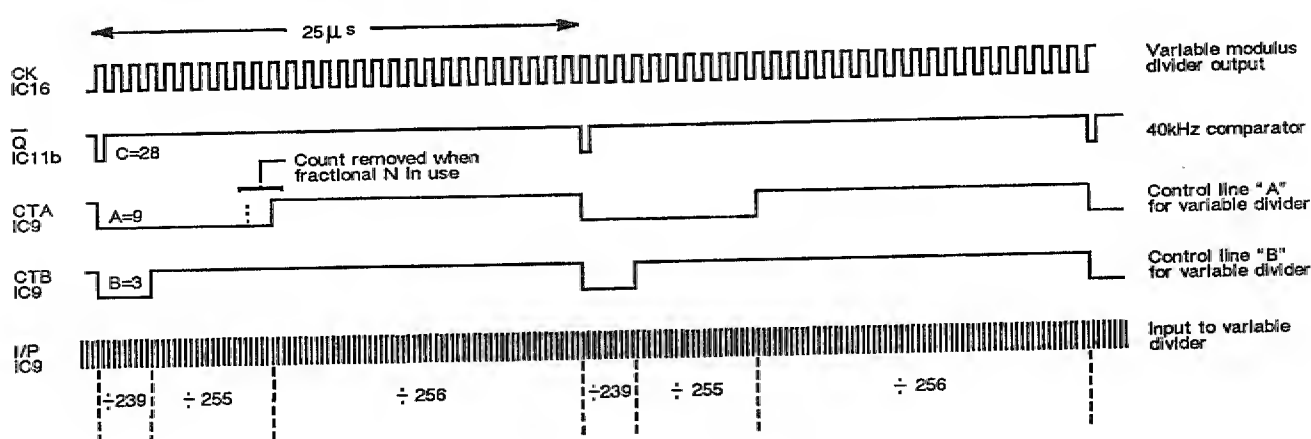


Fig. 5-19 Synthesizer drive and control waveforms

The following example shows how the synthesized frequency (fractional N component, <40 kHz steps, excluded) is derived

$$F_s = (239 \times 3 + 255 \times 7 + 256 \times 18) \times 40 \text{ kHz} \\ = 284.4 \text{ MHz}$$

Note ...

The frequency of the clock waveform to IC16 will change as the division ratio changes.

103. Frequency errors between 40 kHz and 10.24 MHz. The most likely cause of faults in this area is the four modulus divider. The following devices should be checked

- IC9 - 4 modulus divider and inverter.
- IC10c - " " " "
- IC3 - 8-bit data latch. Only the two least significant bits are used from IC19. Binary multiples of 40 kHz.
- IC19
- IC4 - 4-bit down counters. These control the length of time
- IC5 - IC9 divides by a particular number.
- IC10a,b - Allows modification of division ratio; enables the
- IC11a - introduction of the fractional N component

104. Select CARR FREQ, 327.67999 MHz and using Δ facility, decrement by 10 Hz. IC9 should then be dividing by 256 for most of the time (every 100 ms it will divide by 255). Check also IC10 pin 8 for a square wave with a frequency of 1.28 MHz. Voltage swing should satisfy normal TTL requirements.

105. At frequencies other than multiples of 10.24 MHz (with a negative offset of less than 40 kHz), dividers, IC4 and IC5 will be active. If these malfunction it is possible that the loop will not respond fast enough to give a stable output from IC10. To overcome this introduce each one separately :

Set CARR FREQ to 327.60 MHz
IC4 pin 12 - 25 μ s repetition rate. Mark space ratio 31:1
IC10 pin 6 - 25 μ s period. Mark space ratio 30:2

As further 40 kHz decrements are introduced the voltage will remain 'low' for one more $\frac{25}{32}$ μ s period in both cases

Set CARR FREQ to 327 MHz
IC5 pin 12 - 25 μ s repetition rate. Mark space ratio 31:1

Now as additional frequency decrements of 640 kHz are introduced, the waveform should remain 'low' for additional $\frac{25}{32}$ μ s periods.

Note ...

A ripple with a frequency of 1.28 MHz may be seen on the waveforms. Providing the magnitude of this does not affect the TTL 'high' or 'low' levels this is not significant and can be ignored.

106. **Frequency errors of 10.24 MHz or greater.** Frequency errors caused by AB1/2 board are considered to have been dismissed as a possibility which then limits the fault to dividers IC16, IC17 and their associated components.

IC13	6-bit data latch. Data is in the form of 10.24 MHz multiples.
IC16	} Connected as a presettable counter. Normal range of division ratios is 25 to 49.
IC17	
IC11b	
IC15b	Combines the fraction N overflow signal with the output of the final divider.

107. **Set CARR FREQ, 327.64 MHz.** IC16 will route the clock signal through unchanged whilst IC17 will divide by two. Monitor IC16 pins 11 and 12 using pin 11 to synchronize the oscilloscope. A positive-going pulse of approximately 0.78 μ s duration should be seen on pin 12. As increments of 10.24 MHz are entered a wider pulse should be seen, this will be delayed by one more clock period each time. Eventually the division ratio of IC17 will increase to three and IC16 pin 12 will go 'high' immediately after the parallel load command on pin 11. There will now be three longer duration pulses on pin 12 in every phase comparator cycle (25 μ s).

108. If a frequency counter with a ratiometric function is available it should be connected to IC16 pin 14 (frequency should be in the range 1-2 MHz) and IC11 pin 8 (40 kHz). Second function 3 should be used to change the division ratio by altering the contents of latch 34. Check that the value from the counter coincides with the decimal equivalent of the data in the latch.

Note ...

The oscillators must be switched over in order to cover the full octave of 250-500 MHz.

i.e.	Latch data	Set carrier frequency
	011001 - 100010	317.4 MHz
	100011 - 110000	471 MHz

109. 40 kHz Phase comparator and loop filter. Check the phase comparator IC22 and its associated circuit,

- IC22 pin 3 - 40 kHz TTL signal. Mark space ratio 2:3
- IC22 pin 11 - 40 kHz TTL signal. Mark space ratio $\approx 1:50$
dependent on the synthesizer frequency
- TR7,8 bases - +2.5 V
- TR7,8 collectors - +2.5 V
- TR7,8 emitters - Very narrow negative and positive-going pulses
respectively

Timing waveforms can be seen in Fig. 5-18.

The voltage on IC28 pin 6 will vary, typically between +2.5 V and +16 V as the carrier frequency is changed from between 250 - 352 MHz and 353 - 499 MHz.

110. Phase comparator. Carry out the following checks :

- IC14a pin 7 - 40 kHz TTL signal. Mark space ratio 1:4
- TR5 emitter - +12.7 V
- TR6 emitter - -9 V
- TR5,6 collectors - Positive-going ramp -9 V to +12.7 V.
Repetition rate 25 μ s. Slew rate 1.2 V/ μ s

Connect an oscilloscope probe to the junction of R42/IC18 pin 7 and temporarily connect a wire between PLT, pin 10 to a supply of +12 V and -12 V. Check that when +12 V is applied the rising edge of the displayed 40 kHz square wave moves to the right (retards) and has a TTL 'low' level output. Replace the +12 V supply with -12 V and check that the displayed waveform rising edge moves to the left (advances) and that the signal now has a TTL 'high' level output.

111. Frequency synthesizer latch address data. The control data for AA1/1 is shown in Table 5-25.

TABLE 5-25 FREQUENCY SYNTHESIZER LATCH ADDRESS DATA

Address number	Description	D ₀	D ₁	D ₂	D ₃	D ₄	D ₅	D ₆	D ₇
33 IC23	10 Hz positive frequency increments	10 Hz	20 Hz	40 Hz	80 Hz	160 Hz	320 Hz	X	X
34 IC24	640 Hz positive frequency increments	640 Hz	1.28 kHz	2.56 kHz	5.12 kHz	10.24 kHz	20.48 kHz	X	X
35 IC19	2 bits of 2.56 MHz negative frequency increment. Control of phase modulator and external std.	-2.56 MHz	-5.12 MHz	LF FM ON	INTERNAL MOD FREQUENCY CONTROL		EXT STANDARD	X	X
36 IC13	10.24 MHz positive frequency increments	10.24 MHz	20.45 MHz	40.96 MHz	81.92 MHz	163.84 MHz	327.68 MHz	X	X
37 IC3	40 kHz negative frequency increments	-40 kHz	-80 kHz	-160 kHz	-320 kHz	-640 kHz	-1.28 MHz	X	X

Microprocessor (AA2/1)

112. +5 V EAROM protection. Check that the following voltages are present.






D2 cathode - +6.2% \pm 5%
 TP2 - +4.5 V
 IC1 pin 6 - +1.2 V \pm 0.5 V
 TR2 collector - +5 V

113. Parallel to serial converter. If the instrument responds to key presses it is likely that the microprocessor is serviceable. If key presses do not give the correct response, monitor the following points in the 'static' condition using an oscilloscope and probe (that is with no keys pressed or GPIB commands occurring).

IC11 pins 1,9,10,11 - Should be TTL 'high' level for most of the time.
 IC2 pins 3,6,8,11 - Normally 'high'.
 IC13 pins 3,6,11 - Complex data activity
 IC14 pins 2,7,10,11 - Normally 'low'

114. Synthesizer drive latches. Check IC14 address latch, first select CARR FREQ 327.6 MHz followed by frequency increments given in the table below; monitor in each case IC14 outputs Q0 to Q4, as indicated using a logic probe.

TABLE 5-26 SYNTHESIZER FREQUENCY ADDRESS DECODER OUTPUTS

IC14 pin No.	10Hz	Size of frequency step			
		640Hz	40kHz	2.56MHz	10.4MHz
2		X	X	X	X
5	X		X	X	X
7	X	X	X		X
10	X	X	X	X	
12	X	X		X	X

Note ...

Logic probe will normally be lit then temporarily turned off.

115. Check IC15 data latch; first select CARR FREQ 327.6 MHz followed by a 10 Hz frequency increment. Keeping the UP key ↑ pressed monitor the output lines of IC15 using a logic probe. Check the sequences shown for each pin no. in Table 5-27.

TABLE 5-27 DATA LATCH INCREMENT SEQUENCE

IC15 pin No.	Transitory sequence
2	One 'flash' on the logic probe per increment
5	Flashes for two increments, then off for two increments
7	Flashes for four increments, then off for four increments
10	Flashes for eight increments, then off for eight increments
12	Flashes for sixteen increments, then off for sixteen increments
15	Flashes for thirty two increments, then off for thirty two increments

116. Clock divider. Check that the following waveforms are present.

- IC3 pin 1 - 2.5 MHz square wave
- IC3 pin 6 - 156.25 kHz square wave
- IC3 pin 8 - $9.765 \frac{2}{3}$ kHz square wave

Other lines only change at approximately 15 minute intervals although IC18 can be checked for basic operation.

IC4 pin 7 - ≈ 600 Hz square wave

117. Microprocessor system. Check that a 5 MHz square wave is present at IC2 pin 1. Also check that IC2 pin 36 logic level is normally 'high' and IC2 pin 7 normally 'low'. Complex waveforms on all the address and data lines may be expected, especially at power on. Suspect any lines that do not change state at all. Similarly, the decoded address lines feeding IC7,12,13 should toggle at power on (and if it is responding to key presses, then during keyboard interrogation also).

RF processing board (AB1/2)

118. **160 MHz oscillator.** If a 500 Ω oscilloscope probe connected across R6 gives no indication of a 160 MHz waveform (carrier frequency must be set to below 62.5 MHz), then the metal box covering the three voltage controlled oscillators must be dismantled. Care should be taken to ensure that the mating surfaces are kept clean and in particular are kept free of solder splashes on the nickel plated mating areas of the PCB.

119. First check that the DC conditions on TR1 and D1 are correct then check IC1 and IC2 voltages also.

TR1 drain/R2 junction	- +8.4 V
TR1 source	- +1.6 V
D1 cathode	- +15.6 V (+12 V with box lid on)

Check C3,C4,C7 serviceability

IC1 pin 1	- +0.85 V \pm 0.1 V
IC1 pin 5	- +6.5 V \pm 0.5 V

Similar voltages should be present on IC2

120. **160 MHz modulator and level control.** Check that with a 500 Ω oscilloscope probe connected across R6 the level is approximately -22 dBm. Also check that, with no modulation applied, the voltage at the junction of R10/R11 is a nominal 0 V and TR3 emitter voltage is +0.6 V. Set RF LEVEL, -11 dBm, CARR FREQ, 10 MHz and check the following voltages :

D3 cathode	- +0.6 V
Junction of D2/D4 cathodes	- -0.63 V
'ALC LF' test point	- typically +7.3 V
Reset RF LEVEL to -7 dBm (do not use increment facility) 'ALC LF' test point	} - typically +7.6 V

121. **BFO mixer.** Set CARR FREQ, 10 MHz, RF LEVEL, -11 dBm. Using a 500 Ω oscilloscope probe check at the points shown below that level, frequency and distortion are in agreement with the figures given.

Pin 4 of X1: Freq. 170 MHz, Level -15 dBm, Distortion <20 dBc second harmonic
L4 to ground: Freq. 160 MHz, Level -46 dBm, Distortion <30 dBc second harmonic
(Pin 1 of X1)

Across R130: Freq. 10 MHz, Level -49 dBm.

122. **BFO output amplifier and levelling loop.** Set CARR FREQ, 10 MHz, RF LEVEL -11 dBm and check the following :

TR14 base	1 V
TR14 collector	3 V
TR17 base	+2.3 V
TR17 collector	+6.5 V
D33 anode	-0.33 V
D44 cathode	-0.33 V
IC12 pin 7	+7.3 V

123. **250–500 MHz oscillators.** Set CARR FREQ, 250 MHz followed by a frequency of 353 MHz. The following voltages should be noted :

	250 MHz	352 MHz
R24	0 V	+5 V
TR5 collector	-12 V	-11.35 V
TR6 collector	-0.55 V	-12 V
TR8 collector	-11.35 V	-12 V
TR9 collector	-12 V	-0.55 V
Voltage drop across R29	-	1.9 V
Voltage drop across R39	1.9 V	-
PLAD, pin 16	+2 V	+2 V

Monitor the signal level across R48 with a 500 Ω probe and check that this is approximately -25 dBm. If one or other of the oscillators fails to operate correctly it will be necessary to remove the metal screen covering the oscillators. As mentioned previously, care must be taken to ensure that all mating surfaces are kept clean to maintain screening efficiency. As before select the two carrier frequencies 250 MHz and 353 MHz and check for the following voltages :

Carrier frequency	250 MHz	353 MHz
TR7 collector	+12 V	+8.25 V
TR10 collector	+8.25 V	+12 V

124. Check for leakage in D5, D6, D7 and the correct operation of each diode junction. Decoupling and phase correction capacitors should also be checked. If functioning correctly each oscillator should oscillate strongly even if capacitive loads (i.e. fingers) are introduced.

Note ...

TR10 is intentionally fitted with markings facing the PCB, replacement items should also be fitted in the same position.

Finally check that the four buffer amplifiers IC7–IC10 have the following voltages present :

IC7–IC10 pin 1	-	+0.85 V \pm 0.1 V
pin 5	-	+6.5 V \pm 0.5 V

125. **Signal divider (two stage IC11a,b).** Set CARR FREQ, 62.5 MHz. Both dividers IC11a and b will now be in operation. Check that the following voltages are present :

IC11 pin 11	-	+3.6 V
IC11 pin 10	-	+3.6 V
IC11 pin 7	-	+3.6 V
Point F	-	+0.2 V (Points A to F are shown in Fig. 7-9)
Point A	-	+0.2 V
D15/18 junction	-	+5.7 V
Point B	-	+7.8 V

A signal of approximately -12 dBm should be seen across R69 using a 500 Ω oscilloscope probe, check also for the following :

D16 anode - +0.95 V
D11 anode - +1.7 V

Note ...

Switching diode bias is drawn through the two low-pass filters LPF "STOP 375 MHz" and LPF "STOP 187.5 MHz". Attempts therefore to measure signal levels should be made with a capacitively coupled probe. Excessive harmonic distortion at the outputs of the divider stage (>-25 dBc of second harmonic across R69, and from the junction C91/R16 and ground) or a raised noise floor indicate a potentially defective divider, particularly if the drive levels have been checked and found to be satisfactory.

126. 250-500 MHz switch. Set CARR FREQ, 250 MHz, which will effectively switch off IC11a,b dividers and cause diode network D8, D9, D10 to re-route the RF signal through to the "STOP 750 MHz" low-pass filter. Check the following :

Point E - +0.1 V
D10 cathode - +2.5 V
D9 anode - +1.6 V

127. Mixer driver/doubler drive and levelling loop. Set CARR FREQ, 500 MHz and check using a 500 Ω oscilloscope probe the signal level across R64. This should be approximately -15 dBm. Also check the following voltages :

R63/C122 junction - +5 V
D21 anode - +2.5 V
ALC doubler voltage - +3 V
D22 cathode - +2.4 V
D24 anode - +3.5 V
IC13 pin 1 - +3.1 V
IC13 pin 8 - +12 V

Note ...

D24 detects the negative peaks of the drive waveform present at IC13 output. Thus the level DC on the anode will decrease as the RF voltage increases. Attach a capacitively coupled 500 Ω probe between the junction of R80/D26 and ground. The power level at this point should be approximately -10 dBm with a second harmonic distortion better than -20 dBc.

128. Signal doubler and band-pass filter. Set CARR FREQ, 500 MHz, and check the following voltages :

D26 cathode	- +4.1 V	
R90/C103 junction	- -0.2 V	} Will depend on RF signal level.
D27/D28 or D29/D30 junctions	- -0.03 V	
IC3 pin 1	- +0.85 V \pm 0.1 V	
IC3 pin 5	- +6.5 V \pm 0.5 V	

129. The band-pass filter comprising D34, D35 and T6 cannot be adjusted. However a check can be made on the filter tracking. Monitor the voltage and the junction of R27, R107 whilst incrementing the carrier frequency in 100 MHz steps starting from 500 MHz. Compare the results with the values in Table 5-28.

TABLE 5-28 TYPICAL BAND-PASS FILTER TRACKING VOLTAGES/CALIBRATION DATA

Carrier freq.	Filter tuning voltage	EAROM data
500 MHz	5.5 V	60
600 MHz	9.0 V	100
700 MHz	11.5 V	120
800 MHz	14.0 V	150
900 MHz	18.0 V	190
1010 MHz	23.5 V	250

130. Check the voltage drop across R97 and R107, this should be negligible. Also check

Point D - +0.25 V
D32 anode - +1 V

131. **62.5-1010 MHz output amplifier and levelling loop.** Set CARR FREQ, 1010 MHz, RF LEVEL, -7 dBm. Check the following voltages :

D38 cathode - +0.05 V
D41 cathode - +0.5 V
TR13 emitter - +11.6 V
Collector TR19 - +8.4 V
*Base TR20 - +1.4 V
Signal level across R93 - -8 dBm
(using capacitively coupled 500 Ω probe)

D43 cathode - +0.06 V
Check that D50 is reverse biased

IC15 pins 2,3 - -0.07 V
IC15 pin 6 - -0.07 V

132. Couple a 50 Ω external load to the RF OUTPUT socket of the instrument and select the RF levels shown in Table 5-29. Monitor in each case the test points indicated.

TABLE 5-29 62.5-1010 MHz OUTPUT AMPLIFIER DRIVE CONDITIONS

RF level	PLAD pin 3	D43 cathode	ALC HF T./Pt.	TR13 emitter
-7 dBm	0.32 V	+0.07 V	+10.03 V	+11.64 V
0 dBm	0.81 V	+0.57 V	+9.94 V	+11.60 V
+7 dBm	1.91 V	+1.72 V	+9.77 V	+11.52 V
+10 dBm	2.72 V	+2.52 V	+9.56 V	+11.44 V

* **CAUTION:** The output amplifier may be damaged if the base of TR20 is inadvertently shorted to earth. If TR20 is replaced, its heatsink should be tightened to a torque of 0.7 kNm (6.4 lbf in).

133. **Control logic states.** IC4, IC5 and IC6 are used to control the switching of diodes and dividers as the frequency bands change. Table 5-30 gives the different states used and their associated logic levels.

TABLE 5-30 FREQUENCY BAND SWITCHING, LOGIC LEVELS

Frequency band	PLAD pin 6 A0	PLAD pin 11 A1/2	PLAD pin 7 A2	'OSC HIGH'	A	B	C	D	E	F	G
10 kHz - 16.5 MHz	0	1	1	0	1	0	1	1	1	0	1
16.5 - 62.5 MHz	0	1	1	1	1	0	1	1	1	0	1
62.5 - 88.25 MHz	0	0	0	0	1	0	1	1	0	0	0
88.25 - 125 MHz	0	0	0	1	0	1	0	1	1	0	0
125 - 176.5 MHz	1	0	0	0	1	0	0	1	1	0	0
176.5 - 250 MHz	1	0	0	1	1	0	0	1	1	0	0
250 - 353 MHz	1	1	0	0	1	1	0	1	0	1	0
353 - 500 MHz	1	1	0	1	1	1	0	1	0	1	0
500 - 706 MHz	0	1	0	0	1	1	1	0	0	1	0
706 - 1010 MHz	0	1	0	1	1	1	1	0	0	1	0



Chapter 6

REPLACEABLE PARTS

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INTRODUCTION

- Each sub-assembly or printed circuit board in this equipment has been allocated a reference designator code, e.g. A0, A1, A2 etc.
- The complete component reference includes its reference designator as a prefix e.g. A2C1 (capacitor C1 on sub-assembly A2) but for convenience in the text and diagrams the prefix is omitted unless it is needed to avoid confusion. However when ordering replacements or in correspondence the complete component reference must be quoted.

ABBREVIATIONS

- Electrical components are listed in alpha-numerical order of their complete circuit reference and the following standard abbreviations are used in the 'Description' column :

ADC	analogue-digital converter
CAP	capacitor
CARR	carrier
CARB	carbon
CC	carbon composition
CDE CNV	code converter

CERM	cermet
CF	carbon film
COAX	coaxial
CON	connector
CTR	counter
DAC	digital-analogue converter
DEC/DMX	decoder/demultiplexer
DECOD	decoder
DIL	dual in-line
DIV	divider
DRIV	driver
ELEC	electrolytic
ENCOD	encoder
FEM	female
FF	flip-flop (bistable)
FILTERCON	filtering capacitor
GER	germanium
GP	general purpose
ICA	integrated circuit, analogue
ICD	integrated circuit, digital
IND	inductor
INV	inverter
LD/T	lead through
MF	metal film
MG	metal glaze
MISC	miscellaneous
MO	metal oxide
MP	microprocessor
MP SUPP	microprocessor support
MUX	multiplexer
NET	network
PC	polycarbonate
PETP	(polyester)polyethelene terephthalate
PS	polystyrene
PLL	phase-locked loop
Q/ACT	quick acting
RECT	rectifier
RES	resistor
RV	resistor, variable
RX	receiver
SAPPH	sapphire
SEC	secondary

SH REG	shift register
SIL	silicon
SW	switch
T/LAG	time lag
TANT	tantalum
TOG	toggle
TRANS	transistor
TX	transmitter
VAR	variable
VREG	voltage regulator
W	watts at 70°C
WW	wirewound
X	miscellaneous item
XL	crystal
!	static sensitive component
% +	asymmetric tolerance

COMPONENT VALUES

4. One or more of the components fitted in the equipment may differ from those listed in this chapter for any of the following reasons:

- (a) Components indicated by a * have their values selected during test to achieve particular performance limits.
- (b) Owing to supply difficulties, components of different value or type may be substituted provided the overall performance of the equipment is maintained.
- (c) As part of a policy of continuous development, components may be changed in value or type to obtain detail improvements in performance.

5. When there is a difference between the component fitted and the one listed, always use as a replacement the same type and value as found in the equipment.

ORDERING

6. When ordering replacements, address the order to our Service Division (address on rear cover) or nearest agent and specify the following for each component required:-

- (1) Type# and serial number of equipment.
- (2) Complete circuit reference.
- (3) Description.
- (4) Part number.

As given on the serial number label at the rear of the equipment; if this is superseded by a model number label, quote the model number instead of the type number.

Circuit Ref.	Description	Part Number
ELECTRICAL COMPONENTS		
Unit A0/1 - SIGNAL GENERATOR		
7.	When ordering, prefix circuit reference with A0/1.	
	Complete unit	52022-950J
FS1	FUSE T/LAG 0.25A 20X5 SLOW 210V-240V	23411-045F
FS2	FUSE T/LAG 0.25A 20X5 SLOW " "	" "
FS1	FUSE T/LAG 0.5A 20X5 SLOW 105V-120V	23411-046G
FS2	FUSE T/LAG 0.5A 20X5 SLOW " "	" "
	FUSE HOLDER	23416-192R
IC1	ICA VREG+ LM317T PROG 1A5	28461-726A
PLC	CON PWR MALE 3 FXD	23423-159P
PLR	CABLE ASSY (PLR-SKS)	43130-091N
PLV	CABLE ASSY (PLV-SKU)	43130-021Y
PLW	CABLE ASSY	43130-974H
PLY	CABLE ASSY (PLY-SKX)	43130-022N
PLZ	CABLE ASSY	43130-975E
PLAE	CABLE ASSY	43130-032W
PLAF	CABLE ASSY (PLAF-SKB)	43130-011B 491
R1	RV CERM 10K LIN .5W 10%	25748-518H
SA	SW TOG 2CO LEVER MAINS	23462-249Z
SB	SW SLIDE 2CO PANEL MTG	23467-161W
SC	SW SLIDE 2CO PANEL MTG	23467-161W
SKA	CON RF BNC FEM 50 BKHD (MOD IN/OUT)	23443-442B
SKAX	CON RF BNC FEM 50 BKHD (AUX MOD)	23443-442B
SKB	CABLE ASSY (SKB-PLAF)	43130-491A
SKD	CABLE ASSY (SKD-SKR)	43130-012K
SKE	CON 57 FEM 24 FXD PCB EDG GPIB	23435-133X
SKH	CABLE ASSY	43130-014Z
SKJ	CABLE ASSY	43130-010R
SKK	CABLE ASSY	43130-026G
SKL	CABLE ASSY	43130-018Y
SKM	CABLE ASSY	43130-028S
SKN	CABLE ASSY	43130-015H
SKP	CABLE ASSY	43130-027V
SKR	CABLE ASSY (SKR-SKD)	43130-012K
SKS	CABLE ASSY (SKS-PLR)	43130-019N
SKT	CABLE ASSY	43130-020U
SKU	CABLE ASSY (SKU-PLV)	43130-021Y
SKV	CABLE ASSY (SKV-SKW)	43137-028W
SKW	CABLE ASSY " "	" "
SKX	CABLE ASSY (SKX-PLY)	43137-024F
SKY	CABLE ASSY (SKY-SKZ)	43130-017U
SKZ	CABLE ASSY " "	" "

Complete Inc. BNC) BNC
23443-548

Circuit Ref.	Description	Part Number
Unit A0/1 - SIGNAL GENERATOR (Contd.)		
SKAA	CABLE ASSY	43130-023L
SKAB	CABLE ASSY	43130-024J
SKAC	CABLE ASSY	43130-025F
SKAD	CABLE ASSY	43130-029W
SKAE	CON RF SMA FEM 50 BKD LG S/BK	23444-513F
SKAF	CON RF SMA FEM 50 FLG S/BK	23444-509J
SKAG	CON PART MIN HOUSING 1 ROW 3P	23435-171R
TR1	TR NSI BD543 40V LOW VCE	28454-750B
T1	TRANSFORMER MAINS TOROIDAL	43490-086G
X1	FAN AX 5V DC 48MM	23535-127B

Unit A1/2 - KEYBOARD PCB

8. When ordering, prefix circuit reference with A1/2.

	Complete unit	44829-563A
C1	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C2	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C3	CAP ELEC 100U 6.3V 20%	26421-118L
D1	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D2	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D3	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D4	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D5	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D6	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D7	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D8	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D9	DI SIL 1N4148 75V JUNC	28336-676J
D10	DI SIL 1N4148 75V JUNC	28336-676J
D11	DI SIL 1N4148 75V JUNC	28336-676J
D12	DI SIL 1N4148 75V JUNC	28336-676J
D13	DI SIL 1N4148 75V JUNC	28336-676J
D14	DI SIL 1N4148 75V JUNC	28336-676J
D15	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D16	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
D17	LAMP LED HLMP1401 2.4V YELLOW	28624-137D
IC1	ICD DRIV 7225G 32 SEGMENT LCD !	28467-023H
IC2	ICD DRIV 7225G 32 SEGMENT LCD !	28467-023H
IC3	ICD FF-D 74HC374 OCT +E TR 3ST !	28462-624G
IC4	ICD LATCH 40373 OCTAL 3ST !	28462-413N
IC5	ICD BUFF 4503 HEX 3ST !	28469-179T
IC6	ICD NAND 74HC00 QUAD 2INP !	28466-365P
L1	IND CHOKE 100UH 10% LAQ	23642-561W

Circuit Ref.	Description	Part Number
Unit A1/2 - KEYBOARD PCB (Contd.)		
MP3	SW-CAP RECT O "INCREMENT"	37591-301V
MP4	SW-CAP RECT O "STORE"	37591-329G
MP5	SW-CAP RECT O "REC'L"	37591-328F
MP6	SW-CAP BN "MOD ALC"	37591-302S
MP7	SW-CAP RECT O "CARR FREQ"	37591-303W
MP8	SW-CAP RECT O "FM PM"	37591-304D
MP9	SW-CAP RECT O "AM"	37591-305T
MP10	SW-CAP RECT O "RF LEVEL"	37591-306P
MP11	SW-CAP RECT BN "7"	37591-307X
MP12	SW-CAP RECT BN "4"	37591-308M
MP13	SW-CAP RECT BN "1"	37591-309C
MP14	SW-CAP RECT BN "0"	37591-310X
MP15	SW-CAP RECT BN "8"	37591-311M
MP16	SW-CAP RECT BN "5"	37591-312C
MP17	SW-CAP RECT BN "2"	37591-313R
MP18	SW-CAP RECT BN "."	37591-314B
MP19	SW-CAP RECT BN "6" OR "9"	37591-315K
MP20	SW-CAP RECT BN "6" OR "9"	37591-315K
MP21	SW-CAP RECT BN "3"	37591-316A
MP22	SW-CAP RECT BN "-"	37591-317Z
MP23	SW-CAP RECT GY "MHZ V"	37591-318H
MP24	SW-CAP RECT GY "KHZ MV"	37591-319E
MP25	SW-CAP RECT GY "HZ UV"	37591-320Z
MP26	SW-CAP RECT GY "% RAD DB"	37591-321H
MP27	SW-CAP RECT BN "INT EXT"	37591-322E
MP28	SW-CAP RECT BN "MOD ON OFF"	37591-323U
MP29	SW-CAP RECT BN "TOTAL INCR"	37591-324Y
MP30	SW-CAP RECT BN "ARROW"	37591-330J
MP31	SW-CAP RECT BU "SECOND FUNCT"	37591-325N
MP32	SW-CAP RECT BN "CARR ON OFF"	37591-326L
MP33	SW-CAP RECT BN "RETURN"	37591-327J
MP34	SW-CAP RECT BN "ARROW"	37591-330J
R1	RES MF 470R .125W 2% 100PPM	24772-065S
R2	RV CERM 2K LI .3W 10% 3/4"MT	25748-505T
R3	RES MF 3K9 .125W 2% 100PPM	24772-087Y
R4	RES MF 100R .125W 2% 100PPM	24772-049H
R5	RES MF 470R .125W 2% 100PPM	24772-065S
R6	RES MF 10K .25W 0.5% 50PPM	24753-628N
R7	RES MF 10K .25W 0.5% 50PPM	24753-628N
R8	RES MF 62K .125W 2% 100PPM	24772-116K
R9	RN BUS 100K 5% 9SIP	24681-635F
R10	RES MF 150R .125W 2% 100PPM	24772-053E
R12	RES MF 150R .125W 2% 100PPM	24772-053E
R13	RES MF 150R .125W 2% 100PPM	24772-053E
R14	RES MF 150R .125W 2% 100PPM	24772-053E

REPLACEABLE PARTS

Circuit Ref.	Description	Part Number
Unit A1/2 - KEYBOARD PCB (Contd.)		
SA	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SB	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SC	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SD	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SE	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SF	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SG	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SH	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SJ	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SK	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SL	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SM	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SN	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SP	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SR	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SS	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
ST	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SU	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SV	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SW	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SX	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SY	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SZ	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAA	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAB	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAC	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAD	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAE	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAF	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAG	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAH	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
SAJ	SW PUSH 1NO MOM ELASTO INSERT	23465-210Z
TR1	TR PSI BC308B 20V 100MA - GEN	28433-455R
X1	LIQUID CRYSTAL DISPLAY	44990-490W
X2	CON ELAS - - - 6.35X3.56X119.4	23436-030E
X100	CABLE ASSY (SKK)	43130-026G

Circuit Ref.	Description	Part Number
Unit A2/2 - POWER SUPPLY & CONTROL PCB		
9.	When ordering, prefix circuit reference with A2/2.	
	Complete unit	44829-573L
C1	CAP ELEC 15000U 16V -10+30%	26422-307Y
C2	CAP ELEC 6800U 25V -10+30%	26422-308N
C3	CAP ELEC 220U 25V 20%+	26421-125V
C4	CAP ELEC 220U 25V 20%+	26421-125V
C5	CAP ELEC 470U 25V 20%+	26421-129T
C6	CAP ELEC 100U 50V 20%+	26421-123F
C7	CAP ELEC 10U 35V 20%	26421-112Z
C8	CAP ELEC 10U 35V 20%	26421-112Z
C9	CAP ELEC 10U 35V 20%	26421-112Z
C10	CAP CER 10N 50V 20%	26346-120Y
C11	CAP ELEC 33U 25V 20%	26421-115U
C12	CAP ELEC 33U 25V 20%	26421-115U
C13	CAP ELEC 4U7 35V 20%	26421-108A
C14	CAP ELEC 100U 6.3V 20%	26421-118L
C15	CAP CER 10N 50V 20%	26346-120Y
C16	CAP CER 10N 50V 20%	26346-120Y
C17	CAP CER 220P 63V 2%	26343-435U
C18	CAP PETP 470N 63V 10%	26582-427L
C19	CAP CER 10N 50V 20%	26346-120Y
C20	CAP CER 220P 63V 2%	26343-435U
C21	CAP PETP 470N 63V 10%	26582-427L
C22	CAP CER 10N 50V 20%	26346-120Y
C23	CAP CER 10N 50V 20%	26346-120Y
C24	CAP PETP 47N 63V 10%	26582-428J
C25	CAP PETP 1U0 50V 10%	26582-432F
C26	CAP PETP 220N 63V 10%	26582-430L
C27	CAP CER 4P7 63V .25P	26343-485P
C28	CAP CER 4P7 63V .25P	26343-485P
C29	CAP PS 1N5 63V 1%	26538-906D
C30	CAP CER 18P 63V 2%	26343-498E
C31	CAP CER 4P7 63V .25P	26343-485P
C32	CAP PETP 2U2 63V 10%	26582-418Z
C33	CAP PS 4N7 63V 1%	26538-918A
C34	CAP CER 15P 63V 2%	26343-493B
C35	CAP CER 47P 63V 2%	26343-433H
C36	CAP CER 15P 63V 2%	26343-493B
C37	CAP CER 15P 63V 2%	26343-493B
C38	CAP CER 10N 50V 20%	26346-120Y
C39	CAP CER 180P 63V 2%	26343-446S
C41	CAP CER 10N 50V 20%	26346-120Y

Circuit Ref.	Description	Part Number
Unit A2/2 - POWER SUPPLY & CONTROL PCB (Contd.)		
C48	CAP CER 10N 50V 20%	26346-120Y
C49	CAP CER 1N0 63V 10%	26383-585M
C50	CAP CER 10N 50V 20%	26346-120Y
C51	CAP ELEC 100U 6.3V 20%	26421-118L
C52	CAP PETP 1U0 50V 10%	26582-432F
C53	CAP ELEC 10U 35V 20%	26421-112Z
C54	CAP PETP 68N 63V 10%	26582-436W
C55	CAP CER 10N 50V 20%	26346-120Y
C56	CAP CER 10N 50V 20%	26346-120Y
D1	DI RECT 1N5401 100V	28355-723N
D2	DI RECT 1N5401 100V	28355-723N
D3	DI BRIDGE 2KBB20R 200V 1.9A	28359-189D
D4	DI BRIDGE 2KBB20R 200V 1.9A	28359-189D
D5	DI RECT 1N4004 400V	28357-028K
D7	DI RECT 1N4004 400V	28357-028K
D8	DI ZEN 1N825/A 6.2V 5%	28371-494Z
D9	DI SIL 1N4148 75V JUNC	28336-676J
D10	DI ZEN 1N825/A 6.2V 5%	28371-494Z
D11	DI SIL 1N4148 75V JUNC	28336-676J
D29	DI SIL 1N4148 75V JUNC	28336-676J
D30	DI H/CARR HP5082-2811 1.0V	28349-008U
IC1	ICA VREG- LM337T ADJ 1.5A	28461-727Z
IC2	ICA VREG+ LM317T ADJ 1.5A	28461-726A
IC3	ICA AMP TL072CP DUAL FET I/P	28461-348Z
IC4	ICD BUFF 4049B HEX INV BI	28469-162Z
IC5	ICD SH-REG 4094 8BIT STR/LA	28467-521W
IC6	ICD AND 4081 QUAD 2INP	28466-009L
IC7	ICD SH-REG 4094 8BIT STR/LA	28467-521W
IC8	ICD SH-REG 4021 8BIT PISO	28467-527C
IC9	ICD SH-REG 4094 8BIT STR/LA	28467-521W
IC11	ICD FF-D 40174 HEX	28462-616Y
IC12	ICD NAND 4011 QUAD 2INP	28466-340R
IC13	ICD BUFF 4503 HEX 3ST	28469-179T
IC14	ICA MUX 4053 TRIP 2INP	28469-714H
IC15	ICA AMP TL074CN QUAD FET I/P	28461-349H
IC16	ICA AMP TL074BCN FET I/P DIL14	28461-378K
IC17	ICA AMP TL074CN QUAD FET I/P	28461-349H
IC18	ICA AMP TL074CN QUAD FET I/P	28461-349H
IC19	ICA DAC AD7528JN DUAL 8BIT	28469-428C
IC20	ICA DAC AD7528JN DUAL 8BIT	28469-428C
IC21	ICA AMP NE5532 DUAL LN DIL8	28461-363G
IC22	ICD FF-D 40174 HEX	28462-616Y
IC23	ICA DAC AD7528JN DUAL 8BIT	28469-428C
IC25	ICD FF-D 40174 HEX	28462-616Y
IC26	ICD NAND 4093 QUAD 2INP SCH BI	28469-203U
IC27	ICA ARRAY CA3046 5 NPN TRAN	28461-901A

Circuit Ref.	Description	Part Number
Unit A2/2 - POWER SUPPLY & CONTROL PCB (Contd.)		
IC28	ICA DAC AD7549JN DUAL 12-BIT	28469-460P
IC29	ICD DEC/DMX 74HC138 3-8	28465-040P
IC30	ICD DEC/DMX 74HC138 3-8	28465-040P
IC31	ICD DEC/DMX 74HC138 3-8	28465-040P
IC32	ICA AMP TLO71CP FET I/P DIL8	28461-347A
L1	IND CHOKE 100UH 10% LAQ	23642-561W
PLF	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLG	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLH	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLJ	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLK	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLL	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLM	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLN	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLX	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLAG	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
R1	RES MF 750R .25W 2% 100PPM	24773-270R
R2	RES MF 220R .125W 2% 100PPM	24772-057L
R3	RES MO 51R .5W 2% 250PPM	24573-042D
R4	RES MF 220R .125W 2% 100PPM	24772-057L
R5	RV CERM 50R LI .5W 10%	25711-634N
R6	RES MF 2K0 .25W 2% 100PPM	24773-280U
R7	RES MF 2K0 .25W 2% 100PPM	24773-280U
R8	RV CERM 50R LI .5W 10%	25711-634N
R9	RES MF 220R .125W 2% 100PPM	24772-057L
R10	RES MF 680R .25W 2% 100PPM	24773-269K
R11	RES MF 680R .25W 2% 100PPM	24773-269K
R12	RES MF 1K0 .125W 2% 100PPM	24772-073X
R13	RES MF 620R .125W 2% 100PPM	24772-068T
R14	RES MF 2K0 .125W 2% 100PPM	24772-080B
R15	RV CERM 2K0 LI .5W 10%	25711-639V
R16	RES MF 16K .125W 2% 100PPM	24772-102V
R17	RES MF 560R .125W 2% 100PPM	24772-067D
R18	RES MF 100K .125W 2% 100PPM	24772-121Z
R19	RES WW OR1 1.5W 10%	25133-032C
R20	RES MF 1K0 .25W 2% 100PPM	24773-273A
R21	RES MF 10K .125W 2% 100PPM	24772-097S
R22	RES MF 10K .125W 2% 100PPM	24772-097S
R23	RES MF 100R .125W 2% 100PPM	24772-049H
R24	RES MF 100K .125W 2% 100PPM	24772-121Z
R25	RES MF 100K .125W 2% 100PPM	24772-121Z
R26	RES MF 10K .25W 2% 100PPM	24773-297M
R27	RES MF 10K .125W 2% 100PPM	24772-097S
R28	RES MF 1K0 .125W 2% 100PPM	24772-073X
R29	RES MF 470R .125W 2% 100PPM	24772-065S
R30	RES MF 2K2 .25W 2% 100PPM	24773-281Y

Circuit Ref.	Description	Part Number
Unit A2/2 – POWER SUPPLY & CONTROL PCB (Contd.)		
R31	RES MF 10K .125W 2% 100PPM	24772-097S
R32	RES MF 4K7 .125W 2% 100PPM	24772-089L
R33	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R34	RES MF 100K .125W 2% 100PPM	24772-121Z
R35	RES MF 1K5 .25W 2% 100PPM	24773-277U
R36	RES MF 360R .25W 2% 100PPM	24773-262T
R37	RES MF 360R .25W 2% 100PPM	24773-262T
R38	RES MF 6K2 .125W 2% 100PPM	24772-092L
R39	RES MF 1M0 .125W 2% 100PPM	24772-141T
R40	RES MF 1M0 .125W 2% 100PPM	24772-141T
R41	RES MF 10K .125W 2% 100PPM	24772-097S
R42	RES MF 1K0 .25W 2% 100PPM	24773-273A
R43	RES MF 560K .125W 2% 100PPM	24772-138T
R44	RES MF 430K .125W 2% 100PPM	24772-136W
R45	RES MF 1M0 .125W 2% 100PPM	24772-141T
R46	RES MF 100K .125W 2% 100PPM	24772-121Z
R49	RES MF 100K .125W 2% 100PPM	24772-121Z
R50	RES MF 10K0 .25W 0.1% 15PPM	24723-373P
R51	RES MF 1K8 .25W .1% 25PPM	24723-395F
R52	RES MF 10K0 .25W 0.1% 15PPM	24723-373P
R53	RES MF 18K0 .25W 0.1% 25PPM	24723-413M
R54	RES MF 1K0 .125W 2% 100PPM	24772-073X
R55	RES MF 18K .125W 2% 100PPM	24772-103S
R56	RV CERM 2K0 LI .5W 10%	25711-639V
R57	RES MF 2K2 .125W 2% 100PPM	24772-081K
R58	RV CERM 1K0 LI .5W 10%	25711-638G
R59	RES MF 2K2 .125W 2% 100PPM	24772-081K
R60	RES MF 10K .125W 2% 100PPM	24772-097S
R61	RES MF 100R .25W 2% 100PPM	24773-249J
R62	RES MF 1M0 .125W 2% 100PPM	24772-141T
R63	RES MF 820K .125W 2% 100PPM	24772-140D
R64	RES MF 1M0 .125W 2% 100PPM	24772-141T
R65	RES MF 150R .25W 2% 100PPM	24773-253F
R67	RV CERM 1K0 LIN .25W 10% 12T	25748-586E
R68	RES MF 1K6 .125W 2% 100PPM	24772-078K
R69	RES MF 10K .125W 2% 100PPM	24772-097S
R70	RES MF 91K .125W 2% 100PPM	24772-120A
R71	RES MF 390K .125W 2% 100PPM	24772-135S
R72	RES MF 10K .125W 2% 100PPM	24772-097S
R73	RES MF 12K .125W 2% 100PPM	24772-099D
R74	RES MF 12K .125W 2% 100PPM	24772-099D
R75	RES MF 2K2 .125W 2% 100PPM	24772-081K
R79	RES MF 2K2 .125W 2% 100PPM	24772-081K
R80	RES MF 39K .125W 2% 100PPM	24772-111X
R81	RES MF 1K0 .25W 2% 100PPM	24773-273A
R82	RES MF 15K .125W 2% 100PPM	24772-101G
R83	RES MF 47K .125W 2% 100PPM	24772-113C

Circuit Ref.	Description	Part Number
Unit A2/2 - POWER SUPPLY & CONTROL PCB (Contd.)		
R84	RV CERM 50K LI .5W 10%	25711-643S
R85	RES MF 100R .25W 2% 100PPM	24773-249J
R86	RES MF 620R .125W 2% 100PPM	24772-068T
R87	RES MF 12K .125W 2% 100PPM	24772-099D
R88	RES MF 100K .125W 2% 100PPM	24772-121Z
R89	RV CERM 100R LI .5W 10%	25711-635L
R90	RV CERM 100K LI .5W 10%	25711-644W
R91	RES MF 560R .125W 2% 100PPM	24772-067D
R92	RES MF 1K0 .125W 2% 100PPM	24772-073X
R93	RES MF 220K .125W 2% 100PPM	24772-129F
R94	RES MF 100K .125W 2% 100PPM	24772-121Z
R95	RES MF 2K2 .125W 2% 100PPM	24772-081K
R96	RES MF 2K2 .125W 2% 100PPM	24772-081K
R97	RES MF 100K .125W 2% 100PPM	24772-121Z
R99	RES MF 100K .125W 2% 100PPM	24772-121Z
R100	RES MF 22K .125W 2% 100PPM	24772-105D
R101	RES MF 1K0 .125W 2% 100PPM	24772-073X
R102	RES MF 4K7 .125W 2% 100PPM	24772-089L
R103	RES MF 470R .125W 2% 100PPM	24772-065S
R104	RES MF 100K .125W 2% 100PPM	24772-121Z
R105	RES MF 6K8 .125W 2% 100PPM	24772-093J
R107	RES MF 4K7 .125W 2% 100PPM	24772-089L
R108	RES WW 10R 1.5W 5%	25123-020F
R111	RES MF 150R .25W 2% 100PPM	24773-253F
R112	RES MF 1K0 .25W 2% 100PPM	24773-273A
R113	RV CERM 1K0 LI .5W 10%	25711-638G
R114	RES MF 1K0 .25W 2% 100PPM	24773-273A
R115	RES MF 4K7 .25W 2% 100PPM	24773-289W
R116	RES MF 11K .125W 2% 100PPM	24772-098W
R117	RES MF 3K9 .125W 2% 100PPM	24772-087Y
R118	RES MF 620R .125W 2% 100PPM	24772-068T
R119	RES MF 470R .125W 2% 100PPM	24772-065S
R120	RES MF 5K6 .125W 2% 100PPM	24772-091N
R121	RES MF 4K3 .125W 2% 100PPM	24772-088N
RLA	RELAY REED 1N0 5V 500R	23486-442F
TR1	TR NSI BC108A&B 20V 150M - GEN	28452-787N
TR3	TR NSI BC208B 20V 150M - GEN	28452-781A
TR6	TR NSI BC208B 20V 150M - GEN	28452-781A
TR7	TR NJF J310 25V - 24MA	28459-028E
TR8	TR PSI BC308B 20V 130M - GEN	28433-455R
TR13	TR PSI BC308B 20V 130M - GEN	28433-455R
TR16	TR PSI BC308B 20V 130M - GEN	28433-455R
X100	CABLE ASSY (SKP)	43130-027V
X11	LABEL SSD WARNING ROUND	31739-397C
X10	PCB DETAIL	31829-474N
X12	INS BEAD 185WG BUSH CER	23213-146D
X15	SEE PLF	

Circuit Ref.	Description	Part Number
Unit AA0/2 - RF BOX ASSY A		
10.	When ordering, prefix circuit reference with AA0/2.	
	Complete unit	44990-446L
C1	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C2	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C3	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C4	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C5	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C6	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C7	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C8	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C9	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C10	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C11	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C12	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C13	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C14	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C15	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C16	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C17	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C18	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C19	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C20	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C21	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C22	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C23	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C24	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C25	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C26	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C27	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C28	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C29	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C30	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C31	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C32	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C33	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C34	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
L1	IND CHOKE 5 TURNS	44190-036B
L2	IND CHOKE 5 TURNS	44190-036B
L3	IND CHOKE 5 TURNS	44190-036B
L4	IND CHOKE 5 TURNS	44190-036B
L6	IND CHOKE 5 TURNS	44190-036B
L7	IND CHOKE 5 TURNS	44190-036B
L8	IND CHOKE 5 TURNS	44190-036B
L9	IND CHOKE 5 TURNS	44190-036B
L10	IND CHOKE 5 TURNS	44190-036B

Circuit Ref.	Description	Part Number
Unit AA0/2 - RF BOX ASSY A (Contd.)		
L11	IND CHOKE 5 TURNS	44190-036B
L12	IND CHOKE 2.5 TURNS	44190-909X
L13	IND CHOKE 2.5 TURNS	44190-909X
L14	IND CHOKE 2.5 TURNS	44190-909X
L15	IND CHOKE 2.5 TURNS	44190-909X
L16	IND CHOKE 2.5 TURNS	23642-909X
L17	IND CHOKE 2.5 TURNS	23642-909X
L18	IND CHOKE 2.5 TURNS	23642-909X
X7	FERRITE BEAD	41372-006T
X8	FERRITE BEAD	41372-006T
X9	FERRITE BEAD	41372-006T
X10	FERRITE BEAD	41372-006T
X11	FERRITE BEAD	41372-006T
X12	FERRITE BEAD	41372-006T
X13	FERRITE BEAD	41372-006T
X14	FERRITE BEAD	41372-006T
X15	FERRITE BEAD	41372-006T
X16	FERRITE BEAD	41372-006T
X17	FERRITE BEAD	41372-006T
X18	FERRITE BEAD	41372-006T
X19	FERRITE BEAD	41372-006T
X20	FERRITE BEAD	41372-006T
X21	FERRITE BEAD	41372-006T
X22	FERRITE BEAD	41372-006T
X23	FERRITE BEAD	41372-006T
X24	FERRITE BEAD	41372-006T
X25	FERRITE BEAD	41372-006T
X26	FERRITE BEAD	41372-006T

Unit AA1/1 - SYNTHESIZER PCB

11. When ordering, prefix circuit reference with AA1/1.

	Complete unit	44829-559K
C1	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C2	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C3	CAP CER 10N 50V 20%	26346-120Y
C4	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C5	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C6	CAP CER 10N 50V 20%	26346-120Y
C7	CAP CER 10N 50V 20%	26346-120Y
C8	CAP CER 10N 50V 20%	26346-120Y
C9	CAP CER 10N 50V 20%	26346-120Y
C10	CAP CER 10N 50V 20%	26346-120Y
C11	CAP CER 10N 50V 20%	26346-120Y
C12	CAP CER 10N 50V 20%	26346-120Y
C13	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C14	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C15	CAP CER 10N 50V 20%	26346-120Y

Circuit Ref.	Description	Part Number
Unit AA1/1 - SYNTHESIZER PCB (Contd.)		
C16	CAP CER 100P 63V 2% N150 RAD/T	26343-437N
C17	CAP PS 1N0 63V 1%	26538-902G
C18	CAP ELEC 10U 35V 20%	26421-112Z
C23	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C24	CAP CER 10N 50V 20%	26346-120Y
C25	CAP CER 10N 50V 20%	26346-120Y
C26	CAP CER 10N 50V 20%	26346-120Y
C27	CAP PETP 1U0 50V 10%	26582-432F
C28	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C29	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C30	CAP CER 10N 50V 20%	26346-120Y
C31	CAP CER 10N 50V 20%	26346-120Y
C32	CAP CER 10N 50V 20%	26346-120Y
C33	CAP CER 10N 50V 20%	26346-120Y
C34	CAP CER 10N 50V 20%	26346-120Y
C35	CAP CER 10N 50V 20%	26346-120Y
C36	CAP CER 10N 50V 20%	26346-120Y
C37	CAP CER 10N 50V 20%	26346-120Y
C38	CAP CER 10N 50V 20%	26346-120Y
C39	CAP CER 10N 50V 20%	26346-120Y
C40	CAP CER 10N 50V 20%	26346-120Y
C41	CAP CER 10N 50V 20%	26346-120Y
C42	CAP CER 10N 50V 20%	26346-120Y
C43	CAP PETP 1U0 50V 10%	26582-432F
C44	CAP CER 10N 50V 20%	26346-120Y
C45	CAP CER 10N 50V 20%	26346-120Y
C46	CAP CER 10N 50V 20%	26346-120Y
C47	CAP CER 10N 50V 20%	26346-120Y
C48	CAP CER 10P 63V 2% NPO RAD/T	26343-492R
C49	CAP CER 220P 63V 2% N750 RAD/T	26343-435U
C50	CAP PS 150P 63V 2%	26538-571R
C51	CAP ELEC 33U 25V 20%	26421-115U
C52	CAP ELEC 33U 25V 20%	26421-115U
C55	CAP ELEC 1000U 6V 20%+	26421-128D
C56	CAP CER 4P7 63V .25P NPO RAD/T	26343-485P
C57	CAP PETP 100N 63V 10%	26582-429F
C58	CAP ELEC 10U 35V 20%	26421-112Z
C59	CAP ELEC 10U 35V 20%	26421-112Z
C60	CAP ELEC 10U 35V 20%	26421-112Z
C61	CAP ELEC 10U 35V 20%	26421-112Z
C62	CAP CER 22P 63V 2% N150 RAD/T	26343-489R
C63	CAP CER 120P 63V 2% N150 RAD/T	26343-438L
C64	CAP CER 120P 63V 2% N150 RAD/T	26343-438L
C65	CAP CER 1N0 63V 10% TP2 RAD/T	26383-585M
C70	CAP ELEC 33U 25V 20%	26421-115U
C71	CAP PS 4N7 63V 1%	26538-918A
C72	CAP PS 4N7 63V 1%	26538-918A
C73	CAP PETP 1U0 50V 10%	26582-432F
C74	CAP ELEC 10U 35V 20%	26421-112Z
C75	CAP ELEC 10U 35V 20%	26421-112Z

Circuit Ref.	Description	Part Number
Unit AA1/1 - SYNTHESIZER PCB (Contd.)		
C76	CAP PETP 1U0 50V 10%	26582-432F
C77	CAP PETP 1U0 50V 10%	26582-432F
C78	CAP CER 10N 50V 20%	26346-120Y
D1	DI SIL 1N4148 75V JUNC	28336-676J
D2	DI SIL 1N4148 75V JUNC	28336-676J
D3	DI SIL 1N4148 75V JUNC	28336-676J
D4	DI SIL 1N4148 75V JUNC	28336-676J
D5	DI SIL 1N4148 75V JUNC	28336-676J
D6	DI SIL 1N4148 75V JUNC	28336-676J
D7	DI SIL 1N4148 75V JUNC	28336-676J
D8	DI SIL 1N4148 75V JUNC	28336-676J
D9	DI SIL 1N4148 75V JUNC	28336-676J
D10	DI ZEN BZX79C5V1 5.1V 5%	28371-401U
D11	DI SIL 1N4148 75V JUNC	28336-676J
D12	DI SIL 1N4148 75V JUNC	28336-676J
D13	DI V/CAP BB809 3V 29PF	28381-132G
D14	DI ZEN BZX79C5V1 5.1V 5%	28371-401U
D15	DI SIL 1N4148 75V JUNC	28336-676J
D16	DI SIL 1N4148 75V JUNC	28336-676J
D17	DI SIL 1N4148 75V JUNC	28336-676J
IC1	ICD DIV SP8659B /16 200MHZ	28469-429R
IC2	ICD NAND 74S00N QUAD 2INP	28466-331D
IC3	ICD FF-D 40174 HEX	28462-616Y
IC4	ICD CTR 74LS191 4BIT BIN U/D	28464-022X
IC5	ICD CTR 74LS191 4BIT BIN U/D	28464-022X
IC6	ICD FF-D 74S74 DUAL +EDG TR	28462-607K
IC7	ICD FF-D 74S74 DUAL +EDG TR	28462-607K
IC8	ICD CTR 74LS390 DUAL 4BIT DEC	28464-127R
IC9	ICD DIV SP8906 4MOD PRESCALER	28469-430M
IC10	ICD NAND 74LS00 QUAD 2INP	28466-345H
IC11	ICD FF-D 74LS74 DUAL +EDG TR	28462-611A
IC12	ICA AMP TLO74CN QUAD FET I/P	28461-349H
IC13	ICD FF-D 40174 HEX	28462-616Y
IC14	ICD CTR 74LS390 DUAL 4BIT DEC	28464-127R
IC15	ICD NAND 74LS00 QUAD 2INP	28466-345H
IC16	ICD CTR 74LS191 4BIT BIN U/D	28464-022X
IC17	ICD CTR 74LS191 4BIT BIN U/D	28464-022X
IC18	ICA COMP LM311N DIL8	28461-695U
IC19	ICD FF-D 40174 HEX	28462-616Y
IC20	ICD NAND 74LS00 QUAD 2INP	28466-345H
IC22	ICD FF-D 74LS74 DUAL +EDG TR	28462-611A
IC23	ICD FF-D 40174 HEX	28462-616Y
IC24	ICD FF-D 40174 HEX	28462-616Y
IC25	ICD ARITH 4008 4BIT FULL ADDER	28469-363B
IC26	ICD ARITH 4008 4BIT FULL ADDER	28469-363B

Circuit Ref.	Description	Part Number
Unit AA1/1 - SYNTHESIZER PCB (Contd.)		
IC27	ICD ARITH 4008 4BIT FULL ADDER !	28469-363B
IC28	ICA AMP TLO71CP FET I/P DIL8	28461-347A
IC29	ICD ARITH 4008 4BIT FULL ADDER !	28469-363B
IC30	ICD ARITH 4008 4BIT FULL ADDER !	28469-363B
IC31	ICD FF-D 40174 HEX !	28462-616Y
IC32	ICD FF-D 40174 HEX !	28462-616Y
IC33	ICA DAC AD7524JN 8BIT !	28469-400R
IC34	ICD NAND 74LS132 QUAD 2INP SCH	28469-205N
IC35	ICA MUX 74HC4052 4CH DUAL !	28469-738R
IC36	ICA AMP TLO74CN QUAD FET I/P	28461-349H
L1	IND CHOKE 100UH 10% LAQ	23642-561W
L3	IND CHOKE 1.0UH 10% LAQ	23642-549L
L4	IND CHOKE 1000UH 10% LAQ	23642-567C
PLS	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLT	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLU	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLX	CON-RF SMB-MALE 50RR PCB STR	23444-334Y
PLAA	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLAB	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
R1	RES MF 33K .125W 2% 100PPM	24772-109M
R2	RES MF 51R .125W 2% 100PPM	24772-042M
R3	RES MF 470R .125W 2% 100PPM	24772-065S
R4	RES MF 470R .125W 2% 100PPM	24772-065S
R5	RES MF 150R .125W 2% 100PPM	24772-053E
R6	RES MF 51R .125W 2% 100PPM	24772-042M
R7	RES MF 470R .125W 2% 100PPM	24772-065S
R8	RES MF 470R .125W 2% 100PPM	24772-065S
R9	RES MF 470R .125W 2% 100PPM	24772-065S
R10	RES MF 470R .125W 2% 100PPM	24772-065S
R11	RES MF 39K .125W 2% 100PPM	24772-111X
R12	RES MF 22K .125W 2% 100PPM	24772-105D
R13	RES MF 100K .125W 2% 100PPM	24772-121Z
R14	RES MF 10K .125W 2% 100PPM	24772-097S
R15	RES MF 100K .125W 2% 100PPM	24772-121Z
R16	RES MF 2K2 .125W 2% 100PPM	24772-081K
R17	RES MF 1K0 .125W 2% 100PPM	24772-073X
R18	RES MF 2K2 .125W 2% 100PPM	24772-081K
R19	RES MF 1K0 .125W 2% 100PPM	24772-073X
R20	RES MF 4K7 .125W 2% 100PPM	24772-089L
R21	RES MF 4K7 .125W 2% 100PPM	24772-089L
R22	RES MF 4K7 .125W 2% 100PPM	24772-089L
R27	RES MF 100R .125W 2% 100PPM	24772-049H
R28	RES MF 470R .125W 2% 100PPM	24772-065S
R29	RES MF 1K8 .125W 2% 100PPM	24772-079A
R30	RES MF 470R .125W 2% 100PPM	24772-065S
R31	RES MF 1K8 .125W 2% 100PPM	24772-079A
R32	RES MF 4K7 .125W 2% 100PPM	24772-089L
R33	RES MF 4K7 .125W 2% 100PPM	24772-089L
R34	RES MF 2K2 .125W 2% 100PPM	24772-081K

Circuit Ref.	Description	Part Number
Unit AA1/1 - SYNTHESIZER PCB (Contd.)		
R35	RES MF 100K .125W 2% 100PPM	24772-121Z
R36	RES MF 10K .125W 2% 100PPM	24772-097S
R37	RES MF 18K .125W 2% 100PPM	24772-103S
R38	RES MF 1K0 .125W 2% 100PPM	24772-073X
R39	RES MF 470R .125W 2% 100PPM	24772-065S
R40	RES MF 470R .125W 2% 100PPM	24772-065S
R41	RES MF 2K2 .125W 2% 100PPM	24772-081K
R42	RES MF 1K0 .125W 2% 100PPM	24772-073X
R46	RES MF 16K .125W 2% 100PPM	24772-102V
R47	RES MF 4K7 .125W 2% 100PPM	24772-089L
R49	RES MF 1K0 .125W 2% 100PPM	24772-073X
R50	RES MF 100R .25W 2% 100PPM	24773-249J
R51	RES MF 100R .25W 2% 100PPM	24773-249J
R52	RES MF 100K .125W 2% 100PPM	24772-121Z
R53	RES MF 24K .125W 2% 100PPM	24772-106T
R54	RES MF 24K .125W 2% 100PPM	24772-106T
R55	RES MF 2K2 .125W 2% 100PPM	24772-081K
R56	RES MF 2K2 .125W 2% 100PPM	24772-081K
R57	RES MF 68K .125W 2% 100PPM	24772-117A
R58	RES MF 680R .125W 2% 100PPM	24772-069P
R60	RES MF 30K0 .25W 0.5% 50PPM	24753-540D
R61	RES MF 54K6 .25W 0.5% 50PPM	24753-582B
R62	RES MF 18K0 .25W 0.5% 50PPM	24753-344K
R63	RES MF 15K83 .25W 0.5% 25PPM	24753-560Y
R64	RES MF 2K .25W 0.5% 50PPM	24753-626U
R65	RES MF 4K7 .25W 0.5% 50PPM	24753-484H
R66	RES MF 680R .125W 2% 100PPM	24772-069P
R67	RES MF 390R .125W 2% 100PPM	24772-063G
R68	RES MF 33R .125W 2% 100PPM AX	24772-037P
R69	RES MF 620R .125W 2% 100PPM	24772-068T
R70	RES MF 1M0 .125W 2% 100PPM	24772-141T
R71	RES MF 1M0 .125W 2% 100PPM	24772-141T
R72	RES MF 1K0 .125W 2% 100PPM	24772-073X
R73	RES MF 100K .125W 2% 100PPM	24772-121Z
R74	RES MF 2K2 .125W 2% 100PPM	24772-081K
R75	RES MF 4K7 .125W 2% 100PPM	24772-089L
R76	RES MF 330K .125W 2% 100PPM	24772-133G
R77	RES MF 330K .125W 2% 100PPM	24772-133G
R78	RES MF 6K8 .125W 2% 100PPM	24772-093J
R79	RES MF 10K .125W 2% 100PPM	24772-097S
R80	RES MF 1K0 .125W 2% 100PPM	24772-073X
R81	RV CERM 2K LI .5W 10% HORZ	25711-639V
R82	RES MF 1K3 .125W 2% 100PPM	24772-076R
R83	RES MF 30K0 .25W 0.5% 50PPM	24753-540D
R84	RES MF 54K6 .25W 0.5% 50PPM	24753-582B
R85	RES MF 18K0 .25W 0.5% 50PPM	24753-344K
R86	RES MF 15K83 .25W 0.5% 25PPM	24753-560Y
R87	RES MF 2K .25W 0.5% 50PPM	24753-626U
R88	RES MF 4K7 .25W 0.5% 50PPM	24753-484H
R89	RES MF 470R .125W 2% 100PPM	24772-065S

Circuit Ref.	Description	Part Number
Unit AA1/1 - SYNTHESIZER PCB (Contd.)		
R90	RES MF 470R .125W 2% 100PPM	24772-065S
R91	RES MF 470R .125W 2% 100PPM	24772-065S
R92	RES MF 470R .125W 2% 100PPM	24772-065S
R93	RES MF 150R .125W 2% 100PPM	24772-053E
TR1	TR NSI BC208B 20V 150M - GEN	28452-781A
TR2	TR PSI BC308B 20V 100MA - GEN	28433-455R
TR3	TR NSI BC208B 20V 150M - GEN	28452-781A
TR4	TR PSI BC308B 20V 100MA - GEN	28433-455R
TR5	TR PSI BC308B 20V 100MA - GEN	28433-455R
TR6	TR NSI 2N2369 15V 500M - SW	28452-197H
TR7	TR NSI BC208B 20V 150M - GEN	28452-781A
TR8	TR PSI BC308B 20V 100MA - GEN	28433-455R
TR9	TR NSI 2N2369 15V 500M - SW	28452-197H
TR10	TR PSI BC308B 20V 100MA - GEN	28433-455R
TR11	TR NSI BC208B 20V 150M - GEN	28452-781A
TR12	TR NSI BC208B 20V 150M - GEN	28452-781A
TR13	TR NJF J310 25V - 24MA	28459-028E
X1	10MHZ OSCILLATOR(HS)OCXO	44990-418V
X2	XTAL 10M P30P 20R	28312-047U
X13	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
X14	CON JUMP FEM 2 9.6MM	23435-990X
X15	S/C-ACC PAD TO18,ETC TO .1"GRD	28488-115L
X16	S/C-ACC PAD TO5 TO DIL8	28488-102R

Circuit Ref.	Description	Part Number
Unit AA2/1 - MICROPROCESSOR PCB		
12.	When ordering, prefix circuit reference with AA2/1.	
	Complete unit	44829-556C
C3	CAP ELEC 4U7 35V 20%	26421-108A
C4	CAP CER 10N 50V 20%	26346-120Y
C5	CAP CER 10N 50V 20%	26346-120Y
C6	CAP CER 10N 50V 20%	26346-120Y
C7	CAP CER 10N 50V 20%	26346-120Y
C8	CAP PETP 100N 63V 10%	26582-429F
C9	CAP CER 10N 50V 20%	26346-120Y
C10	CAP CER 10N 50V 20%	26346-120Y
C11	CAP CER 10N 50V 20%	26346-120Y
C12	CAP CER 10N 50V 20%	26346-120Y
C15	CAP CER 10N 50V 20%	26346-120Y
C16	CAP CER 10N 50V 20%	26346-120Y
C19	CAP ELEC 47U 63V 20%+	26421-121L
D2	DI ZEN 1N825/A 6.2V 5%	28371-494Z
D6	DI SIL 1N4148 75V JUNC	28336-676J
IC1	ICA AMP TLO71CP FET I/P DIL8	28461-347A
IC2	ICM MP P8085A 8BIT NMOS	28469-396K
IC3	ICD CTR 74HC393 DUAL 4BIT BIN	28464-143L
IC4	ICD DIV 4020 14STAGE	28464-107N
IC5	ICD LATCH 74HC373 OCT 3ST	28462-419S
IC6	ICD AND 74HC08 QUAD 2INP	28466-020S
IC7	ICM PROM 27C512-20 64KX8 200NS	28471-029M
IC8	ICD DEC/DMX 74HC138 3-8	28465-040P
IC9	ICD OR 74HC32 QUAD 2INP	28466-112Y
IC10	ICD BUFF 74HCT125 QUAD 3ST	28469-010S
IC11	ICD FF-D 74HC175 QUAD +EDGE TR	28462-623F
IC12	ICM RAM HM6116P-4 2KX8 200NS	28469-307N
IC13	ICM PROM 2817A-25 2KX8 200NSEA	28471-025D
IC14	ICD FF-D 40174 HEX	28462-616Y
IC15	ICD FF-D 40174 HEX	28462-616Y
PLAA	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLAB	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
PLAC	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
R1	RV CERM 1K LI .5W 10% HORZ	25711-638G
R2	RES MF 3K9 .25W 2% 100PPM	24773-287V
R3	RES MF 3K0 .25W 2% 100PPM	24773-284J
R8	RES MF 4K7 .25W 2% 100PPM	24773-289W
R9	RES MF 4K7 .25W 2% 100PPM	24773-289W
R10	RES MF 1K0 .25W 2% 100PPM	24773-273A
R11	RES MF 150K .25W 2% 100PPM	24773-325V
R12	RES MF 1K0 .25W 2% 100PPM	24773-273A
R13	RES MF 10K .25W 2% 100PPM	24773-297M
R14	RES MF 10K .25W 2% 100PPM	24773-297M

REPLACEABLE PARTS

Circuit Ref.	Description	Part Number
Unit AA2/1 - MICROPROCESSOR PCB (Contd.)		
R16	RES MF 10K .25W 2% 100PPM	24773-297M
R17	RES MF 1K0 .25W 2% 100PPM	24773-273A
R18	RES MF 3K0 .25W 2% 100PPM	24773-284J
R19	RES MF 3K0 .25W 2% 100PPM	24773-284J
TR2	TR NSI BC208B 20V 150M - GEN	28452-781A
X12	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
X13	CON JUMP FEM 2 9.6MM	23435-990X
X15	S/C-ACC SKT DIL28 LOW PROFILE	28488-045L

Circuit Ref.	Description	Part Number
Unit AB0/2 - RF BOX ASSY B		
13.	When ordering, prefix circuit reference with AB0/2.	
	Complete unit	44990-447J
C1	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C2	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C3	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C4	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C5	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C6	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C7	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C8	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C9	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C10	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C11	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C12	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C13	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C14	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C15	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C16	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C17	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C18	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C19	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C20	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C21	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C22	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C23	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C24	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C25	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C26	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C27	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C28	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C29	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
C30	CAP CER 1N0 300V 20%+ L/T SOL	26373-733K
L1	IND CHOKE 5 TURNS	44190-036B
L2	IND CHOKE 5 TURNS	44190-036B
L3	IND CHOKE 5 TURNS	44190-036B
L4	IND CHOKE 5 TURNS	44190-036B
L5	IND CHOKE 5 TURNS	44190-036B
L6	IND CHOKE 5 TURNS	44190-036B
L7	IND CHOKE 5 TURNS	44190-036B
L8	IND CHOKE 5 TURNS	44190-036B
L9	IND CHOKE 5 TURNS	44190-036B
L10	IND CHOKE 5 TURNS	44190-036B
L11	IND CHOKE 5 TURNS	44190-036B
L12	IND CHOKE 5 TURNS	44190-036B
L13	IND CHOKE 2.5 TURNS	23642-909X
L14	IND CHOKE 2.5 TURNS	23642-990X
L15	IND CHOKE 2.5 TURNS	23642-990X

Circuit Ref.	Description	Part Number
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Unit AB0/2 - RF BOX ASSY B (Contd.)		
X4	FERRITE BEAD	41372-006T
X5	FERRITE BEAD	41372-006T
X6	FERRITE BEAD	41372-006T
X7	FERRITE BEAD	41372-006T
X8	FERRITE BEAD	41372-006T
X9	FERRITE BEAD	41372-006T
X10	FERRITE BEAD	41372-006T
X11	FERRITE BEAD	41372-006T
X12	FERRITE BEAD	41372-006T
X13	FERRITE BEAD	41372-006T
X14	FERRITE BEAD	41372-006T
X15	FERRITE BEAD	41372-006T
X16	FERRITE BEAD	41372-006T
X17	FERRITE BEAD	41372-006T
X18	FERRITE BEAD	41372-006T
X19	FERRITE BEAD	41372-006T

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING		
14.	When ordering, prefix circuit reference with AB1/2.	
	Complete unit	44829-574J
C1	CAP ELEC 220U 10V 20%+	26415-817J
C2	CAP CER 220P 63V 10%	26383-595H
C3	CAP CER 10P 50V 10%	26343-570H
C4	CAP CER 22P 50V 10%	26343-572U
C5	CAP CER 220P 63V 10%	26383-595H
C6	CAP TANT 10U 35V 20%	26486-225C
C7	CAP-VAR PLAS 22P 2P TRIM	26878-407U
C8	CAP CER 220P 63V 10%	26383-595H
C11	CAP CER 220P 63V 10%	26383-595H
C12	CAP TANT 1UO 35V 20%	26486-209F
C13	CAP CER 220P 63V 10%	26383-595H
C14	CAP CER 220P 63V 10%	26383-595H
C15	CAP CER 33P 63V 2%	26343-494K
C16	CAP CER 220P 63V 10%	26383-595H
C17	CAP CER 220P 63V 10%	26383-595H
C18	CAP-VAR PLAS 65P 5P5 TRIM	26878-408Y
C19	CAP CER 220P 63V 10%	26383-595H
C20	CAP CER 18P 63V 2%	26343-498E
C21	CAP CER 220P 63V 10%	26383-595H
C23	CAP CER 220P 63V 10%	26383-595H
C24	CAP CER 33P 63V 2%	26343-494K
C25	CAP CER 47P 63V 2%	26343-433H
C26	CAP CER 33P 63V 2%	26343-494K
C27	CAP PC 1N0 100V 5%	26531-107L
C29	CAP PC 1N0 100V 5%	26531-107L
C30	CAP CER 220P 63V 10%	26383-595H
C31	CAP-VAR PLAS 22P 2P TRIM	26878-407U
C32	CAP ELEC 220U 10V 20%+	26415-817J
C33	CAP CER 15P 50V 10%	26343-571E
C34	CAP CER 15P 50V 10%	26343-571E
C35	CAP ELEC 220U 16V 20%+	26421-124G
C36	CAP CER 220P 63V 10%	26383-595H
C37	CAP CER 220P 63V 10%	26383-595H
C38	CAP-VAR PLAS 65P 5P5 TRIM	26878-408Y
C39	CAP ELEC 220U 10V 20%+	26415-817J
C40	CAP CER 33P 50V 10%	26343-573Y
C41	CAP CER 33P 50V 10%	26343-573Y
C42	CAP ELEC 220U 16V 20%+	26421-124G
C43	CAP CER 220P 63V 10%	26383-595H
C47	CAP CER 220P 63V 10%	26383-595H
C48	CAP CER 1N0 63V 10%	26383-585M
C49	CAP CER 220P 63V 10%	26383-595H

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
C57	CAP CER 220P 63V 10%	26383-595H
C58	CAP CER 15P 63V 2%	26343-493B
C59	CAP CER 1N0 63V 10%	26383-585M
C60	CAP CER 5P6 63V .25P	26343-486X
C61	CAP CER 8P2 63V .25P	26343-488C
C62	CAP CER 6P8 63V .25P	26343-487M
C63	CAP CER 15P 63V 2%	26343-493B
C64	CAP CER 10P 63V 2%	26343-492R
C65	CAP CER 18P 63V 2%	26343-498E
C66	CAP CER 2P7 63V .25P	26343-484T
C67	CAP CER 10P 63V 2%	26343-492R
C68	CAP CER 1N0 63V 10%	26383-585M
C71	CAP CER 1N0 63V 10%	26383-585M
C72	CAP CER 3P9 63V .25P	26343-496Z
C73	CAP CER 12P 63V 2%	26343-497H
C74	CAP CER 220P 63V 10%	26383-595H
C75	CAP CER 1N0 63V 10%	26383-585M
C77	CAP CER 1N0 63V 10%	26383-585M
C78	CAP CER 2P7 63V .25P	26343-484T
C79	CAP CER 22P 63V 2%	26343-489R
C80	CAP CER 220P 63V 10%	26383-595H
C81	CAP CER 1N0 63V 10%	26383-585M
C82	CAP CER 220P 63V 10%	26383-595H
C83	CAP CER 15P 63V 2%	26343-493B
C84	CAP CER 10N 25V 20%	26383-006C
C85	CAP CER 220P 63V 10%	26383-595H
C86	CAP CER 33P 63V 2%	26343-494K
C87	CAP CER 22P 63V 2%	26343-489R
C88	CAP CER 22P 63V 2%	26343-489R
C89	CAP CER 33P 63V 2%	26343-494K
C90	CAP CER 5P6 63V .25P	26343-486X
C91	CAP CER 68P 63V 2%	26343-434E
C93	CAP CER 68P 63V 2%	26343-434E
C95	CAP CER 1N0 63V 10%	26383-585M
C96	CAP CER 4P7 63V .25P	26343-485P
C97	CAP CER 220P 63V 10%	26383-595H
C98	CAP CER 220P 63V 10%	26383-595H
C101	CAP CER 1N0 63V 10%	26383-585M
C102	CAP CER 1N0 63V 10%	26383-585M
C103	CAP CER 220P 63V 10%	26383-595H
C104	CAP PETP 47N 63V 10%	26582-428J
C106	CAP PETP 47N 63V 10%	26582-428J
C107	CAP CER 220P 63V 10%	26383-595H
C108	CAP CER 1N0 63V 10%	26383-585M
C109	CAP CER 1N0 63V 10%	26383-585M
C110	CAP PETP 47N 63V 10%	26582-428J
C111	CAP CER 100P 63V 2%	26343-437N
C112	CAP CER 1N0 63V 10%	26383-585M

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
C113	CAP CER 82P 63V 2%	26343-431A
C114	CAP CER 100P 63V 2%	26343-437N
C115	CAP CER 33P 50V 10%	26343-573Y
C116	CAP PETP 47N 63V 10%	26582-428J
C117	CAP CER 220P 63V 10%	26383-595H
C127	CAP CER 220P 63V 10%	26383-595H
C128	CAP CER 68P 63V 2%	26343-434E
C129	CAP CER 220P 63V 10%	26383-595H
C132	CAP CER 220P 63V 10%	26383-595H
C134	CAP CER 39P 63V 2%	26343-430K
C135	CAP ELEC 33U 25V 20%	26421-115U
C136	CAP CER 220P 63V 10%	26383-595H
C137	CAP CER 1N0 63V 10%	26383-585M
C138	CAP CER 220P 63V 10%	26383-595H
C141	CAP CER 220P 63V 10%	26383-595H
C142	CAP CER 1N0 63V 10%	26383-585M
C143	CAP PC 1N0 100V 5%	26531-107L
C144	CAP PETP 100N 63V 10%	26582-429F
C145	CAP CER 220P 63V 10%	26383-595H
C146	CAP PETP 100N 63V 10%	26582-429F
C147	CAP CER 220P 63V 10%	26383-595H
C148	CAP CER 4P7 63V .25P	26343-485P
C149	CAP CER 22P 63V 2%	26343-489R
C150	CAP CER 220P 63V 10%	26383-595H
C155	CAP CER 220P 63V 10%	26383-595H
C156	CAP ELEC 33U 25V 20%	26421-115U
C157	CAP CER 1N0 63V 10%	26383-585M
C158	CAP CER 1N0 63V 10%	26383-585M
C160	CAP TANT 1U0 35V 20%	26486-209F
C161	CAP CER 120P 63V 2%	26343-438L
C162	CAP TANT 1U0 35V 20%	26486-209F
C164	CAP TANT 1U0 35V 20%	26486-209F
C165	CAP CER 1P8 63V .25P	26343-490M
C166	CAP CER 1N0 63V 10%	26383-585M
C169	CAP CER 1N0 63V 10%	26383-585M
C170	CAP TANT 1U0 35V 20%	26486-209F
C171	CAP CER 1N0 63V 10%	26383-585M
C172	CAP CER 4P7 63V .25P	26343-485P
C173	CAP CER 4P7 63V .25P	26343-485P
C174	CAP TANT 1U0 35V 20%	26486-209F
C175	CAP CER 4N7 63V 10%	26383-591B
C176	CAP TANT 1U0 35V 20%	26486-209F
C177	CAP CER 1N0 63V 10%	26383-585M
C178	CAP TANT 1U0 35V 20%	26486-209F
C179	CAP PETP 22N 63V 10%	26582-431J
C180	CAP PETP 22N 63V 10%	26582-431J
C181	CAP CER 1P8 63V .25P	26343-490M

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
D1	DI V/CAP BB405B 3V 11.5PF	28381-101V
D2	DI PIN 5082-3379 50V !	28383-997T
D4	DI PIN 5082-3379 50V !	28383-997T
D5	DI V/CAP BB809 3V 29PF	28381-132G
D7	DI V/CAP BB809 3V 29PF	28381-132G
D8	DI SIL BA482 35V JUNC	28335-675R
D11	DI SIL BA482 35V JUNC	28335-675R
D12	DI V/CAP BB405B 3V 11.5PF	28381-101V
D13	DI V/CAP BB405B 3V 11.5PF	28381-101V
D14	DI SIL BA482 35V JUNC	28335-675R
D18	DI SIL BA482 35V JUNC	28335-675R
D20	DI SIL BA482 35V JUNC	28335-675R
D21	DI PIN 5082-3379 50V !	28383-997T
D22	DI PIN 5082-3379 50V !	28383-997T
D23	DI SIL BA482 35V JUNC	28335-675R
D24	DI H/CARR HP5082-2811 1.0V !	28349-008U
D25	DI SIL BA482 35V JUNC	28335-675R
D26	DI SIL BA482 35V JUNC	28335-675R
D27	DI H/CARR 5082-2080 MATCHED QUAD !	44529-106X
D30	DI H/CARR 5082-2080 " " !	44529-106X
D31	DI SIL BA482 35V JUNC	28335-675R
D32	DI SIL BA482 35V JUNC	28335-675R
D33	DI H/CARR 5082-2826 MATCHED PAIR !	44529-057F
D34	DI V/CAP BB809 3V 29PF	28381-132G
D37	DI V/CAP BB809 3V 29PF	28381-132G
D38	DI PIN 5082-3379 50V !	28383-997T
D41	DI PIN 5082-3379 50V !	28383-997T
D42	DI H/CARR 5082-2826 MATCHED PAIR !	44529-057F
D43	DI H/CARR 5082-2826 " "	44529-057F
D44	DI H/CARR 5082-2826 " "	44529-057F
D45	DI SIL 1N4148 75V JUNC	28336-676J
D50	DI SIL 1N4148 75V JUNC	28336-676J
D51	DI ZEN BZX79C6V8 6.8V 5%	28371-550W
D52	DI RECT BAV99 70V DOUBLE SOT23	28383-903X
D53	DI ZEN BZX79C6V8 6.8V 5%	28371-550W
D54	DI SIL 1N4148 75V JUNC	28336-676J
D57	DI SIL 1N4148 75V JUNC	28336-676J
IC1	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z
IC2	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z
IC3	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z
IC4	ICD INV 74LS04 HEX	28469-171L
IC5	ICD NAND 7438 QUAD 2INP O/C BF	28466-334X
IC6	ICD NAND 74LS26 QUAD 2INP HV	28466-350U
IC7	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z
IC8	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z
IC9	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z
IC10	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
IC11	ICD FF-D SP9131 DUAL M/SLAVE	28462-112V
IC12	ICA AMP TL072CP DUAL FET I/P	28461-348Z
IC13	MOD HYB OM360 40-860MHZ AMP	28461-366W
IC14	MOD HYB OM345 VHF/UHF AMP SIL	28461-351Z
IC15	ICA AMP TL072CP DUAL FET I/P	28461-348Z
L5	IND CHOKE 2U2 10% MINIATURE	23642-420F
L7	IND CHOKE 2U2 10% MINIATURE	23642-420F
L9	IND CHOKE .47UH 10% LAQ	23642-547Y
L16	IND CHOKE .47UH 10% LAQ	23642-547Y
L17	IND CHOKE 2.2UH 10% LAQ	23642-551N
L18	IND CHOKE .68UH 10% LAQ	23642-548N
L19	IND CHOKE .47UH 10% LAQ	23642-547Y
L24	IND CHOKE 2.2UH 10% LAQ	23642-551N
L25	IND CHOKE .47UH 10% LAQ	23642-547Y
L26	IND CHOKE 2U2 10% MINIATURE	23642-420F
L27	IND CHOKE 2.2UH 10% LAQ	23642-551N
L28	IND CHOKE 2.2UH 10% LAQ	23642-551N
L30	IND CHOKE .22UH 10% LAQ	23642-545E
L31	IND RF-7T	44290-952R
L33	IND CHOKE 2U2 10% MINIATURE	23642-420F
L34	IND CHOKE 2.2UH 10% LAQ	23642-551N
L35	IND CHOKE 2.2UH 10% LAQ	23642-551N
L36	IND CHOKE 2U2 10% MINIATURE	23642-420F
L37	IND CHOKE .047UH MINATURE	23624-044S
L40	IND RF-7T	44290-952R
PLAD	TERM C/PIN 0.64SQX6 S/E REEL	23435-188V
R1	RES MF 1K0 .25W 2% 100PPM	24773-273A
R2	RES MF 1K0 .25W 2% 100PPM	24773-273A
R3	RES MF 100R .25W 2% 100PPM	24773-249J
R4	RES MF 68K .25W 2% 100PPM	24773-317N
R5	RES MF 100R .25W 2% 100PPM	24773-249J
R6	RES MF 47R .25W 2% 100PPM	24773-241A
R7	RES MF 47R .25W 2% 100PPM	24773-241A
R8	RES MF 10K .25W 2% 100PPM	24773-297M
R9	RES MF 4K7 .25W 2% 100PPM	24773-289W
R10	RES MF 3K0 .25W 2% 100PPM	24773-284J
R11	RES MF 3K0 .25W 2% 100PPM	24773-284J
R12	RES MF 4K7 .25W 2% 100PPM	24773-289W
R13	RES MF 1K0 .25W 2% 100PPM	24773-273A
R14	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R15	RES MF 22R .25W 2% 100PPM	24773-233M
R16	RES MF 10R .125W 2% 100PPM	24772-025L
R17	RES MF 10K .25W 2% 100PPM	24773-297M
R18	RES MG 4M7 .25W 5%	24321-881F
R19	RES MF 1K0 .25W 2% 100PPM	24773-273A
R20	RES MF 220R .25W 2% 100PPM	24773-257W

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
R21	RES MF 47K .25W 2% 100PPM	24773-313H
R22	RES MF 1M0 .25W 2% 100PPM	24773-346E
R23	RES MF 1M0 .25W 2% 100PPM	24773-346E
R24	RES MF 100R .25W 2% 100PPM	24773-249J
R25	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R26	RES MF 10K .25W 2% 100PPM	24773-297M
R27	RES CC 43R .125W 5%	24331-995C
R28	RES MF 470R .25W 2% 100PPM	24773-265M
R29	RES MF 100R .25W 2% 100PPM	24773-249J
R31	RES MF 100R .25W 2% 100PPM	24773-249J
R32	RES CC 22R .125W 5%	24331-988T
R33	RES CC 22R .125W 5%	24331-988T
R34	RES CC 10R .125W 5%	24331-974U
R35	RES MF 100R .25W 2% 100PPM	24773-249J
R36	RES MF 10K .25W 2% 100PPM	24773-297M
R37	RES CC 56R .125W 5%	24331-944N
R38	RES MF 470R .25W 2% 100PPM	24773-265M
R39	RES MF 100R .25W 2% 100PPM	24773-249J
R41	RES MF 100R .25W 2% 100PPM	24773-249J
R42	RES CC 22R .125W 5%	24331-988T
R43	RES CC 22R .125W 5%	24331-988T
R44	RES CC 10R .125W 5%	24331-974U
R45	RES MF 100R .25W 2% 100PPM	24773-249J
R49	RES MF 100R .25W 2% 100PPM	24773-249J
R50	RES MF 18R .25W 2% 100PPM	24773-231P
R51	RES MF 10K .25W 2% 100PPM	24773-297M
R52	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R55	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R56	RES MF 100K .25W 2% 100PPM	24773-321L
R57	RES MF 4K7 .25W 2% 100PPM	24773-289W
R58	RES MF 330R .25W 2% 100PPM	24773-261D
R59	RES MF 270R .25W 2% 100PPM	24773-259T
R60	RES MF 330R .25W 2% 100PPM	24773-261D
R61	RES MF 270R .25W 2% 100PPM	24773-259T
R62	RES MF 4K7 .25W 2% 100PPM	24773-289W
R63	RES MF 100K .25W 2% 100PPM	24773-321L
R64	RES MF 100K .25W 2% 100PPM	24773-321L
R66	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R67	RES MF 4K7 .25W 2% 100PPM	24773-289W
R68	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R69	RES MF 62R .25W 2% 100PPM	24773-244E
R70	RES CC 51R .125W 5%	24331-989P
R72	RES MF 1R0 .125W 2%	24772-001S
R74	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R75	RES MF 1K0 .25W 2% 100PPM	24773-273A

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
R76	RES MF 4K7 .25W 2% 100PPM	24773-289W
R77	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R78	RES MF 270R .25W 2% 100PPM	24773-259T
R79	RES MF 270R .25W 2% 100PPM	24773-259T
R80	RES CC 47R .125W 5%	24331-975Y
R81	RES MF 47K .25W 2% 100PPM	24773-313H
R82	RES MF 220K .25W 2% 100PPM	24773-329T
R89	RES MF 1K0 .25W 2% 100PPM	24773-273A
R90	RES MF 2K0 .25W 2% 100PPM	24773-280U
R91	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R92	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R93	RES MF 220R .25W 2% 100PPM	24773-257W
R97	RES MF 47K .125W 2% 100PPM	24772-113C
R98	RES MF 100R .125W 2% 100PPM	24772-049H
R99	RES MF 470R .25W 2% 100PPM	24773-265M
R100	RES MF 100K .25W 2% 100PPM	24773-321L
R101	RV CERM 100K LI .5W 10%	25711-644W
R102	RES MF 4K7 .25W 2% 100PPM	24773-289W
R103	RES MG 10M .25W 5%	24321-885W
R104	RES MF 470K .25W 2% 100PPM	24773-337R
R105	RES MF 470K .25W 2% 100PPM	24773-337R
R106	RES MG 10M .25W 5%	24321-885W
R107	RES MF 47K .125W 2% 100PPM	24772-113C
R108	RES MF 100K .25W 2% 100PPM	24773-321L
R109	RES MF 220R .25W 2% 100PPM	24773-257W
R110	RES MF 10K .25W 2% 100PPM	24773-297M
R111	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R112	RES MF 2K2 .25W 2% 100PPM	24773-281Y
R113	RES MF 220R .25W 2% 100PPM	24773-257W
R114	RES MF 6K2 .25W 2% 100PPM	24773-292W
R116	RES MF 470K .25W 2% 100PPM	24773-337R
R118	RES MF 470K .25W 2% 100PPM	24773-337R
R119	RES MF 100R .25W 2% 100PPM	24773-249J
R120	RES MF 4K7 .25W 2% 100PPM	24773-289W
R121	RES MF 1K5 .25W 2% 100PPM	24773-277U
R122	RES MF 50R0 .25W 1% 100PPM	24762-558R
R123	RES MF 50R0 .25W 1% 100PPM	24762-558R
R124	RES MF 5K1 .1W 1% 100PPM	24421-598W
R125	RES CC 100R .125W 5%	24331-997B
R126	RES MF 3K0 .25W 2% 100PPM	24773-284J
R127	RES MF 12K .25W 2% 100PPM	24773-299R
R128	RES MF 4K7 .25W 2% 100PPM	24773-289W
R129	RES MF 4K7 .25W 2% 100PPM	24773-289W
R130	RES MF 51R .25W 2% 100PPM	24773-242Z
R131	RES MF 1K0 .25W 2% 100PPM	24773-273A

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
R132	RES MF 33R .25W 2% 100PPM	24773-237K
R133	RES MF 22R .25W 2% 100PPM	24773-233M
R134	RES MF 470R .25W 2% 100PPM	24773-265M
R135	RES MF 330R .25W 2% 100PPM	24773-261D
R136	RES MF 51R .25W 2% 100PPM	24773-242Z
R137	RES MF 130R .25W 2% 100PPM	24773-252J
R138	RES MF 22R .25W 2% 100PPM	24773-233M
R139	RES MF 22R .25W 2% 100PPM	24773-233M
R140	RES MF 10R .25W 2% 100PPM	24773-225W
R141	RES MF 27R .125W 2% 100PPM	24772-035D
R142	RES MF 10R .25W 2% 100PPM	24773-225W
R143	RES MF 3K9 .25W 2% 100PPM	24773-287V
R144	RES MF 910R .125W 2% 100PPM	24772-072P
R145	RES MF 2K0 .125W 2% 100PPM	24772-080B
R146	RES MF 68R .25W 2% 100PPM	24773-245U
R147	RES MF 510R .125W 2% 100PPM	24772-066W
R148	RES CC 150R .125W 5%	24331-990D
R149	RES MG 16R .125W 5%	24681-043E
R150	RES MG 16R .125W 5%	24681-043E
R151	RES CC 270R .125W 5%	24331-992P
R152	RES MF 510R .125W 2% 100PPM	24772-066W
R153	RES MF 91R .125W 2% 100PPM	24772-048Z
R154	RES MF 2K0 .125W 2% 100PPM	24772-080B
R155	RES MF 8R2 .25W 2% 100PPM	24773-223V
R156	RES MG 16R .125W 2% 200PPM	24321-730B
R157	RES MG 16R .125W 2% 200PPM	24321-730B
R158	RES MF 4R7 .125W 2% 100PPM	24772-017H
R159	RES MF 100R .125W 2% 100PPM	24772-049H
R160	RES CC 4R7 .125W 5%	24331-985S
R161	RES MF 220R .125W 2% 100PPM	24772-057L
RLA	RELAY MAG 2CO 5V 100R	23486-146C
TR1	TR NJF J310 25V - 24MA	28459-028E
TR2	DI CUR-REG J510 50V 3.6MA TO92	28383-984Y
TR3	TR PSI 2N4959 30V 1G - LN AMP	28433-836K
TR4	TR PSI 2N4959 30V 1G - LN AMP	28433-836K
TR5	TR PSI BC308B 20V 130M - GEN	28433-455R
TR6	TR NSI BC208B 20V 150M - GEN	28452-781A
TR7	TR NSI BFR91A 12V 6G - AMP	28451-694H
TR8	TR PSI BC308B 20V 130M - GEN	28433-455R
TR9	TR NSI BC208B 20V 150M - GEN	28452-781A
TR10	TR NSI BFR91A 12V 6G - AMP	28451-694H
TR13	TR PSI BC308B 20V 130M - GEN	28433-455R
TR14	TR NSI BFR96S 15V 5G - AMP	28452-172N
TR17	TR NSI BFR96S 15V 5G - AMP	28452-172N
TR18	TR PSI BC308B 20V 130M - GEN	28433-455R
TR19	TR NSI BFG96 15 5GHZ 150MA S	28452-156C
TR20	TR NSI MRF587 17V 5.5GHZ 200M	28452-231B
TR21	TR PSI BC308B 20V 130M - GEN	28433-455R

Circuit Ref.	Description	Part Number
Unit AB1/2 - RF PROCESSING (Contd.)		
T1	TRANSFORMER ASSY (3.5 TURNS)	43590-140U
T4	TRANSFORMER ASSY (3.5 TURNS)	43590-140U
T5	TRANSFORMER ASSY (1.5 TURNS)	43590-143L
X1	MOD RF TFM2 DOUBLE BAL MIXER	28531-003Z

Unit AC0 - ATTENUATOR

15. When ordering, prefix circuit reference with AC0.

Complete unit 44429-029N

Unit AD0 - GPIB MODULE

16. When ordering, prefix circuit reference with AD0.

Complete unit 54433-003N

MP1	SHROUD MOUNTING	35904-293P
MP2	SPACER SPECIAL ST/CD STUDMOUNT	33900-539L

Unit AD1 - GPIB PCB

17. When ordering, prefix circuit reference with AD1.

Complete unit 44828-785H

C1	CAP PETP 470N 63V 10% RAD MIN	26582-427L
C2	CAP PETP 470N 63V 10% RAD MIN	26582-427L
C3	CAP CER 10N 50V 20% X7R MON AX	26346-120Y
C4	CAP CER 10N 50V 20% X7R MON AX	26346-120Y
C5	CAP CER 10N 50V 20% X7R MON AX	26346-120Y
C6	CAP CER 10N 50V 20% X7R MON AX	26346-120Y
C7	CAP CER 10N 50V 20% X7R MON AX	26346-120Y
C8	CAP CER 2N2 63V 10% PLATE	26383-587R
IC1	ICD INV 74LS14 HEX SCHM	28469-176S
IC2	ICD MP SUP 8291A GPIB TALK/LIS !	28467-014C
IC3	ICD BUFF 3448 QUAD GPIBTXRX 3S	28469-190R
IC4	ICD BUFF 3448 QUAD GPIBTXRX 3S	28469-190R
IC5	ICD BUFF 3448 QUAD GPIBTXRX 3S	28469-190R
IC6	ICD BUFF 3448 QUAD GPIBTXRX 3S	28469-190R
L1	IND CHOKE 100UH 10% LAQ	23642-561W
R1	RES MF 330R 1/4W 2% 100PPM	24773-261D

MECHANICAL COMPONENTS

18. Order without prefix.

Fig. 6-1
Item

Description

Part
Number

1	Button outer cover	35903-668Y
2	Front panel switch caps (see keyboard, Unit A1 for individual part numbers)	
3	Front panel, screen printed	35890-084K
4	Frame casting; front, painted	35890-084K
5	Plug	37590-293K
6	Foot	37590-224R
7	Top cover - stone grey	35904-009F
8	Rear frame casting	35890-101L
9	Rear foot	37590-840M
10	Side rail	34900-812Z
11	Selector plate	35902-441Z
12	GPB blanking plate	35904-290W
13	Cap	37590-219M
14	Boss	37590-220P
15	Handle assembly	41700-239W

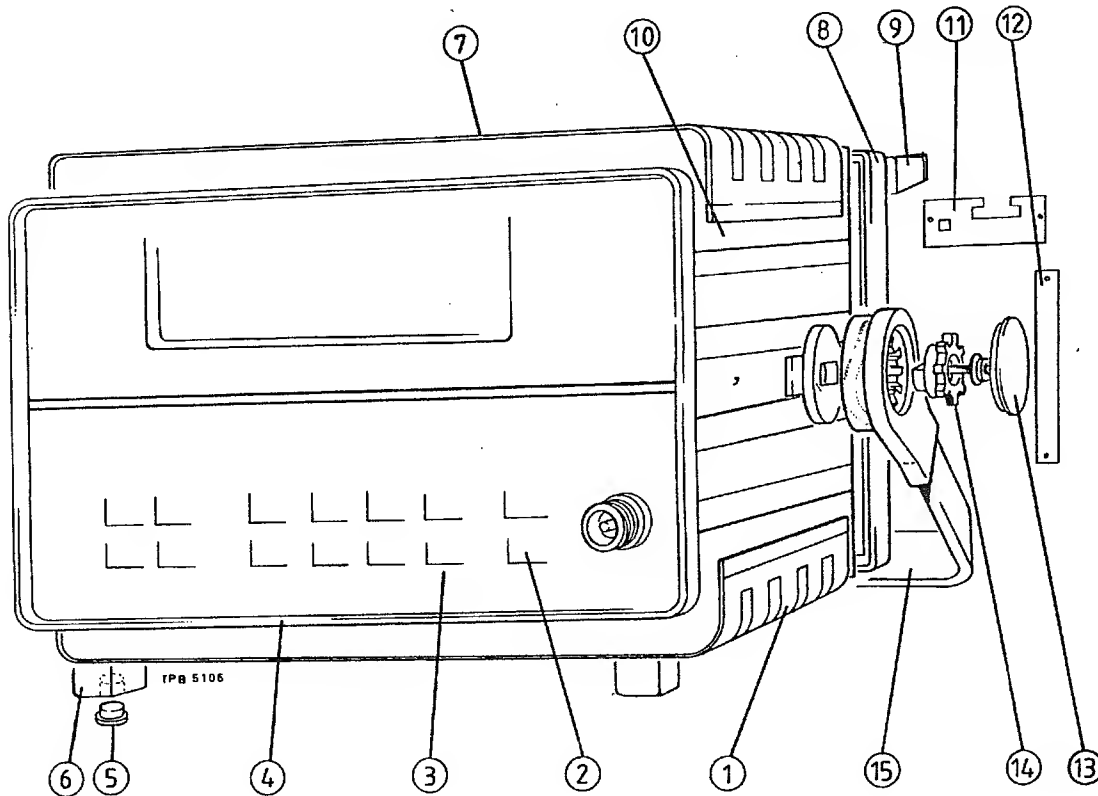


Fig. 6-1 Miscellaneous mechanical parts



Chapter 7

SERVICING DIAGRAMS

CONTENTS

Para.

- 1 Circuit notes
- 1 Component values
- 3 Symbols

Fig.	Unit	Title	Dwg. No.	Page
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7-4	A2/2	Power supply & control (sheet 1)	Z44829-573L	9/10
7-5	A2/2	Power supply & control (sheet 2)	Z44829-573L	11
7-6a	AA1/1	Synthesizer, component layout		12
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CIRCUIT NOTES**Component values**

1. Resistors : Code letter R = ohms, k = kilohms (10³), M = megohms (10⁶).

Capacitors : Code letter m = millifarads (10⁻³) μ = microfarads (10⁻⁶),
n = nanofarads (10⁻⁹), p = picofarads (10⁻¹²).

Inductors : Code letter H = henrys, m = millihenrys (10⁻³),
 μ = microhenrys (10⁻⁶), n = nanohenrys (10⁻⁹)

SIC : Value selected during test, nominal value shown.

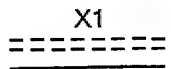
2. Components are marked normally with two, three or four figures according to the accuracy limit $\pm 10\%$, $\pm 1\%$ or $\pm 0.1\%$. The code letter used indicates the multiplier and replaces the decimal point.

Symbols

3. Symbols are based on the provisions of BS 3939 with the following additions:-



edge connector



ferrite bead



caution, see page (iv), servicing precautions



unit identification number



printed component

NOTES AND CAUTIONS

ELECTRICAL SAFETY PRECAUTIONS

This equipment is protected in accordance with IEC Safety Class 1. It has been designed and tested according to IEC Publication 348, 'Safety Requirements for Electronic Measuring Apparatus', and has been supplied in a safe condition. The following precautions must be observed by the user to ensure safe operation and to retain the equipment in a safe condition.

Defects and abnormal stresses

Whenever it is likely that protection has been impaired, for example as a result of damage caused by severe conditions of transport or storage, the equipment shall be made inoperative and be secured against any unintended operation.

Removal of covers

Removal of the covers is likely to expose live parts although reasonable precautions have been taken in the design of the equipment to shield such parts. The equipment shall be disconnected from the supply before carrying out any adjustment, replacement or maintenance and repair during which the equipment shall be opened. If any adjustment, maintenance or repair under voltage is inevitable it shall only be carried out by a skilled person who is aware of the hazard involved.

Note that capacitors inside the equipment may still be charged when the equipment has been disconnected from the supply. Before carrying out any work inside the equipment, capacitors connected to high voltage points should be discharged; to discharge mains filter capacitors, if fitted, short together the L (live) and N (neutral) pins of the mains plug.

Mains plug

The mains plug shall only be inserted in a socket outlet provided with a protective earth contact. The protective action shall not be negated by the use of an extension lead without protective conductor. Any interruption of the protective conductor inside or outside the equipment is likely to make the equipment dangerous.

Fuses

Note that there is a supply fuse in both the live and neutral wires of the supply lead. If only one of these fuses should rupture, certain parts of the equipment could remain at supply potential.


To provide protection against breakdown of the supply lead, its connectors, and filter where fitted, an external supply fuse (e.g. fitted in the connecting plug) should be used in the live lead. The fuse should have a continuous rating not exceeding 6 A.

Make sure that only fuses with the required rated current and of the specified type are used for replacement. The use of mended fuses and the short-circuiting of fuse holders shall be avoided.

RADIO FREQUENCY INTERFERENCE

This equipment conforms with the requirements of IEC Directive 76/889 as to limits of r.f. interference.

CAUTION : STATIC SENSITIVE COMPONENTS

Components identified with the symbol  on the circuit diagrams and/or parts lists are static sensitive devices. The presence of such devices is also indicated in the equipment by orange discs, flags or labels bearing the same symbol. Certain handling precautions must be observed to prevent these components being permanently damaged by static charges or fast surges.

- (1) If a printed board containing static sensitive components (as indicated by a warning disc or flag) is removed, it must be temporarily stored in a conductive plastic bag.
- (2) If a static sensitive component is to be removed or replaced the following anti-static equipment must be used.

A work bench with an earthed conductive surface.

Metallic tools earthed either permanently or by repeated discharges.

A low-voltage earthed soldering iron.

An earthed wrist strap and a conductive earthed seat cover for the operator, whose outer clothing must not be of man-made fibre.

- (3) As a general precaution, avoid touching the leads of a static sensitive component. When handling a new one, leave it in its conducting mount until it is required for use.

WARNING : HANDLING HAZARDS

This equipment is formed from metal pressings and although every endeavour has been made to remove sharp points and edges care should be taken, particularly when servicing the equipment, to avoid minor cuts.

WARNING : TOXIC HAZARD

Many of the electronic components used in this equipment employ resins and other chemicals which give off toxic fumes on incineration. Appropriate precautions should therefore be taken in the disposal of these items.



Beryllia (beryllium oxide) is used in the construction of the following components in this equipment :

.....Unit AC4 : Transistor TR10.....

This material, when in the form of fine dust or vapour and inhaled into the lungs, can cause a respiratory disease. In its solid form, as used here, it can be handled quite safely although it is prudent to avoid handling conditions which promote dust formation by surface abrasion.

Because of this hazard you are advised to be very careful in removing and disposing of these components. Do not put them in the general industrial or domestic waste or despatch them by post. They must be separately and securely packed and clearly identified to show the nature of the hazard and then disposed of in a safe manner by an authorized toxic waste contractor.

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